ARCHMI-S-8XXC

7”, 8”, 10.1”, 12.1”, 12.1W”, 15”, 15.6”, 17”, 18.5”, 19”, 21.5”

Intel Alder Lake-N

Fanless Industrial Panel PC

User Manual

Release Date	Revision
Oct. 2025	V1.1

Aplex Technology, Inc.

15F-1, No.186, Jian Yi Road, Zhonghe District, New Taipei City 235, Taiwan

Tel: 886-2-82262881 Fax: 886-2-82262883 URL: https://www.aplex.com/

Revision History

Reversion	Date	Description
1.0	2025/9/26	Initiation
1.1	2025/10/08	1. Added 1.3.2 High Brightness LCD information 2. Modified Operating Temperature

Warning!_____

This equipment generates uses and can radiate radio frequency energy and if not installed and used in accordance with the instructions manual, it may cause interference to radio communications. It has been tested and found to comply with the limits for a Class A computing device pursuant to FCC Rules, which are designed to provide reasonable protection against such interference when operated in a commercial environment. Operation of this equipment in a residential area is likely to cause interference in which case the user at his own expense will be required to take whatever measures may be required to correct the interference.

Electric Shock Hazard – Do not operate the machine with its back cover removed. There are dangerous high voltages inside.

Caution
Risk of explosion if the battery is replaced with an incorrect type.
Batteries should be recycled where possible. Disposal of used batteries must be in accordance with local environmental regulations.

Disclaimer
This information in this document is subject to change without notice. In no event shall Aplex Technology Inc. be liable for damages of any kind, whether incidental or consequential, arising from either the use or misuse of information in this document or in any related materials.

Safety Precautions

Follow the messages below to prevent your systems from damage:

- Avoid your system from static electricity on all occasions.
- Prevent electric shock. Don‘t touch any components of this card when the card is power-on. Always disconnect power when the system is not in use.
- Disconnect power when you change any hardware devices. For instance, when you connect a jumper or install any cards, a surge of power may damage the electronic components or the whole system.

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Chapter 1 System Product

1.1 Features

- Intel Celeron N97 Processor(Alder Lake-N)
- 7” to 21.5” Industrial Compact Size Panel PC
- ARCHMI-S Series IP66 Compliant Aluminum Front Bezel
- Support 1 x DDR5-4800MHz SO-DIMM socket, up to 32GB
- Power Input: DC 9-36V
- Support Resistive touch screen (Model : R) and Projected Capacitive Multi-touch screen(Model : P)
- Support High Brightness LCD Version by SKU
- Fanless Design

1.2 Specifications

	ARCHMI-S-8XXC Series
System	
CPU	Intel Processor N97, 4C, 6MB cache, up to 3.6GHz,12W TDP Intel Atom™ x7425E, 4C, 6MB cache, up to 3.4GHz,12W TDP (option)
Chipset	Integrated with SoC
BIOS	AMI UEFI BIOS
Memory	DDR5-4800MHz SO-DIMM socket, up to 32GB
Graphic	Integrated Intel® UHD Graphics
IO Port (7”, 8”)	
USB	2 x USB 3.2 Gen1, 2 x USB2.0 Type-A connectors
Serial	1 x DB9, supports RS-485/422/232(COM1, BIOS selection, RS-232 is default)
LAN	2 x RJ-45, support Intel® I226V/IT 2.5GbE LAN
Power	1 x 3-Pin Terminal Block Type, DC 9-36V Power input
IO Port (10.1” ~ 21.5”)	
USB	2 x USB 3.2 Gen1, 2 x USB2.0 Type-A connectors
Serial	1 x DB9, supports RS-485/422/232(COM1, BIOS selection, RS-232 is default) 1 x DB9, supports RS-485/422/232(COM2, BIOS selection, RS-232 is default) (By cable) 1 x DB9, supports Type RS-232(COM3) (By cable)
LAN	2 x RJ-45, support Intel® I226V/IT 2.5GbE LAN
Power	1 x Terminal Block Type, DC 9-36V Power input
Storage Space	
Storage	1 x M.2 Key-M 2280 (PCIe3.0 x1 or SATA-III, default is SATA-III Type)
Expansion	
Expansion Slot	1 x M.2 2230 E-Key (USB2.0, PCIe x1) for optional Wi-Fi/BT module 1 x M.2 3402/3052 B-key (PCIe x1, USB3.2 Gen1) for optional LTE/5G module

	1 x Nano-SIM slot
Others	
TPM	Onboard TPM2.0 SPI I/F TPM IC
Watchdog Timer	1 ~ 255 sec (system)
Wake on LAN	Support WOL
Antenna	
Antenna	Provide 2 x SMA-female connectors' holes for external antenna (2 for Wi-Fi+BT/4G/5G)
Power	
Power Input	1 x Terminal Block Type, DC 9-36V Power input
Mechanical	
Mechanical Construction	Aluminum die-casting chassis
Mounting	Panel Mount VESA 75(7", 8") VESA 100(10.1"~21.5")
IP Rating	IP66 Front Bezel Design
Operating System Support	
OS Support	Windows 10 IoT Enterprise 2021 LTSC Windows 11 (21H2) or later Linux 22.04 or later
Environmental	
Operating Temperature	7"~19" LCD : default is 0-50 °C, -20~60 °C is option 10.1" ~19" High Brightness 、21.5" LCD : 0℃ to 50℃
Storage Temperature	-30~70°C
Humidity	10 to 95% @ 40°C, non-condensing
Certification	CE / FCC Class A

1.3 Display

1.3.1 Standard LCD

	ARCHMI-S-807CP/R	ARCHMI-S-808CP/R	ARCHMI-S-810CP/R	ARCHMI-S-812CP/R	ARCHMI-S-812WCP/R
Display Type	7” TFT LCD	8” TFT LCD	10” TFT LCD	12.1” TFT LCD	12.1W” TFT LCD
Max. Resolution	800 x 480	800 x 600	1280 x 800	1024 x 768	1280 x 800
Max. Color	262K	16.2M	16.7M	16.2M	16.7M
Luminance(cd/m²)	350	1,000	350	500	400
Contrast Ratio	1,000 : 1	1,000 : 1	800:1	1,000:1	1,200:1
Viewing angle(H/V)	160/160	140/120	170/170	178/178	170 /170
MTBF(Hrs)	40,000	50,000	30,000	30,000	50,000

	ARCHMI-S-815CP/R	ARCHMI-S-816CP/R	ARCHMI-S-817CP/R	ARCHMI-S-818CP/R	ARCHMI-S-819CP/R
Display Type	15” TFT LCD	15.6” TFT LCD	17” TFT LCD	18.5” TFT LCD	19” TFT LCD
Max. Resolution	1024 x 768	1920 x 1080	1280 x 1024	1920 x 1080	1280 x 1024
Max. Color	16.7M	16.7M	16.7M	16.7M	16.7M
Luminance(cd/m²)	350	500	350	350	350
Contrast Ratio	1,000:1	1,000:1	1,000:1	1,000:1	1,000:1
Viewing angle(H/V)	178/178	178/178	160/140	178/178	170/160
MTBF(Hrs)	50,000	50,000	50,000	50,000	50,000

	ARCHMI-S-821CP/R
Display Type	21.5” TFT LCD
Max. Resolution	1920 x 1080
Max. Color	16.7M
Luminance(cd/m²)	250
Contrast Ratio	1,000:1
Viewing angle(H/V)	178/178
MTBF(Hrs)	50,000

1.3.2 High Brightness LCD

	ARCHMI-S-807CP/R(H)	ARCHMI-S-808CP/R(H)	ARCHMI-S-810CP/R(H)	ARCHMI-S-812CP/R(H)	ARCHMI-S-812WCP/R(H)
Display Type	7” TFT LCD	8” TFT LCD	10” TFT LCD	12.1” TFT LCD	12.1W” TFT LCD
Max. Resolution	800 x 480	800 x 600	1280 x 800	1024 x 768	1280x800
Max. Color	262K	16.2M	16.7M	16.7M	16.7M
Luminance(cd/m²)	1000	1,000	800	1000	1000
Contrast Ratio	1000 : 1	1,000 : 1	1200 : 1	1000:1	1000:1
Viewing angle(H/V)	160/160	140/120	178/178	176/176	176/176
MTBF(Hrs)	40,000	50,000	50,000	50,000	50,000

	ARCHMI-S-815CP/R(H)	ARCHMI-S-816CP/R(H)	ARCHMI-S-817CP/R(H)	ARCHMI-S-818CP/R(H)	ARCHMI-S-819CP/R(H)
Display Type	15” TFT LCD	15.6” TFT LCD	17” TFT LCD	18.5” TFT LCD	19” TFT LCD
Max. Resolution	1024 x 768	1920x1080	1280 x 1024	1920x1080	1280 x 1024
Max. Color	16.7M	16.7M	16.7M	16.7M	16.7M
Luminance(cd/m²)	1000	1000	1000	1000	1200
Contrast Ratio	3000:1	1,000:1	800:1	1000:1	1000:1
Viewing angle(H/V)	176/176	170/170	170/160	178/178	170/160
MTBF(Hrs)	70,000	50,000	50,000	50,000	50,000

	ARCHMI-S-821CP/R(H)
Display Type	21.5” TFT LCD
Max. Resolution	1920 x 1080
Max. Color	16.7M
Luminance(cd/m²)	1000
Contrast Ratio	1000:1
Viewing angle(H/V)	178/178
MTBF(Hrs)	50,000

All product specifications are subject to change without notice, * identify as optional function

1.4 Mechanical

	ARCHMI-S-807CP/R	ARCHMI-S-808CP/R	ARCHMI-S-810CP/R	ARCHMI-S-812CP/R	ARCHMI-S-812WCP/R
Mounting(mm)	VESA Mount 75 x 75		VESA Mount 100 x 100		
Dimensions(mm)	202x149x58	231.1x176.1x69	285x189x75	319x244.9x77	328x227x78
Net Weight(Kg)	1.37	2.14	2.57	3.34	3.16

	ARCHMI-S-815CP/R	ARCHMI-S-816CP/R	ARCHMI-S-817CP/R	ARCHMI-S-818CP/R	ARCHMI-S-819CP/R
Mounting(mm)	VESA Mount 100 x 100				
Dimensions(mm)	410.2x310.2x78.7	412x277.5x78	439x348x82	4**99.6**x314.6x82	4**6**8x3**6**0x82
Net Weight	4.85	4.13	5.97	6.77	7.22

	ARCHMI-S-821CP/R
Mounting(mm)	VESA Mount 100 x 100
Dimensions(mm)	557.3x362.3x81.4
Net Weight	6.84

1.5 Power Consumption

Max power consumption of each model under Window 10

Model	Max Power Consumption
ARCHMI-S-807C	33.92
ARCHMI-S-808C	38.65
ARCHMI-S-810C	44.11
ARCHMI-S-812C	43.82
ARCHMI-S-812WC	47.72
ARCHMI-S-815C	43.09
ARCHMI-S-816C	46.27
ARCHMI-S-817C	48.2
ARCHMI-S-818C	48.89
ARCHMI-S-819C	43.07
ARCHMI-S-821C	43.07

* To record power consumed when system has full loading with external devices attached.
* Power consumption may have 10% tolerance difference due to different MB, parts, test instrument, and so on.
* We suggest to use the adapter that APLEX approved. If you would like to adopt your own power supply or adapter, please add another 20-30% from the above power consumption to make sure the system can work stable.

1.6 Dimensions

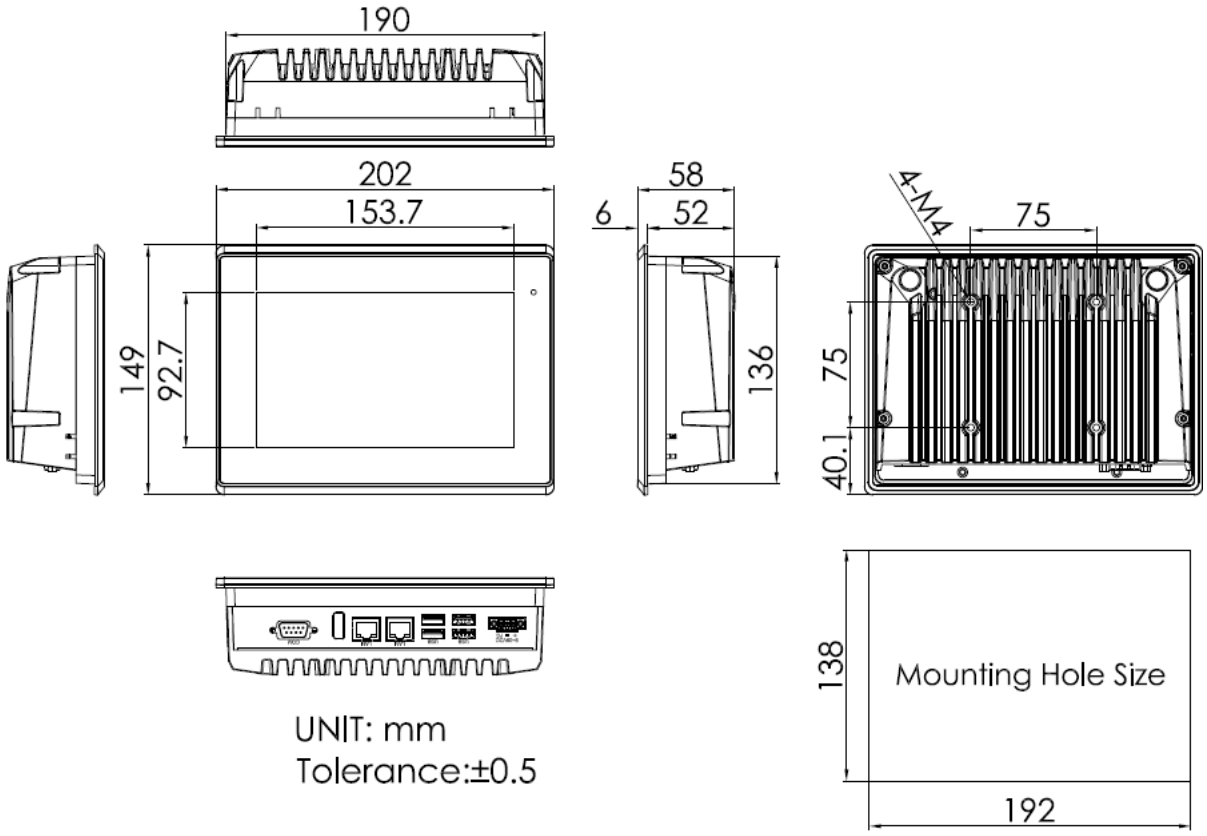


Figure 1 Dimensions of ARCHMI-S-807CP/R

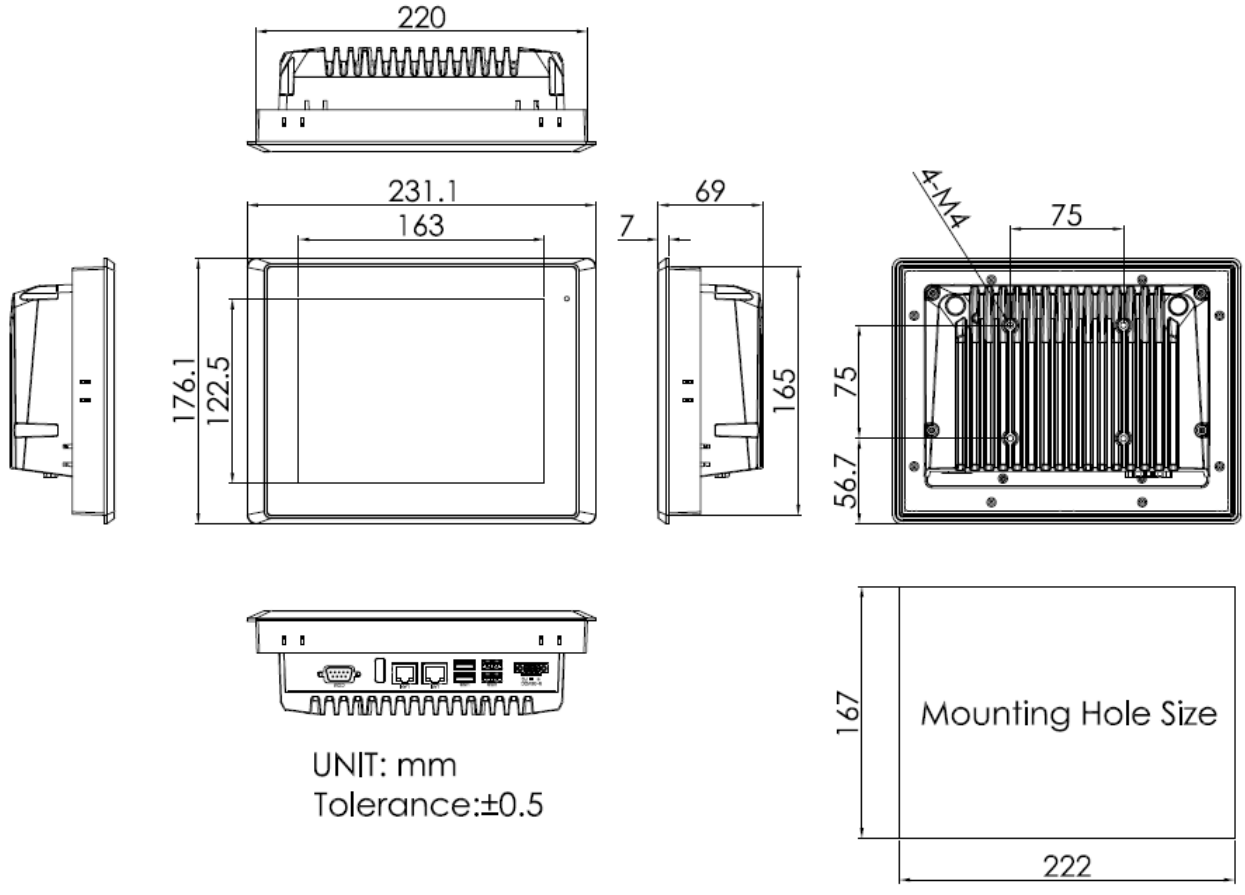


Figure 2 Dimensions of ARCHMI-S-808CP/R

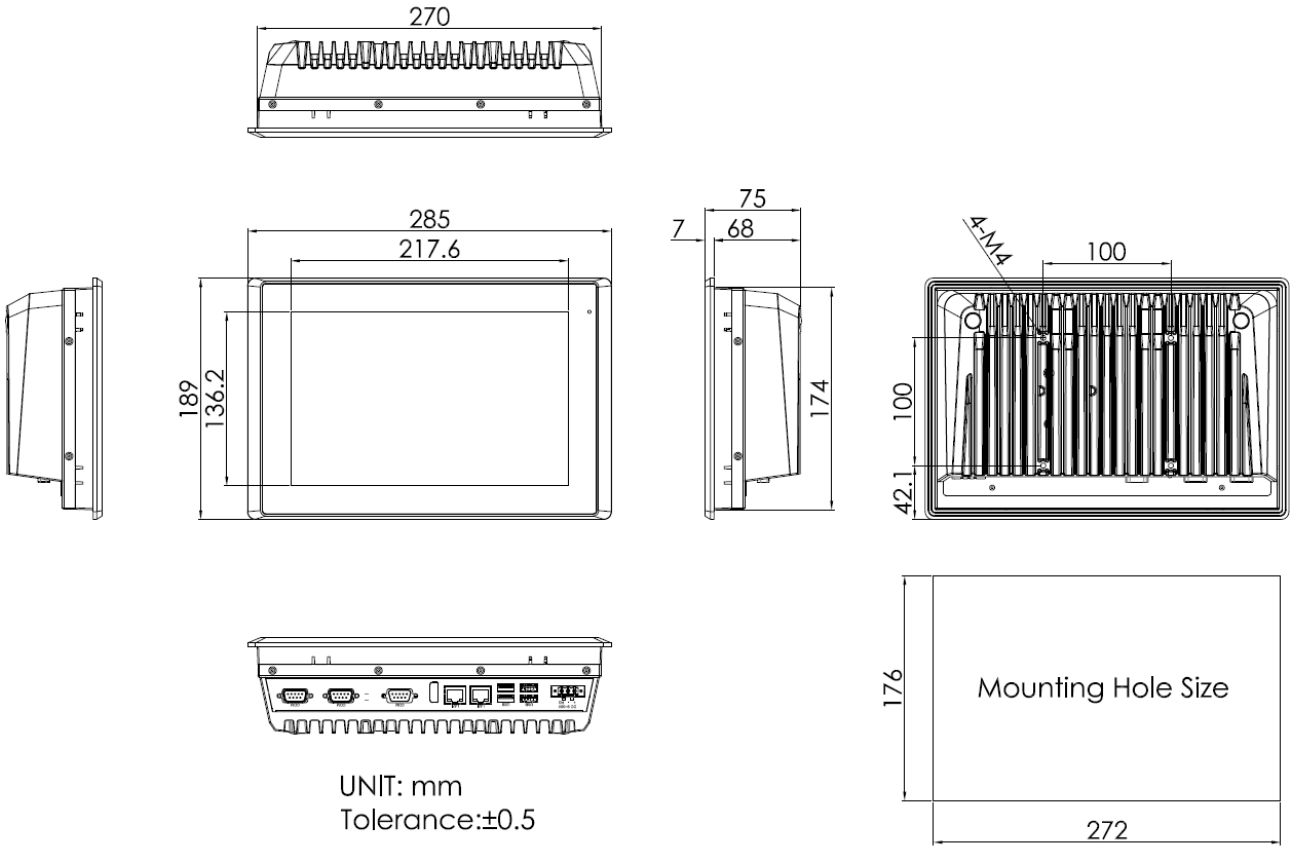


Figure 3 Dimensions of ARCHMI-S-810CP/R

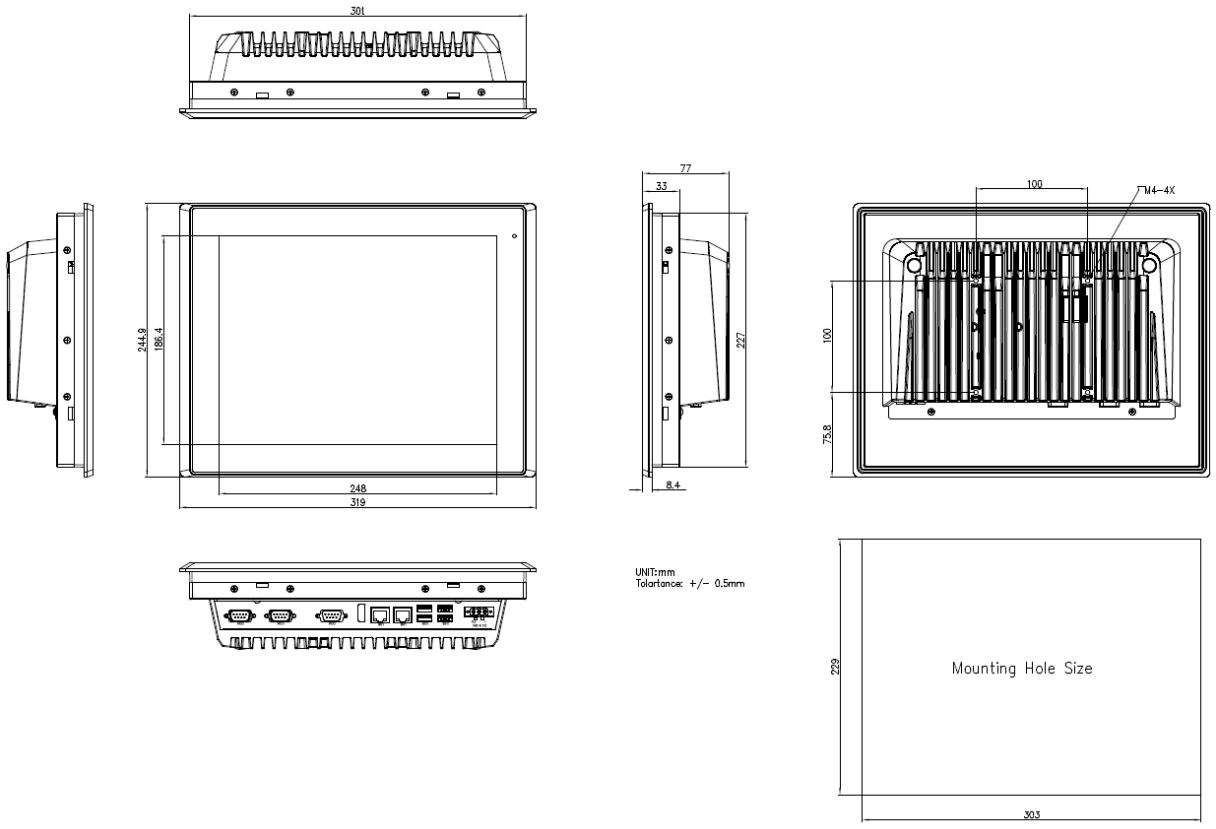


Figure 4 Dimensions of ARCHMI-S-812CP/R

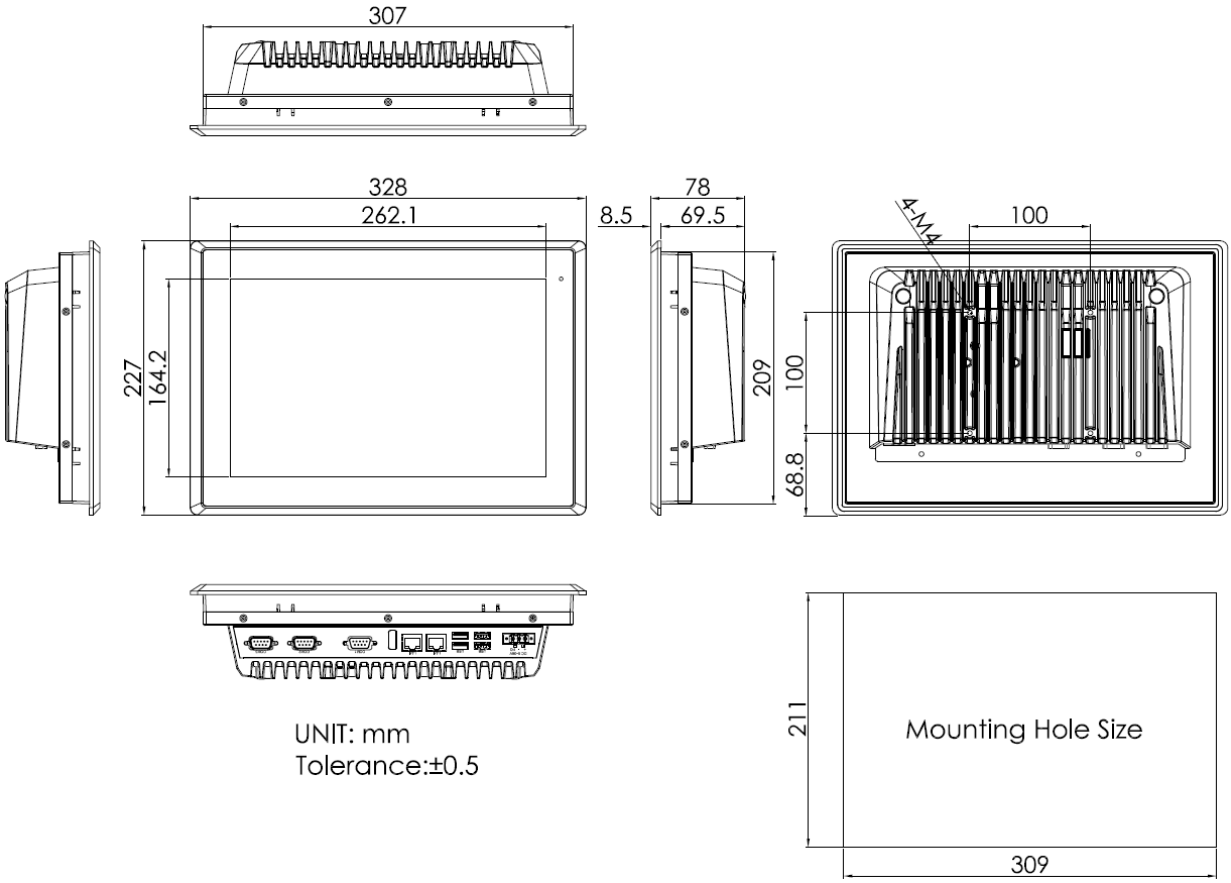


Figure 5 Dimensions of ARCHMI-S-812WCP/R

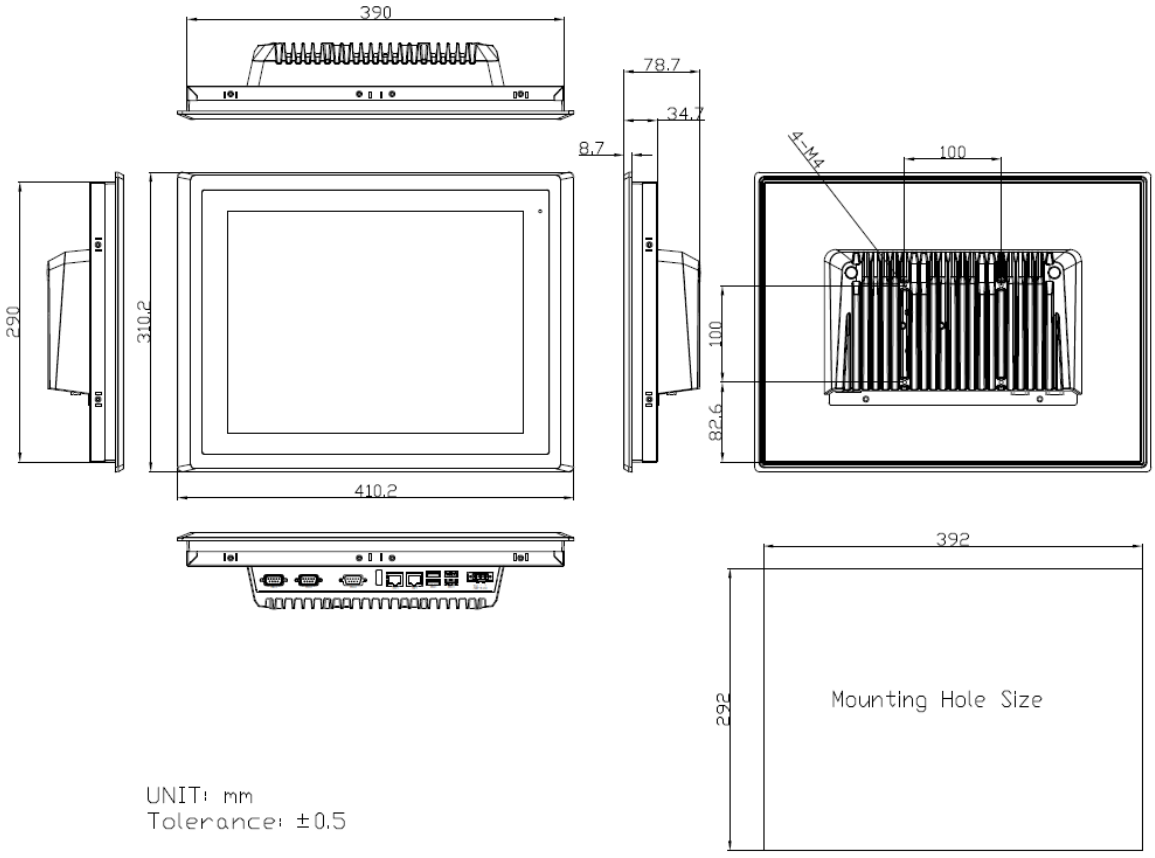


Figure 6 Dimensions of ARCHMI-S-815CP/R

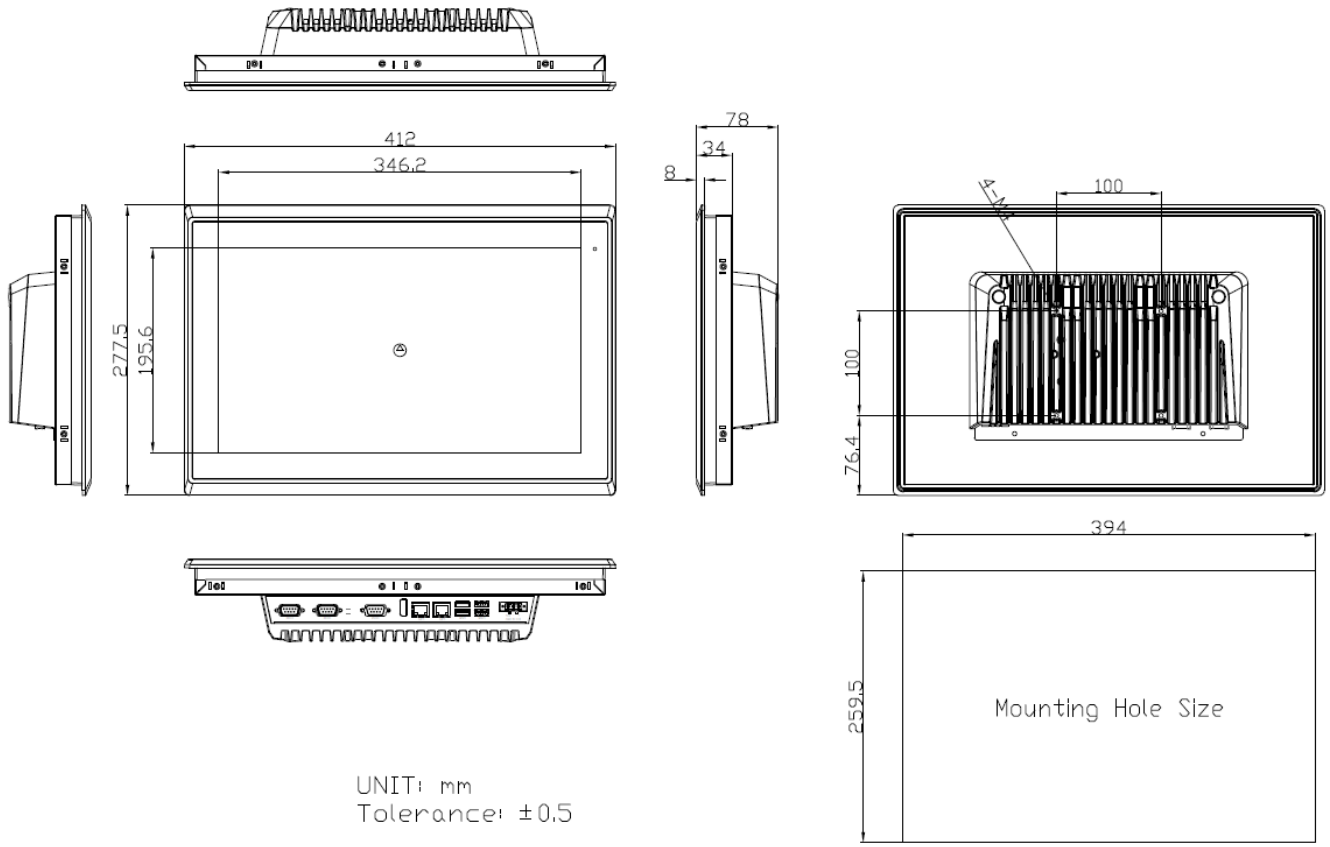


Figure 7 Dimensions of ARCHMI-S-816CP/R

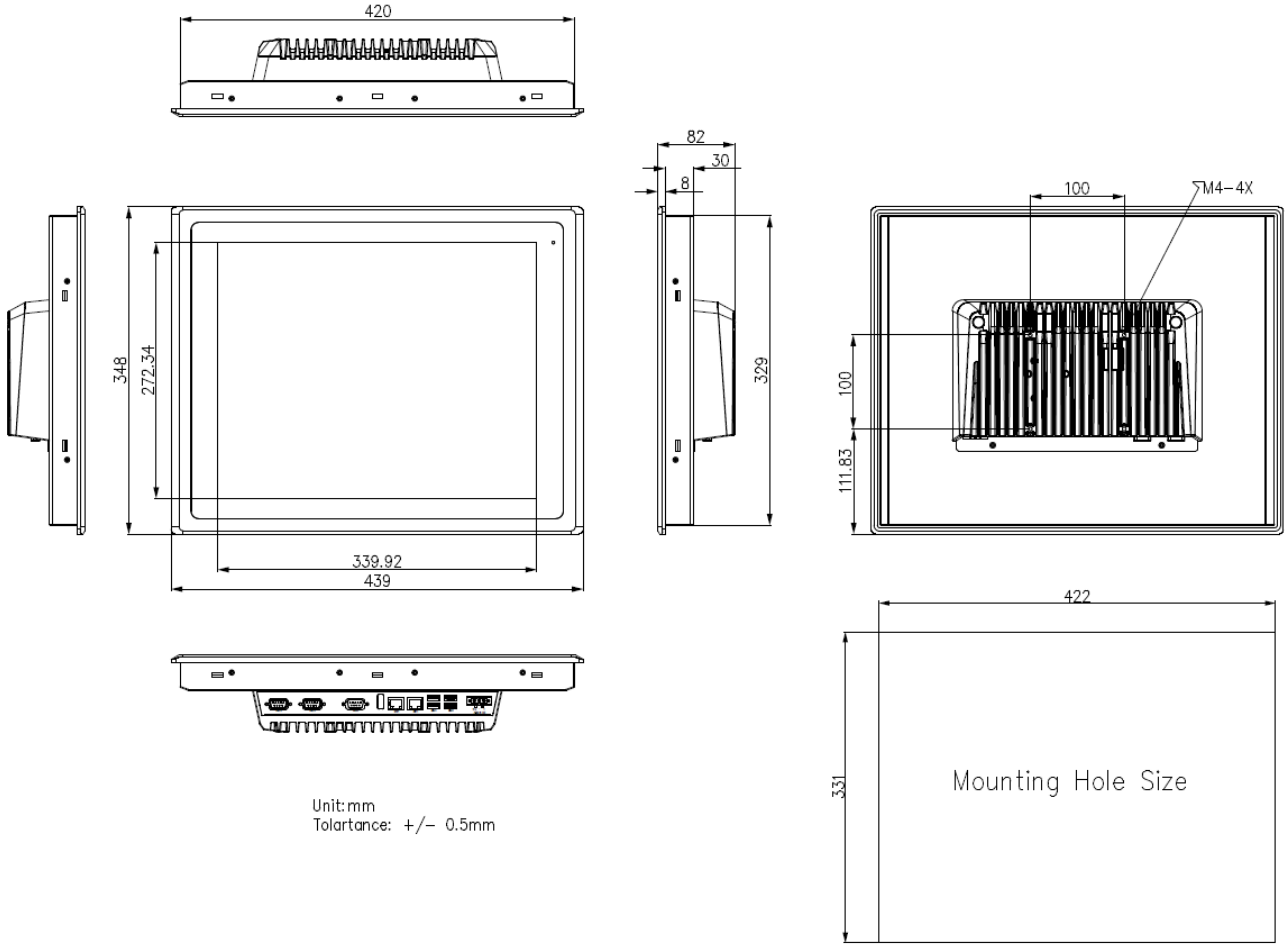


Figure 8 Dimensions of ARCHMI-S-817CP/R

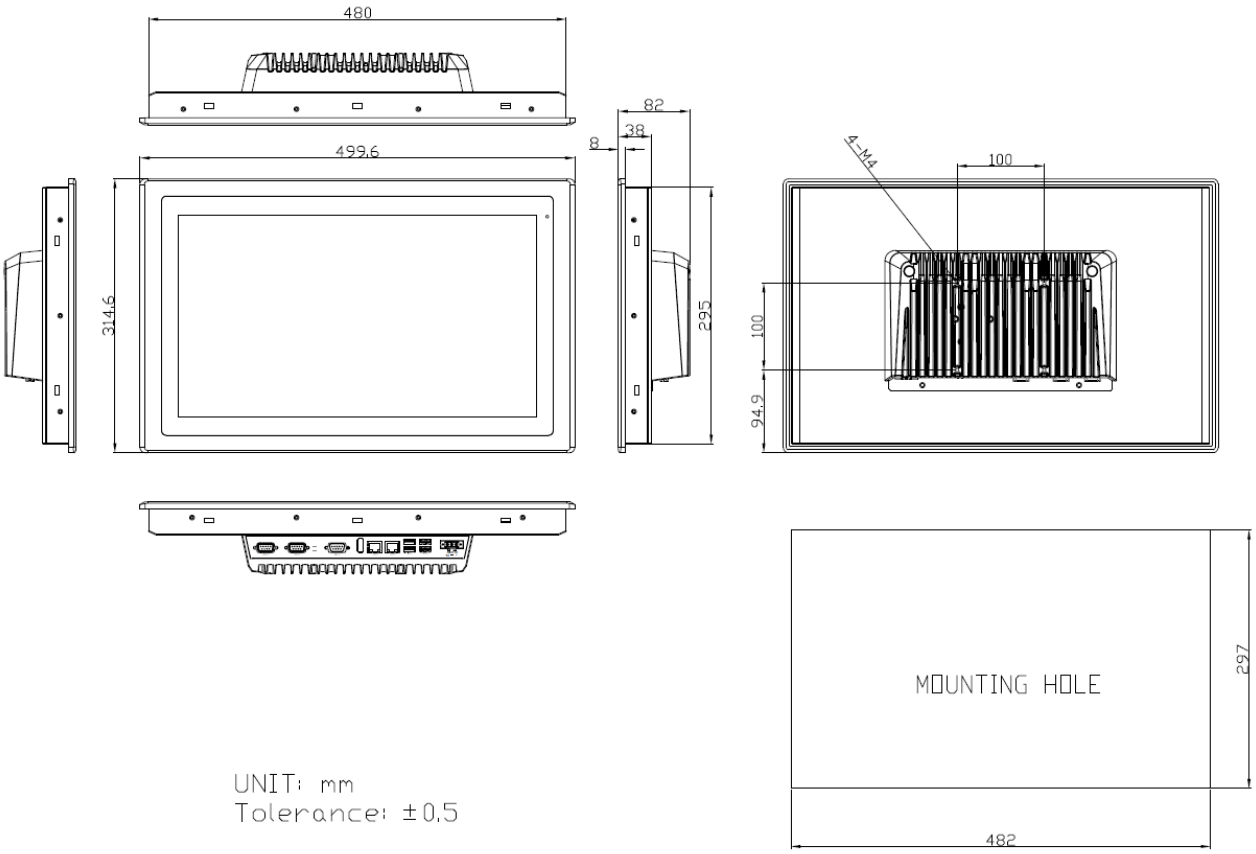


Figure 9 Dimensions of ARCHMI-S-818CP/R

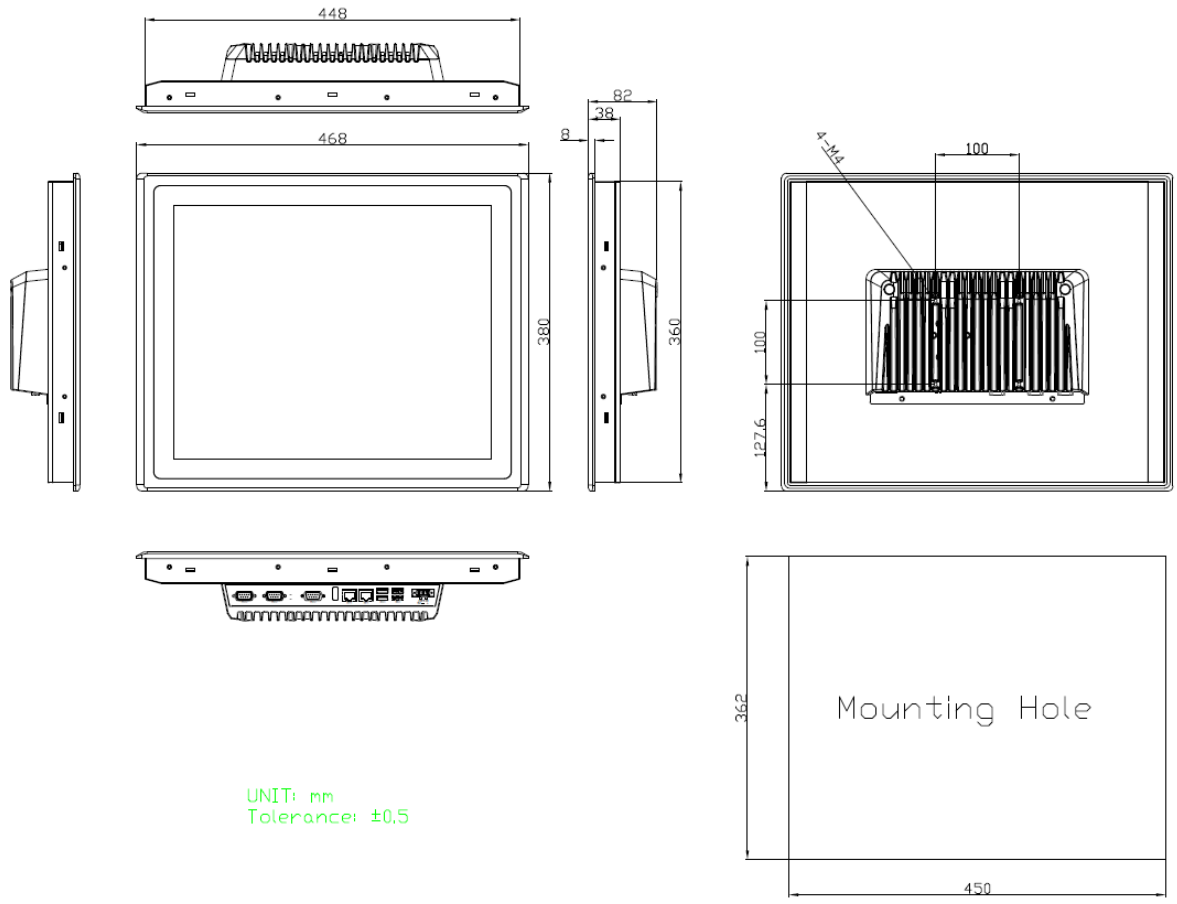


Figure 10 Dimensions of ARCHMI-S-819CP/R

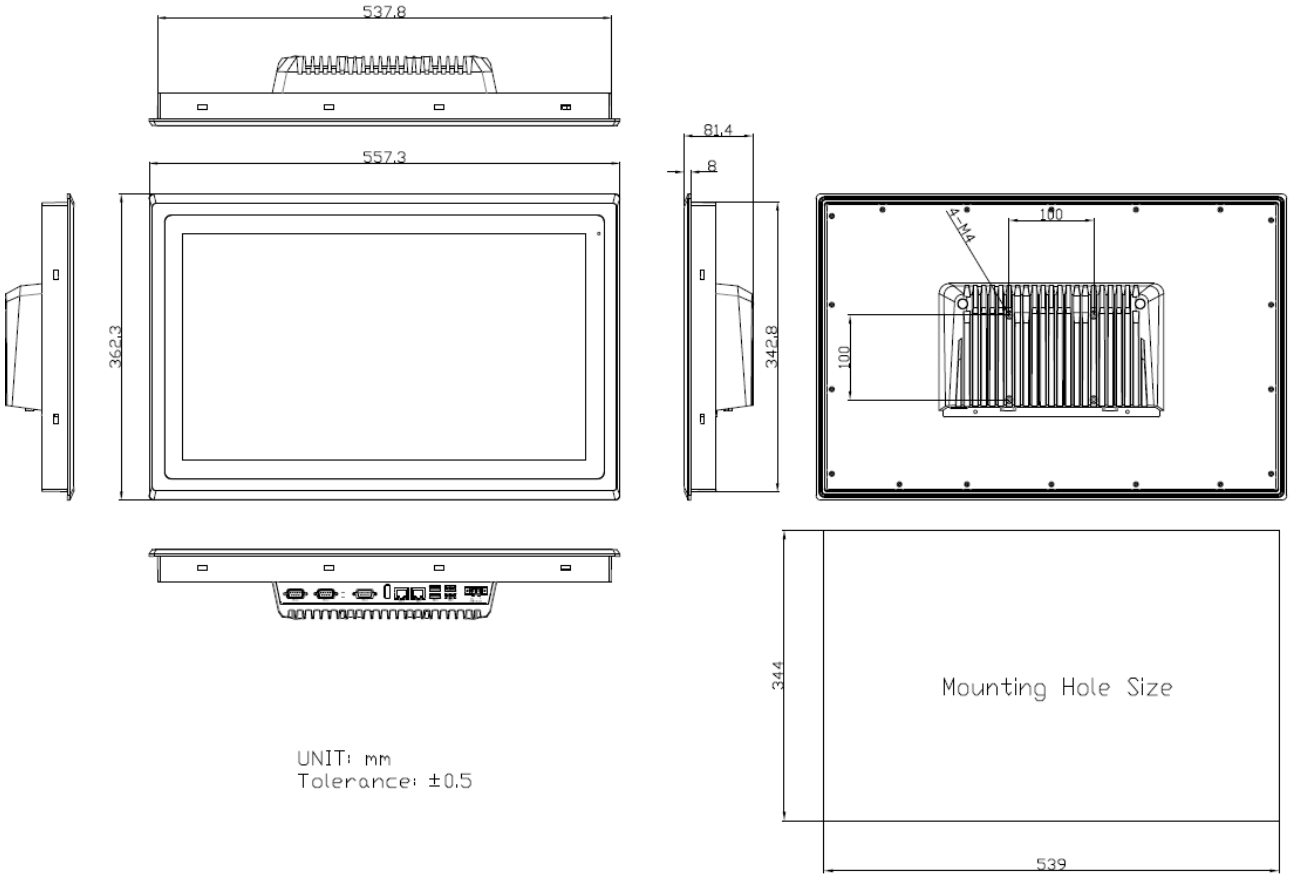


Figure 11 Dimensions of ARCHMI-S-821CP/R

1.7 Brief Description of ARCHMI-S-8XXC Series

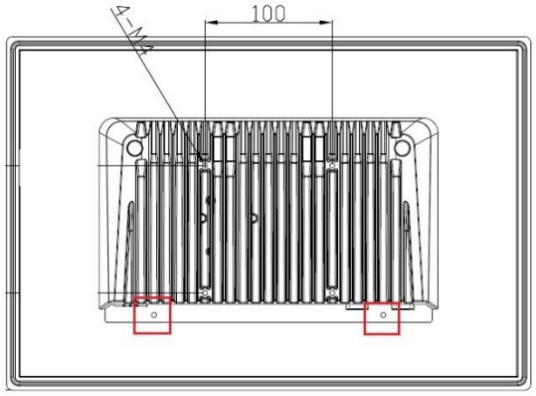
ARCHMI-S-8XXC series products are a newly launched product line, ranging in size from 10.1” to 21.5”. They feature a fanless, low-power, and compact design, making them suitable for use as HMI and control panels in smart production lines and self-service kiosks. With a protective aluminum enclosure, full-plane resistive touchscreen or projected capacitive multi-touchscreen technology, wireless capabilities, and multiple I/O options, the high-performance ARCHMI-S-8XXC series devices can also be integrated with a wide range of optional peripherals and accessories according to specific application requirements.

Figure 12 Front View of ARCHMI-S-816C

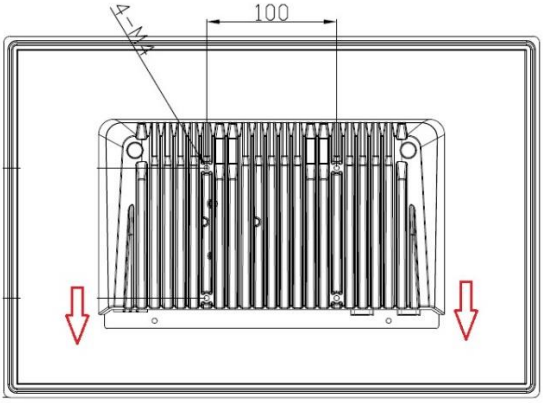
Figure 13 Rear View of ARCHMI-S-816C

1.8 Installation of Memory and Storage

Step 1 : Remove screws from the bottom side of back chassis.

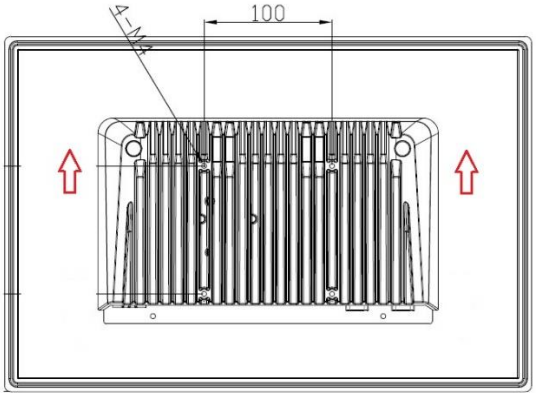


Step 2 : Push down back chassis from the system

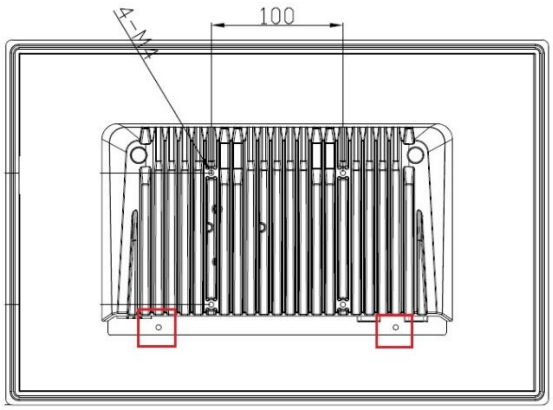


Step 3 : Install memory module on the motherboard.
Install M.2 M-Key 2280 for SSD on motherboard.

Step 4 : Push the back cover latch into the back cover sliding rail.



Step 5 : Tighten the screws.



1.9 VESA Mounting

The ARCHMI-S-8XXC series support VESA 75/100 mount.

ARCHMI-S-807/808C : VESA 75, 4-m4 screw x 4 PCs

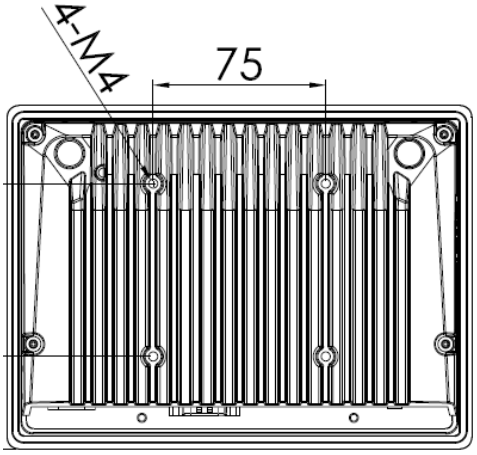


Figure 14 ARCHMI-S-807C/808C VESA Mounting

ARCHMI-S-810C/812C/812WC/815C/816C/817C/818C/819C/821C : VESA 100, 4-m4 screw x 4 PCs

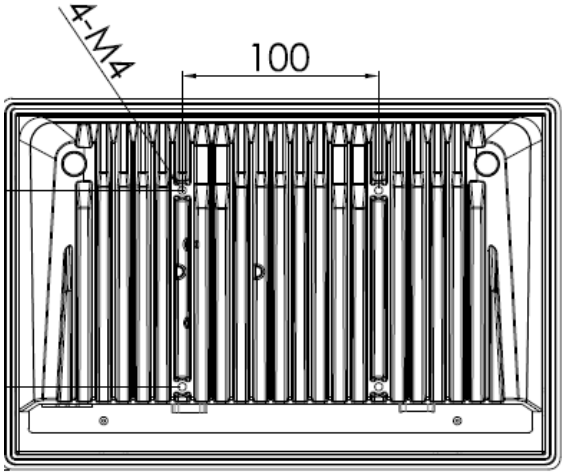


Figure 15 ARCHMI-S-810C/812C/812WC/815C/816C/817C/818C/819C/821C VESA Mounting

1.10 Panel Mounting

There are mounting holes located along the four sides of the HMI. Position the ARCHMI-S panel pc against the panel mount and insert the mounting kit from the four sides and tighten them with screws.

Description	Qty	Unit
Panel mounting kit for 7”	4	PCS
Panel mounting kit for 8”	6	PCS
Panel mounting kit for 10.1” , 12.1” and 12.1”W	8	PCS
Panel mounting kit for 15”, 15.6”, 17”, 18.5” and 19”	10	PCS
Panel mounting kit for 21.5”	12	PCS

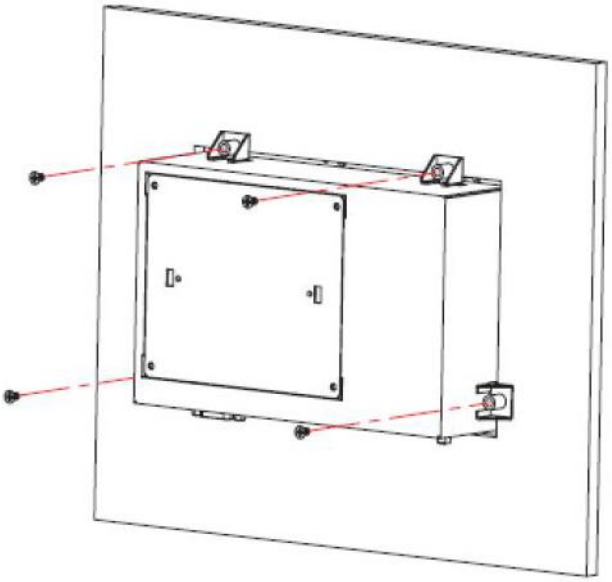


Figure 17 ARCHMI-S-8XXC PANEL Mounting

Chapter 2 Hardware

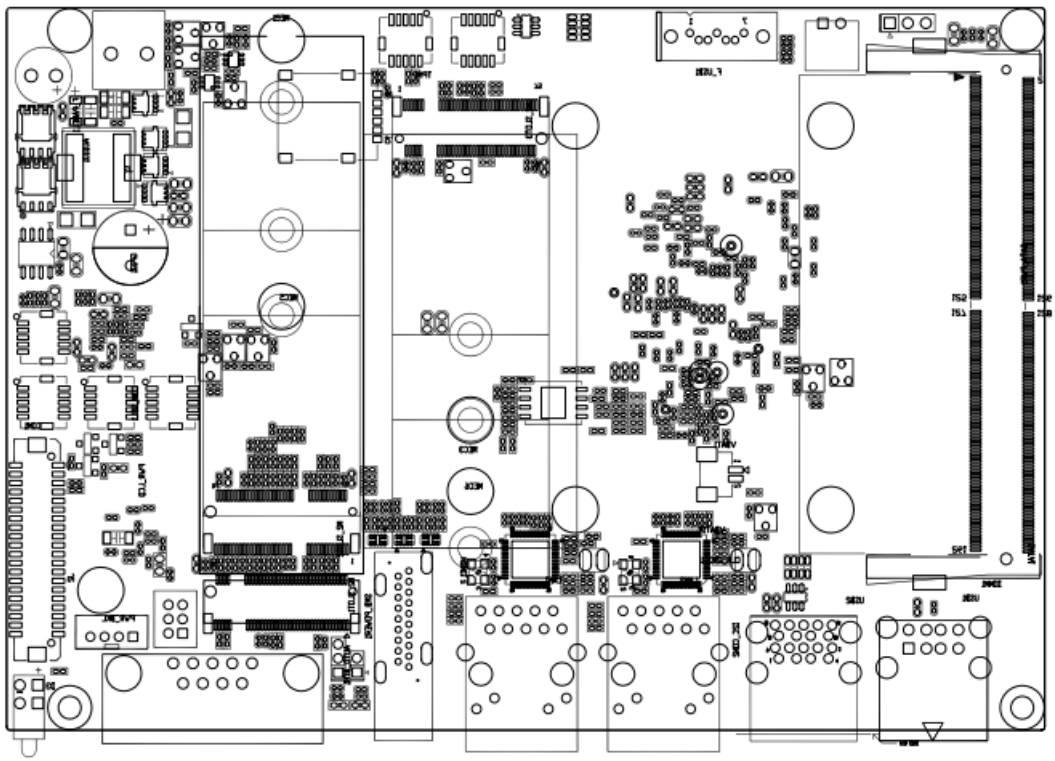
SBC-7135 is a 3.5" industrial motherboard developed on the basis of Intel Alder Lake, which provides abundant peripheral interfaces to meet the needs of different customers..

2.1 Motherboard Specifications

Specifications	
Board Size	146mm x 101.6mm
CPU Support	Intel N95,4C4T ,up to 3.4GHz, 16EU iGPU TDP:15W Intel N97,4C4T, up to 3.6 GHz , 24EU iGPU , TDP:12W Intel N100,4C4T,up to 3.4GHz, 24EU iGPU,TDP:6W Intel N200,4C4T,up to 3.7GHz, 32EU iGPU,TDP:6W Intel Core™ i3-N300,8C8T,up to 3.8GHz, 32EU iGPU,TDP:7W Intel Core™ i3-N305,8C8T,up to 3.8GHz, 32EU iGPU,TDP:15W Intel Atom® X7425E,4C4T, up to 3.4GHz, 24EU iGPU , TDP:12W
Chipset	SOC
Memory Support	SO-DIMM (260pins), up to 32GB DDR5 4800MT/s
Graphics	Integrated Intel UHD Graphics
Display Mode	1 x HDMI1.4b via HDMI Port 1 x LVDS (18/24-bit dual LVDS)/Edp(option by bom)
Support Resolution	HDMI: support up to 4096x2160@60Hz LVDS: support up to 1920x1200@60Hz eDP: support up to 3840x2160@60Hz
Super I/O	ITE IT8786E-I/HX
BIOS	AMI/UEFI BIOS
Storage	1 x SATAIII via 7pin SATA connector 1 x M.2 M-Key(**PCIe3.0 x1 + SATA-III**) 2280 for Storage
Ethernet	1 x 2.5G LAN via intel® I226V/IT controller (PXE/WOL) 1 x 2.5G LAN via intel® I226V/IT controller (PXE/WOL)
USB	2 x USB3.2 gen1/USB2.0,Type-A stack ports (USB1) 2 x USB2.0, Type-A stack ports (USB2) 2 x USB2.0 via SHD 1.25mm 2x5pin header (F_USB1) 1x USB2.0 for M.2 B-Key 1x USB2.0 for M.2 E-Key
Serial	1 x RS-232(default)/422/485, signals select via BIOS (COM1), pin9 RI(default)/5V/12V, select via COM1_PIN9SEL. (DB9, COM1)

	1 x RS-232(default)/422/485 via SHD 1.25mm 2x5pin header, signals select via BIOS (COM2) 4 x 2wired RS232 via SHD 1.25mm 2x5pin header (COM3-6)
GPIO	8-bit digital I/O by SHD 1.25mm 2x5pin header (GPIO1)
Audio	Support Audio via Realtek ALC887-VA2-CG HD audio codec Support Line-in,Line-out,MIC by SHD 1.25mm 2x5pin header
Expansion Slots	1 x M.2 B-Key(PCIex1, USB3.0, USB2.0),3042/3052 for 4G/5G module with Nano SIM slot (SIM1) 1 x M.2 E-Key(PCIex1,USB2.0,CNVi),2230 for WIFI/BT module
FAN	1x 2pin fan connector
Watchdog Timer	Software programmable 1–255 level
TPM	Onboard TPM IC Infineon_SLB9670AQ2.0 Support fTPM, select via BIOS
Switches and LED Indicators	Power button/reset button/power LED/HDD LED via SHD 1.25mm 2x5pin header (F_Panel1)
Battery	Support 3V RTC Li-battery via 2pin wafer (VBAT1)
Power Management	Wide range DC 9~36V±10% power input via 2pin terminal block
Temperature	Operating: -30℃ to 70℃ Storage: -40℃ to 85℃
Humidity	10% - 90%, non-condensing, operating
Certifications	Meet CE/FCC class A UL RoHS2.0

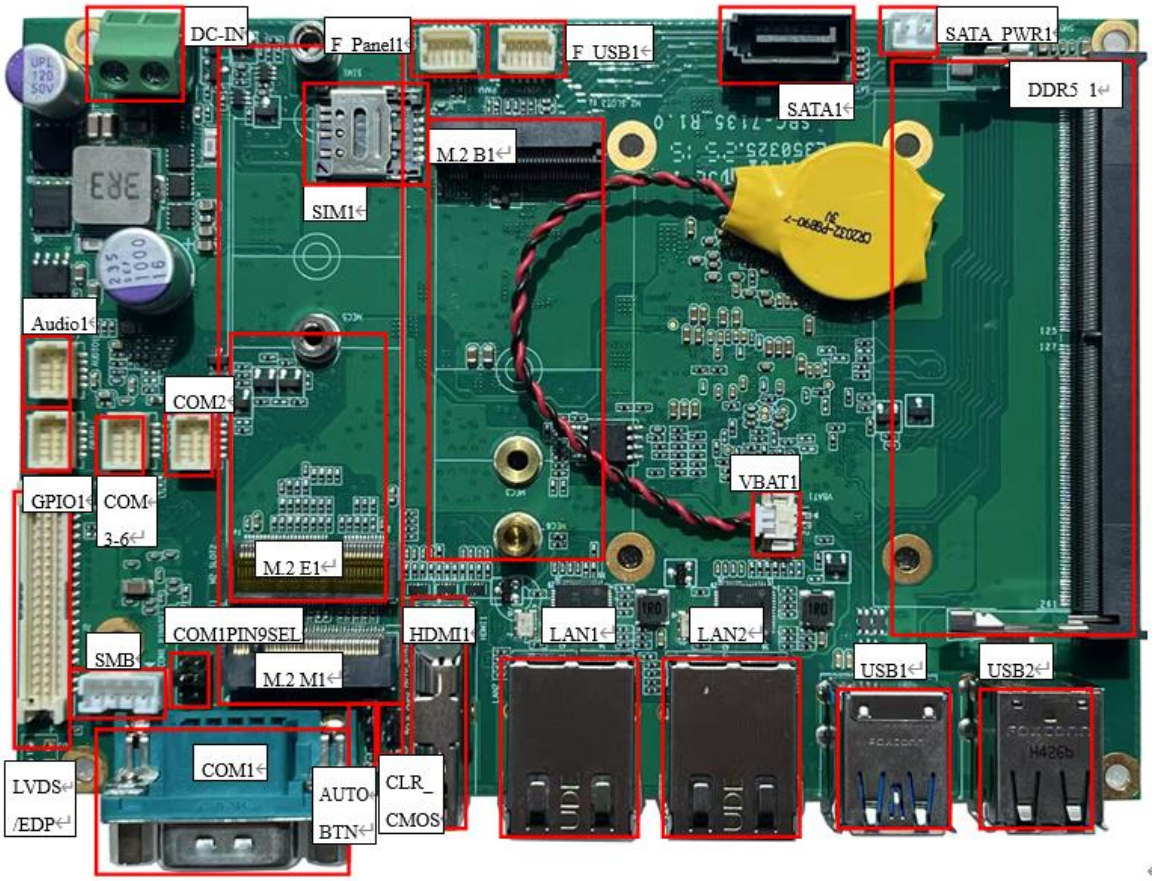
2.2 Board Dimensions



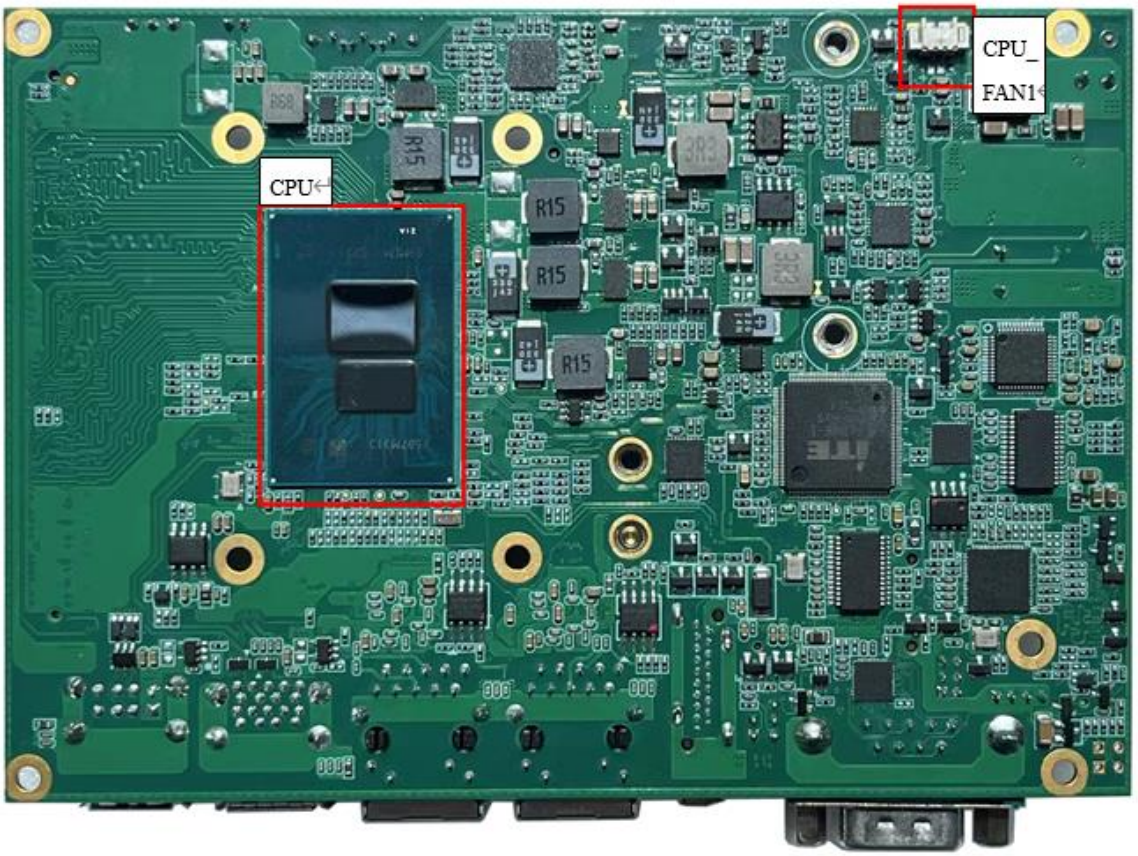
Dimensions: 146 x 101.6 (units :mm)

2.3 Jumpers and Connectors Location

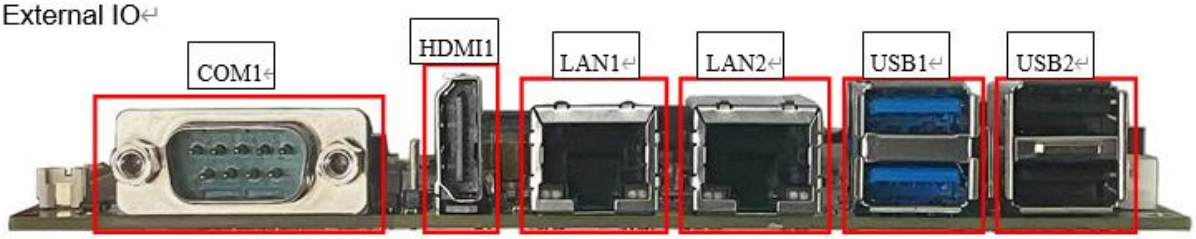
Board Top



Board Bottom



External IO



2.4 Jumpers Setting and Connectors

1. CPU1:

(FCBGA1264) Onboard Intel Alder Lake SoC

Model	SoC				
	Number	PBF	Cores/ Threads	TDP	Remarks
SBC-7135-N95	N95	Up to 4.4GHz(P-Core)	4C / 4T	15W	Option
SBC-7135-N97	N97	Up to 4.4GHz(P-Core)	4C / 4T	12W	Default
SBC-7135-N100	N100	Up to 4.4GHz(P-Core)	4C / 4T	6W	Option
SBC-7135-N200	N200	Up to 4.4GHz(P-Core)	4C / 4T	6W	Option
SBC-7135-N300	N300	Up to 4.5GHz(P-Core)	8C / 8T	7W	Option
SBC-7135-N305	N305	Up to 4.5GHz(P-Core)	8C / 8T	15W	Option
SBC-7135-X7425E	X7425E	Up to 4.5GHz(P-Core)	4C / 4T	12W	Option

2. DDR5_1:

(SO-DIMM 260Pin slot) DDR5 memory socket, the socket is located at the top of the board and supports 260Pin 1.1V DDR5 SO-DIMM memory module up to 32GB.

Max Memory Size (dependent on memory type).

3. VBAT1:

(1.25mm Pitch 1x2 wafer Pin Header) 3.0V Li battery is embedded to provide power for CMOS.

Pin#	Signal Name
Pin1	VCC_RTC
Pin2	GND

4. CLR_CMOS1:

CMOS clear switch, CMOS clear operation will permanently reset old BIOS settings to factory defaults.

Procedures of CMOS clear:

a) Turn off the system and unplug the power cord from the power outlet.

b) To clear the CMOS settings, close CLR_CMOS1 for 1 second

c) Power on the system again.

d) When entering the POST screen, press the <DEL> key to enter CMOS Setup Utility to load optimal defaults.

e) After the above operations, save changes and exit BIOS Setup.

5. CPU_FAN1:

(1.25mm Pitch 1x2 wafer Pin Header) Fan connector, cooling fans can be connected directly for use.

Pin#	Signal Name
1	GND
2	VCC(5V_S0)

Note:

Output power of cooling fan must be limited under 3W.

6. DC_IN1:

(5.08mm Pitch 1x2 Pin Connector) DC9~36V System power input connector.

Pin#	Power Input
Pin1	DC_IN+ (DC+9V~36V)
Pin2	DC_IN- (Ground)

7. SMB:

(2.00mm Pitch 1x4 Pin Header) For SMBUS interface Device.

Pin#	Signals
1	GND
2	Data
3	Clock
4	Vcc 3.3V

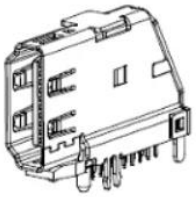
8. LVDS/EDP:

(1.25mm Pitch 2x20 Connector, DF13-40P) Support 18/24-bit LVDS interface LCM with USB2.0 signal for touch screen.

Function	Signal Name	Pin#		Signal Name	Function
DC12V	12V_S0	1	2	12V_S0	DC12V
LVDS/eDP Signals	BKLT_PWM_OUT	3	4	BKLT_EN	LVDS/eDP Signals
	GND	5	6	GND	
	LVDS_VDD5	7	8	LVDS_VDD5	
	LVDS_VDD3.3	9	10	LVDS_VDD3.3	
	GND	11	12	GND	
	LA_D0-/EDP D0-	13	14	LA_D0+/EDP D0+	

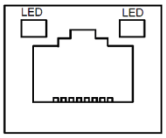
	LA_D1-/EDP D1-	15	16	LA_D1+/EDP D1+	
	LA_D2-/EDP D2-	17	18	LA_D2+/EDP D2+	
	LA_D3-/EDP D3-	19	20	LA_D3+/EDP D3+	
	LA_CLK-/EDP AUX-	21	22	LA_CLK+/EDP AUX+	
	LB_D0-	23	24	LB_D0+	
	LB_D1-	25	26	LB_D1+	
	LB_D2-	27	28	LB_D2+	
	LB_D3-	29	30	LB_D3+	
	LB_CLK-	31	32	LB_CLK+	
USB3	GND	33	34	GND	USB3
	USB2 9D-	35	36	USB2 9D+	
SMbus	SMbus DAT	37	38	5V_S5	
	SMbus CLK	39	40	Power LED+	Power LED

9. HDMI1:



(Vertical HDMI Connector) HDMI Interface connector.
HDMI 1.4, Support resolution up to 1920x1080@60Hz.

10. LAN1:

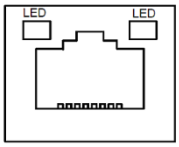


LAN1

(RJ45 Connector) Provide 2.5GbE LAN via Intel® I226V/IT.

Status	Description
Green ACT, Yellow Link	100Mbps
Green ACT, Yellow Link	1G/2.5Gbps bps

11. LAN2:



LAN2

(RJ45 Connector) Provide 2.5GbE LAN via Intel® I226V/IT.

Status	Description
Green ACT, Yellow Link	100Mbps
Green ACT, Yellow Link	1G/2.5Gbps bps

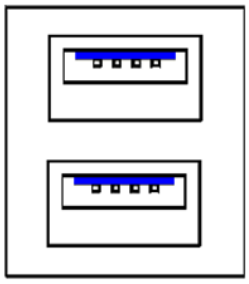
12. F_AUDIO1:

(SHD 1.25mm 2x5pin header) Provide line-in/line-out/mic-in via onboard Realtek ALC897 codec.

Signal Name	Pin#	Pin#	Signal Name
LINE-OUT-R	1	2	LINE-OUT-L
GND	3	4	GND
MIC-IN-R	5	6	MIC-IN-L
GND	7	8	GND
LINE-IN-R	9	10	LINE-IN-L

13. USB1、USB2:

(Double stack USB typeA) Rear USB3.2 connector, provides up to 2 USB3.2 gen1/USB2.0 ports, USB3.2 gen1 allows data transfers up to 5.0Gbps.



Each USB Type A Receptacle (2 Ports) Current limited value is 2A.
If the external USB device current exceeds 2.0A, please separate connectors into different Receptacle.

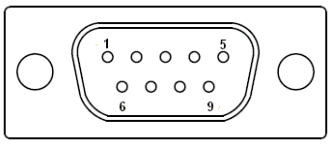
14. F_USB1:

(SHD 1.25mm 2x5pin header) Provide 2xUSB2.0 signals.

Signal Name	Pin#	Pin#	Signal Name
5V_USB23	1	2	5V_USB23
USB2_N	3	4	USB3_N
USB2_P	5	6	USB3_P
GND	7	8	GND
GND	9	10	GND

15. COM1:

(DB9 connector) Provide serial RS232/422/485 via standard DB9 male connector. Default is set to RS232, RS422/485 can be selected via BIOS. Pin 9 RI/5V/12V select via COM1_PIN9SEL.



RS232 (Default):	
Pin#	Signal Name
1	DCD# (Data Carrier Detect)
2	RXD (Received Data)
3	TXD (Transmit Data)
4	DTR (Data Terminal Ready)
5	GND
6	DSR (Data Set Ready)
7	RTS (Request To Send)
8	CTS (Clear To Send)
9	JP1 select Setting (RI/5V/12V)
BIOS Setup：Serial Port 1 Configuration【RS-232】	

RS422 (option):	
Pin#	Signal Name
1	422_TX-
2	422_TX+
3	422_RX+
4	422_RX-
5	GND
6	NC

7	NC
8	NC
9	NC
BIOS Setup：Serial Port 1 Configuration【RS-422】	

RS485 (option):	
Pin#	Signal Name
1	485-
2	485+
3	NC
4	NC
5	GND
6	NC
7	NC
8	NC
9	NC
BIOS Setup：Serial Port 1 Configuration【RS-485】	

16. COM1_PIN9SEL:

(2.0mm Pitch 2x3 Pin Header) For COM1 pin9 signal setting.

JP1 Pin#	Function
Close 1-2	COM1 Pin9 = +12V
Close 3-4	**COM1 Pin9 RI (Ring Indicator, Default)**
Close 5-6	COM1 Pin9 = +5V

17. COM2:

(SHD 1.25mm 2x5pin header) Provide RS232 RS422/485, Default is set to RS232, RS422/485 can be selected via BIOS.

Signal Name	Pin#	Pin#	Signal Name
DCD	1	2	RXD
TXD	3	4	DTR
GND	5	6	DSR
RTS	7	8	CTS
RI	9	10	NC

18. COM3-6:

(SHD 1.25mm 2x5pin header) Provide 4x2wired RS232(COM3/4/5/6).

Signal Name	Pin#	Pin#	Signal Name
COM3_RX	1	2	COM3_TX
COM4_RX	3	4	COM4_TX
COM5_RX	5	6	COM5_TX
COM6_RX	7	8	COM6_TX
GND	9	10	GND

19. GPIO1:

(SHD 1.25mm 2x5pin header) Provide 8Xgpio with 3.3V VCC.

Signal Name	Pin#	Pin#	Signal Name
3.3V_GPIO	1	2	GND
GPIO0	3	4	GPIO1
GPIO2	5	6	GPIO3
GPIO4	7	8	GPIO5
GPIO6	9	10	GPIO7

20. F_Panel1:

(SHD 1.25mm 2x5pin header) Provide power button/reset button/power LED/HDD LED.

Signal Name	Pin#	Pin#	Signal Name
HDD LED+	1	2	Power LED+
HDD LED-	3	4	Power LED-
Reset Button-	5	6	Power Button+
Reset Button+	7	8	Power Button-
NC	9	10	NC

21. SIM1:

(Nano-SIM Slot) Support Nano SIM card for M.2 B Key.

Pin#	Signal Name
1	SIM_VCC
2	SIM_RST
3	SIM_CLK
4	GND
5	NC
6	SIM_DAT

22. M2_B1:

(M.2 B-Key Socket) Support 3042/3052 4G/5G module with Nano SIM slot,and Support 2242 Nvme interface SSD.

23. M2_M1:

(M.2 M-Key Socket) Provide PCIex1, support M-key 2280 Nvme interface SSD.

24. M2_E1:

(M.2 E-Key Socket) Provide USB2.0/PCIex1/CNVi, support E-key 2230 WiFi/BT expansion cards.

25. SATA1:

(SATA 7Pin) SATA connector provide SATA III signal for storages.

26. SATA_PWR1:

(2.0mm Pitch 1x2 Wafer Pin Header) 5V power supply for SATA1 port device.

Pin#	Signal Name
1	5V_S0
2	GND

Note:

Output current of the connector must not be above 1A.

27. AUTO_BTN:

The AUTO_BTN button allows you to select automatic power on after the motherboard is powered on.

(Defalt)

Status	Function
Pin1-2 short circuit	Forced AT mode(Auto power ON)
Pin2-3 short circuit	AT(Auto power ON)/ATX(Manual Power ON) mode select via BIOS (Default AT mode)
*Note: Compatible with BIOS version 002	

Chapter 3 BIOS Setup Description

3.1 Operations after POST Screen

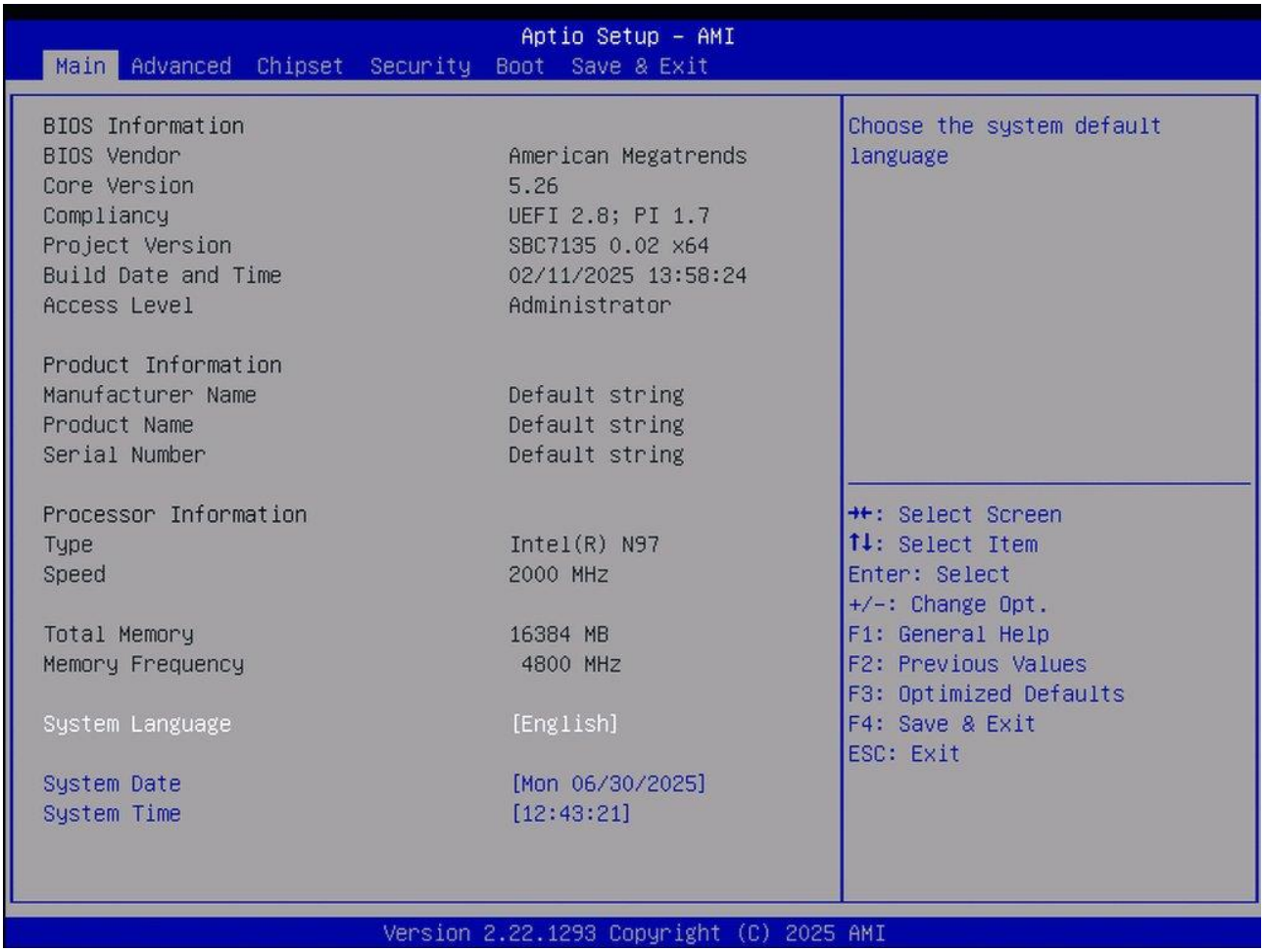
After CMOS discharge or BIOS flashing operation. Press [Delete] key to enter CMOS Setup.

After optimizing and exiting CMOS Setup

3.2 BIOS SETUP UTILITY

Press [Delete] key to enter BIOS Setup utility during POST, and then a main menu containing system summary information will appear.

3.3 Main Settings



System Time:

Set the system time, the time format is:

Hour : 0 to 23

Minute : 0 to 59

Second : 0 to 59

System Date:

Set the system date, the date format is:

Day: Note that the 'Day' automatically changes when you set the date.

Month: 01 to 12

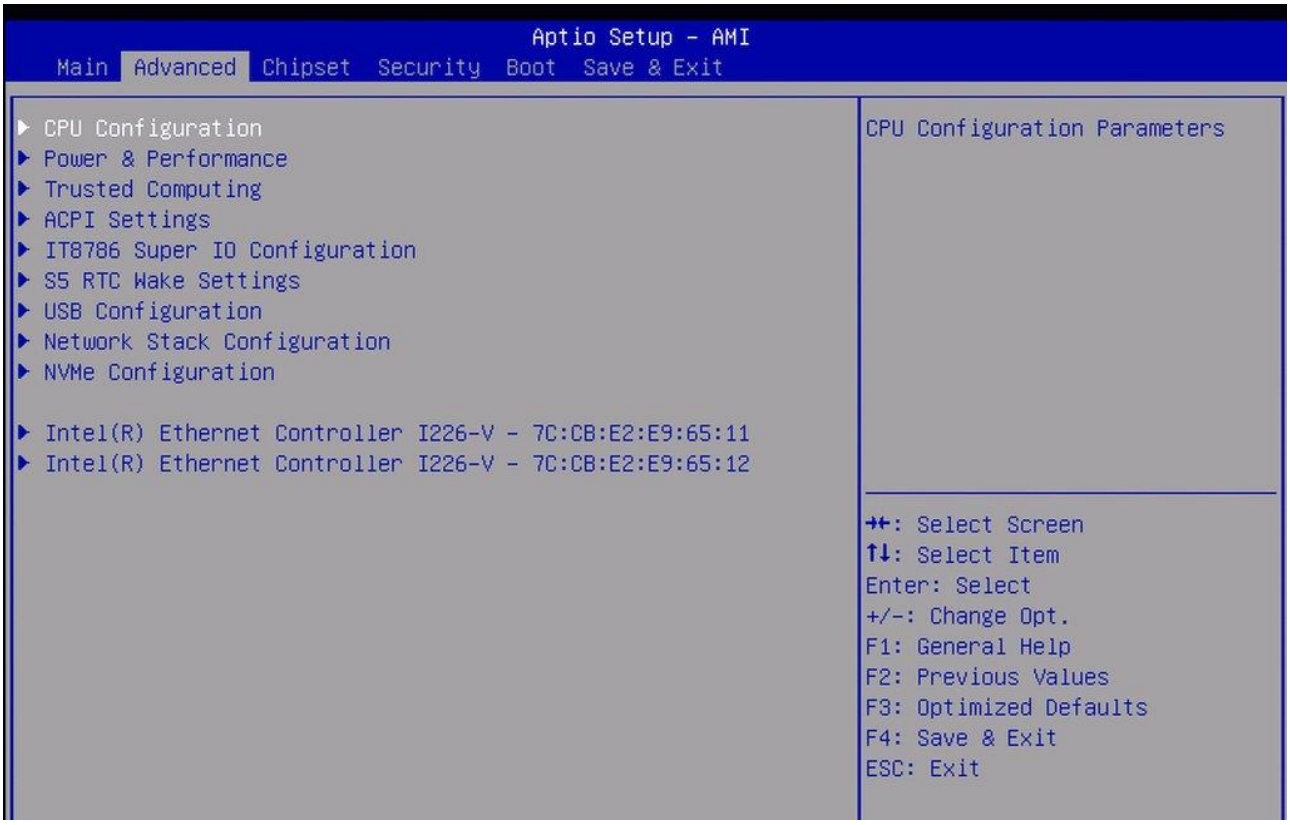
Date: 01 to 31

Year: 1998 to 2099

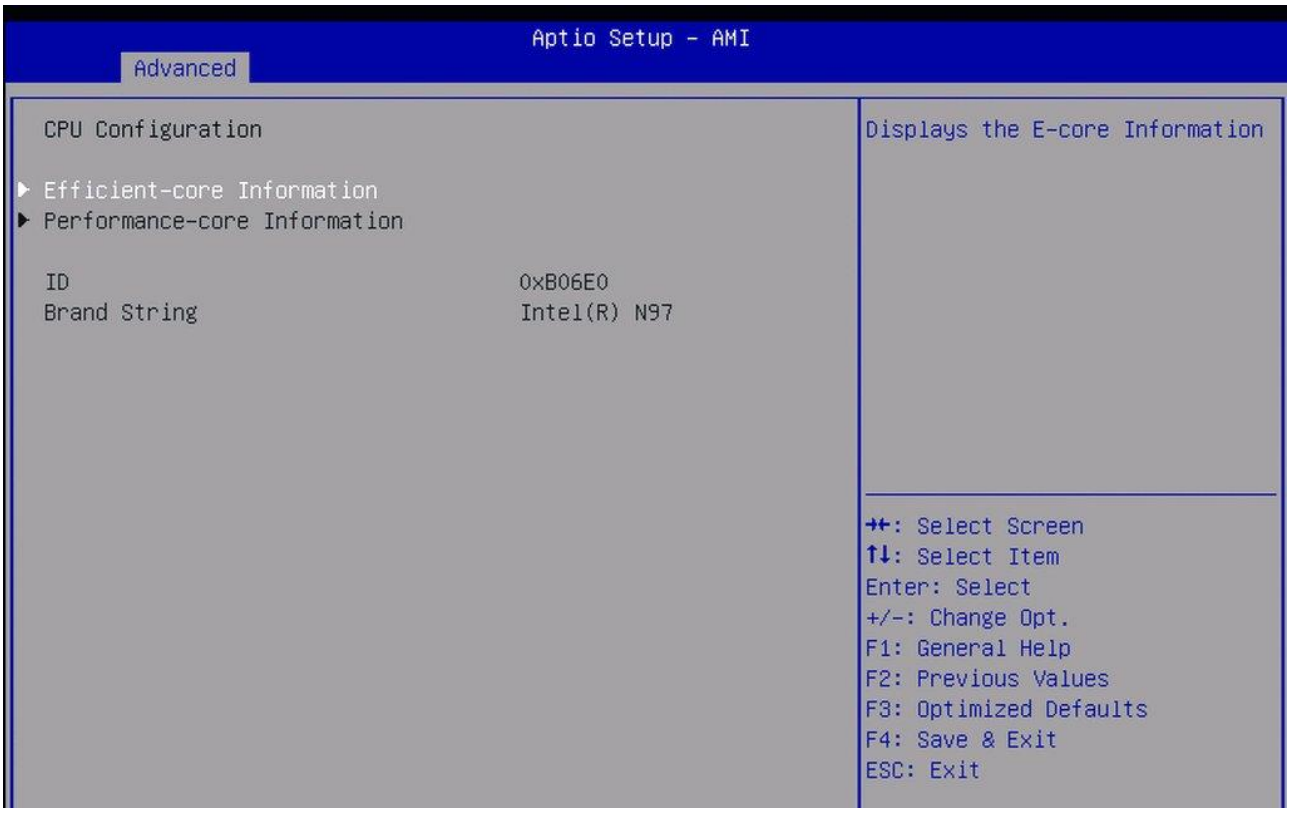
NOTE:

When all selectable items are not listed in the BIOS, it only has two options to "Enabled" or "Disabled".

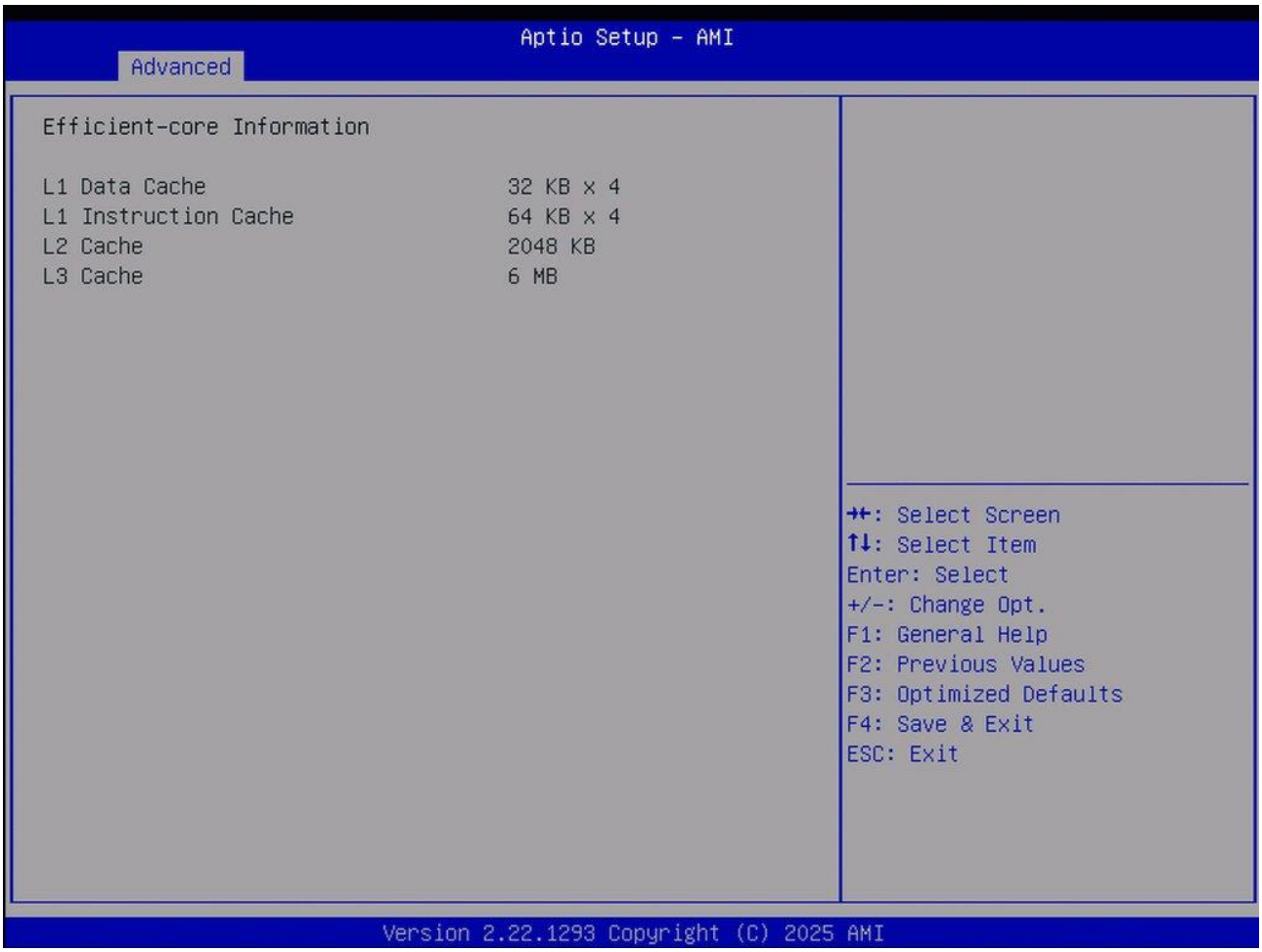
3.4 Advanced Settings



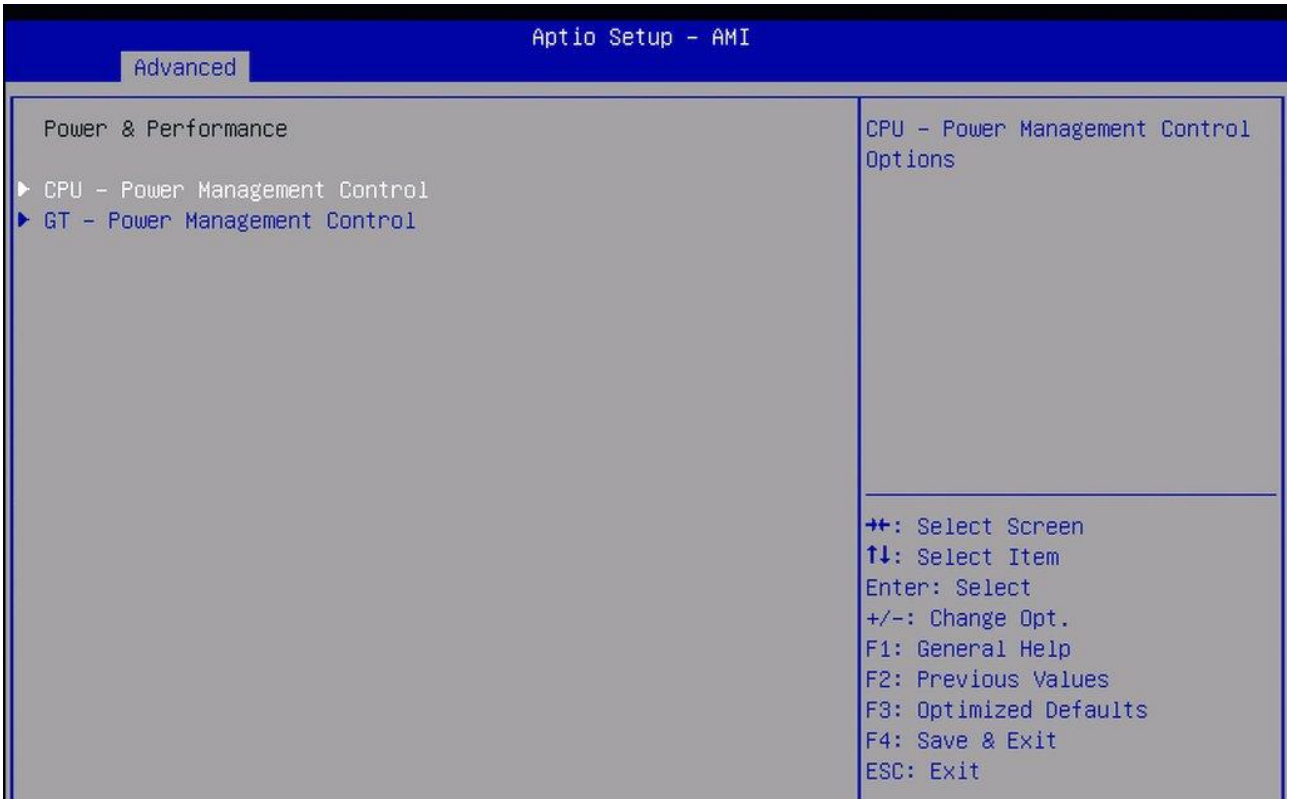
3.4.1 CPU Configuration



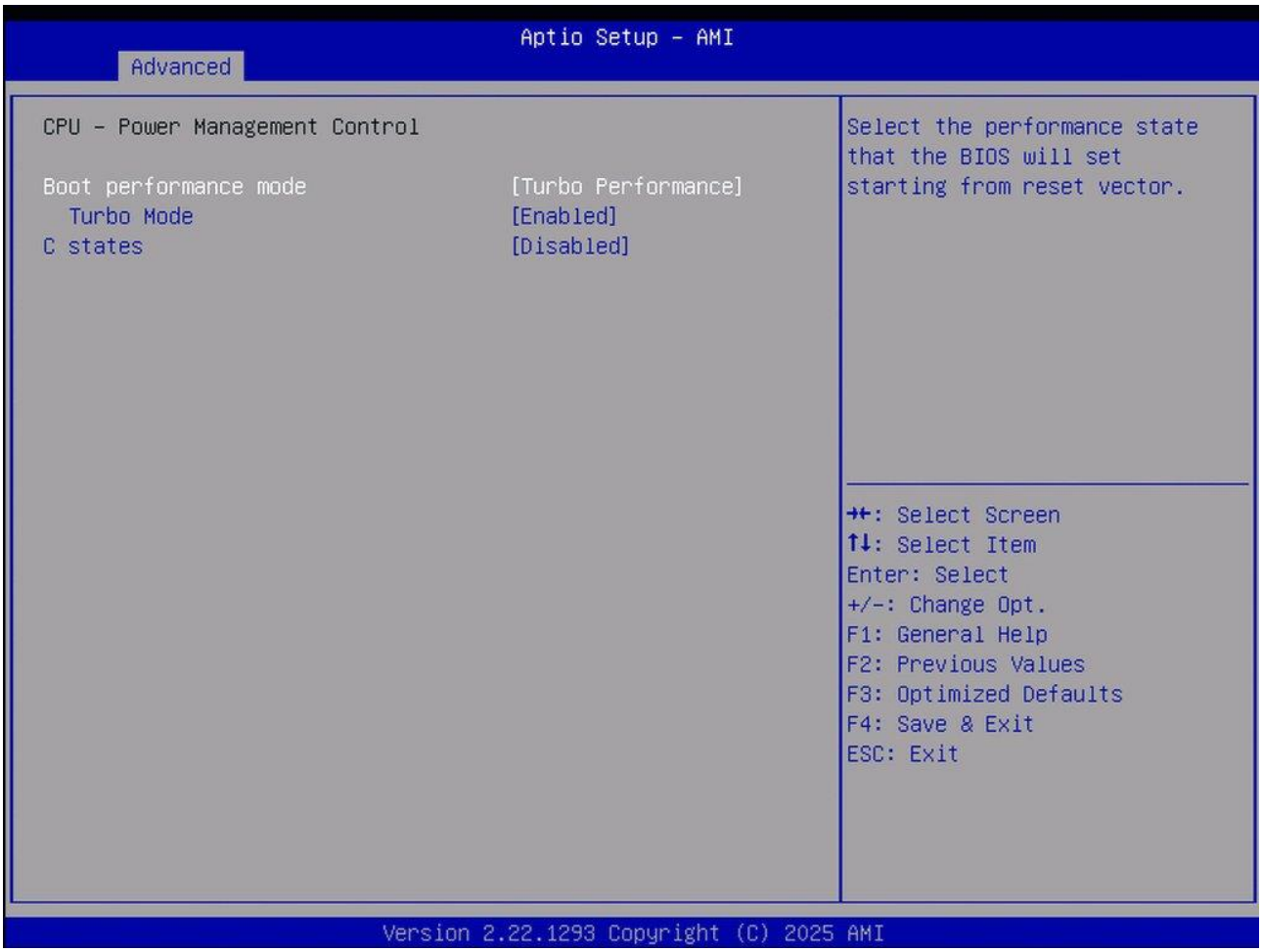
3.4.1.1 Efficient-core Information



3.4.2 Power & Performance



3.4.2.1 CPU-Power Management Control



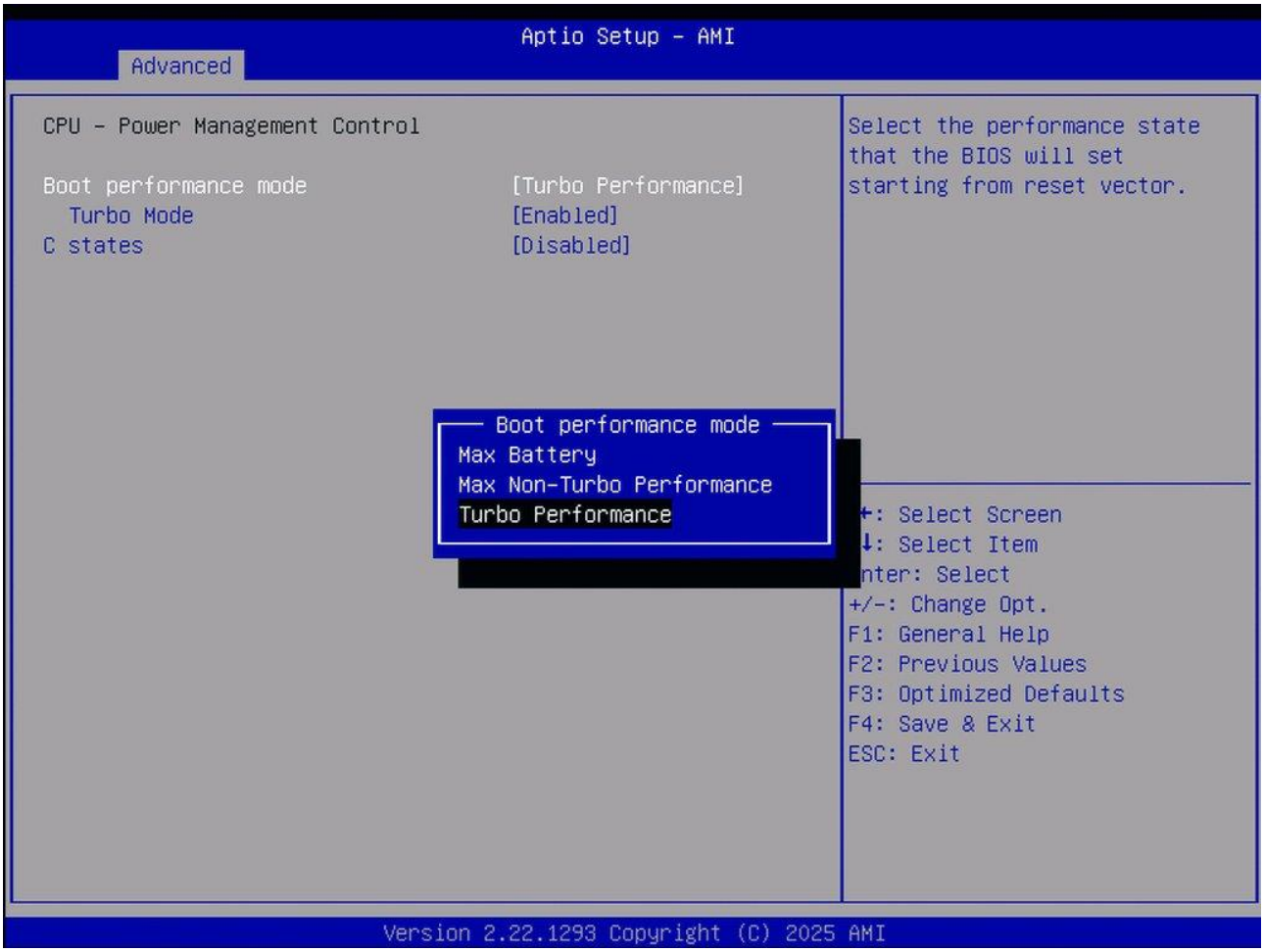
Boot performance mode:

Select the performance state that the BIOS will set starting from reset vector.

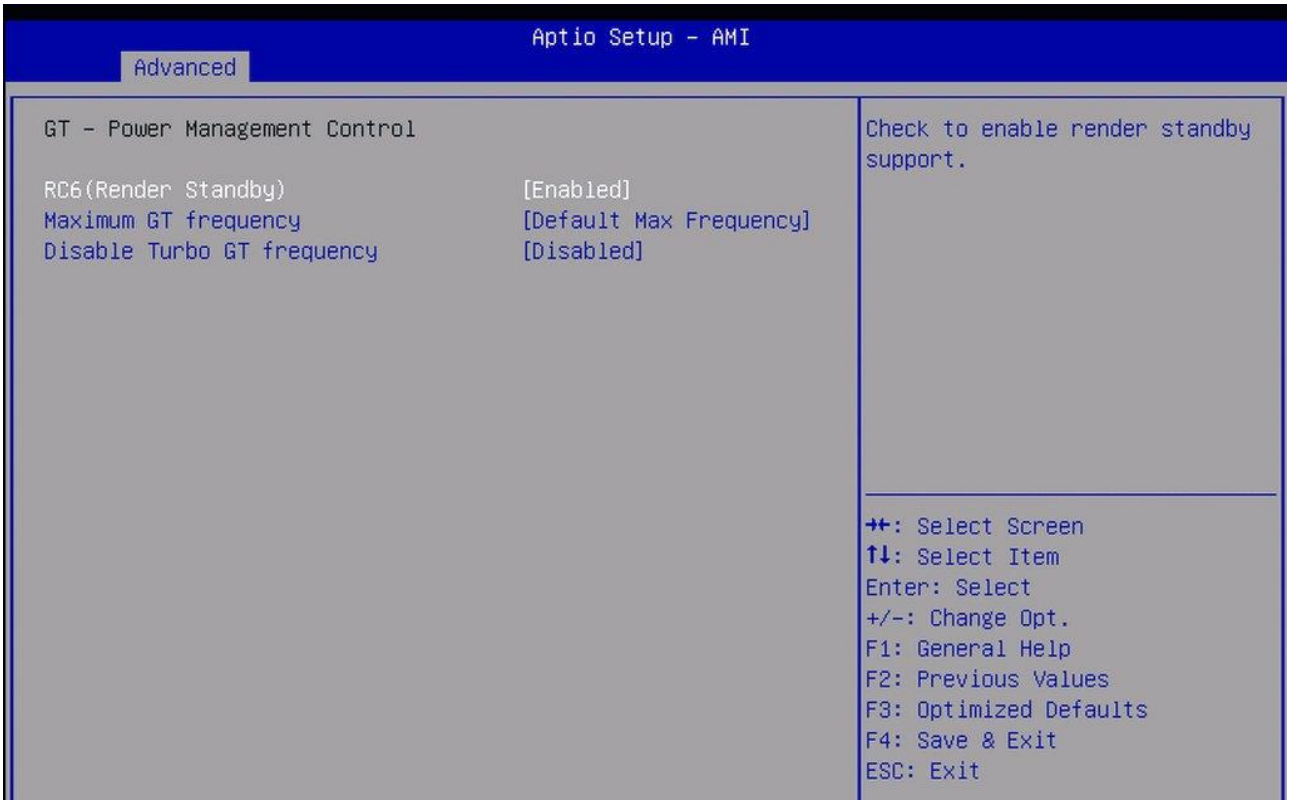
Turbo Mode:

Enable/Disable processor Turbo Mode (requires EMTTM enabled too).AUTO means enabled.

2.4.2.1.1 Boot performance mode



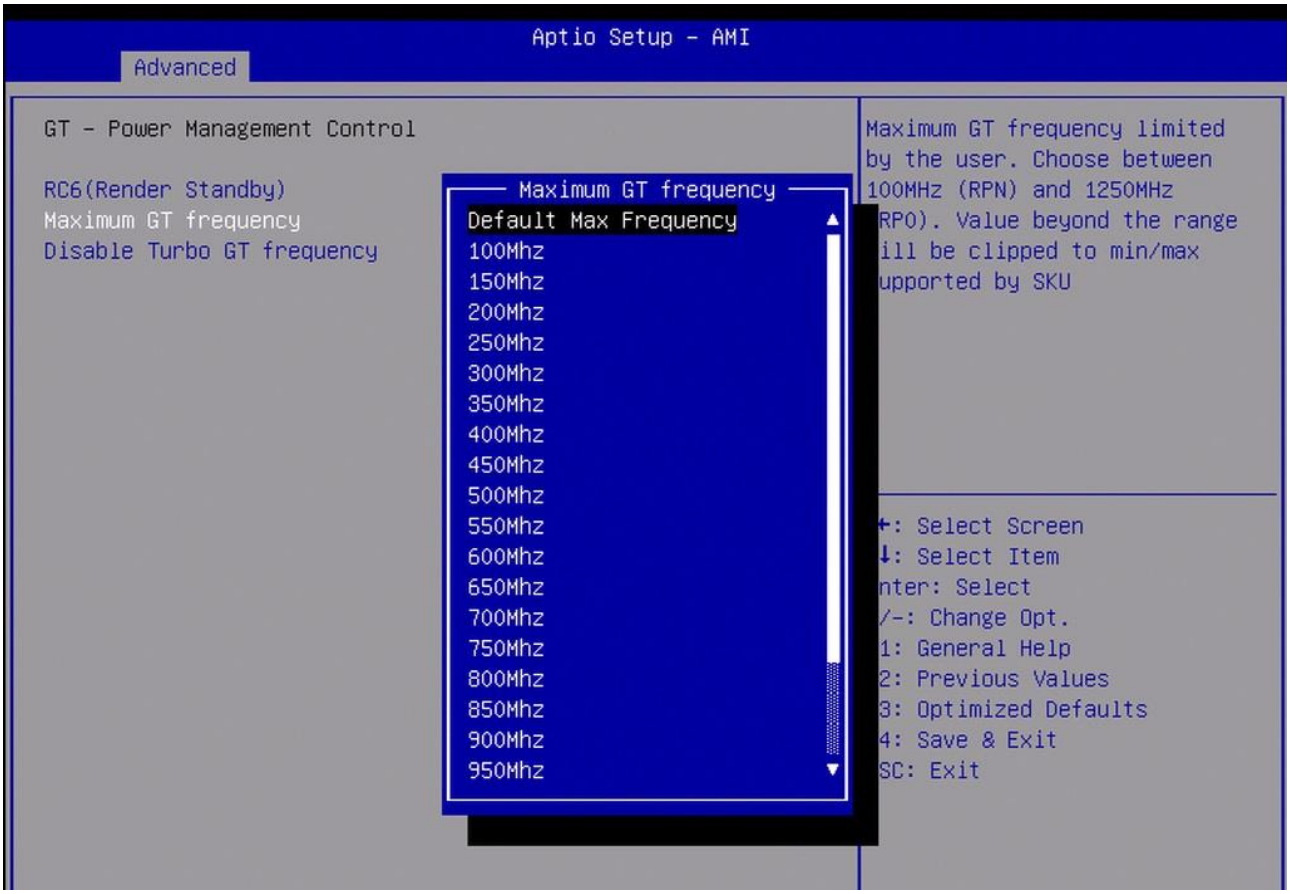
3.4.2.2 GT- Power Management Control



RC6(Render Standby):

Check to enable render standby support.

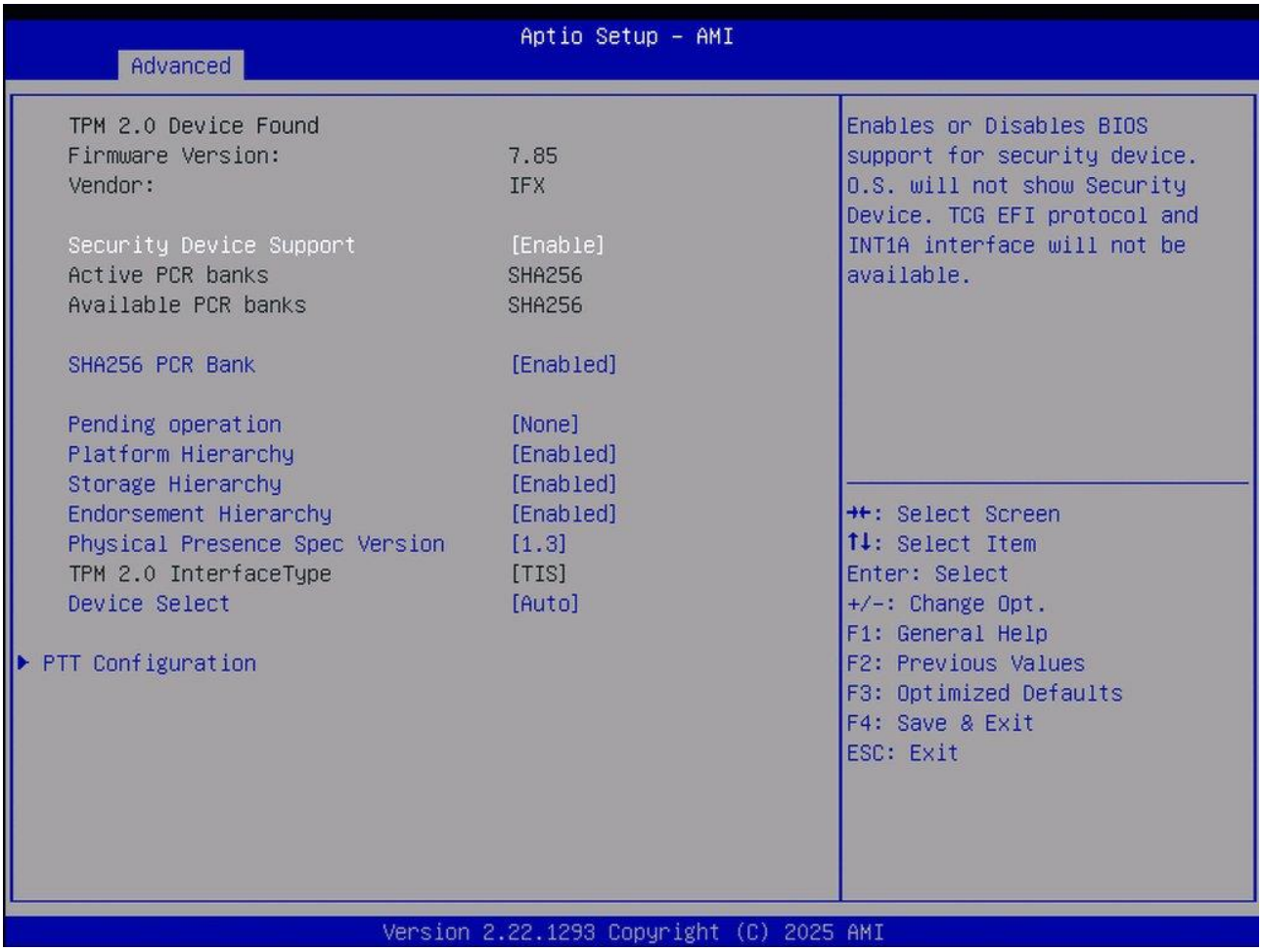
Maximum GT frequency:



Disable Turbo GT frequency:

Enabled: Disables Turbo GT frequency. Disabled: GT frequency is not limited

3.4.3 Trusted Computing



Security Device support:

Enables or Disables BIOS support for security device. o.S. wll not show Security Device. TCG EFI protocol and INT1A interface will not be available.

SHA256 PCR Bank:

Enable or Disable SHA256 PCR Bank

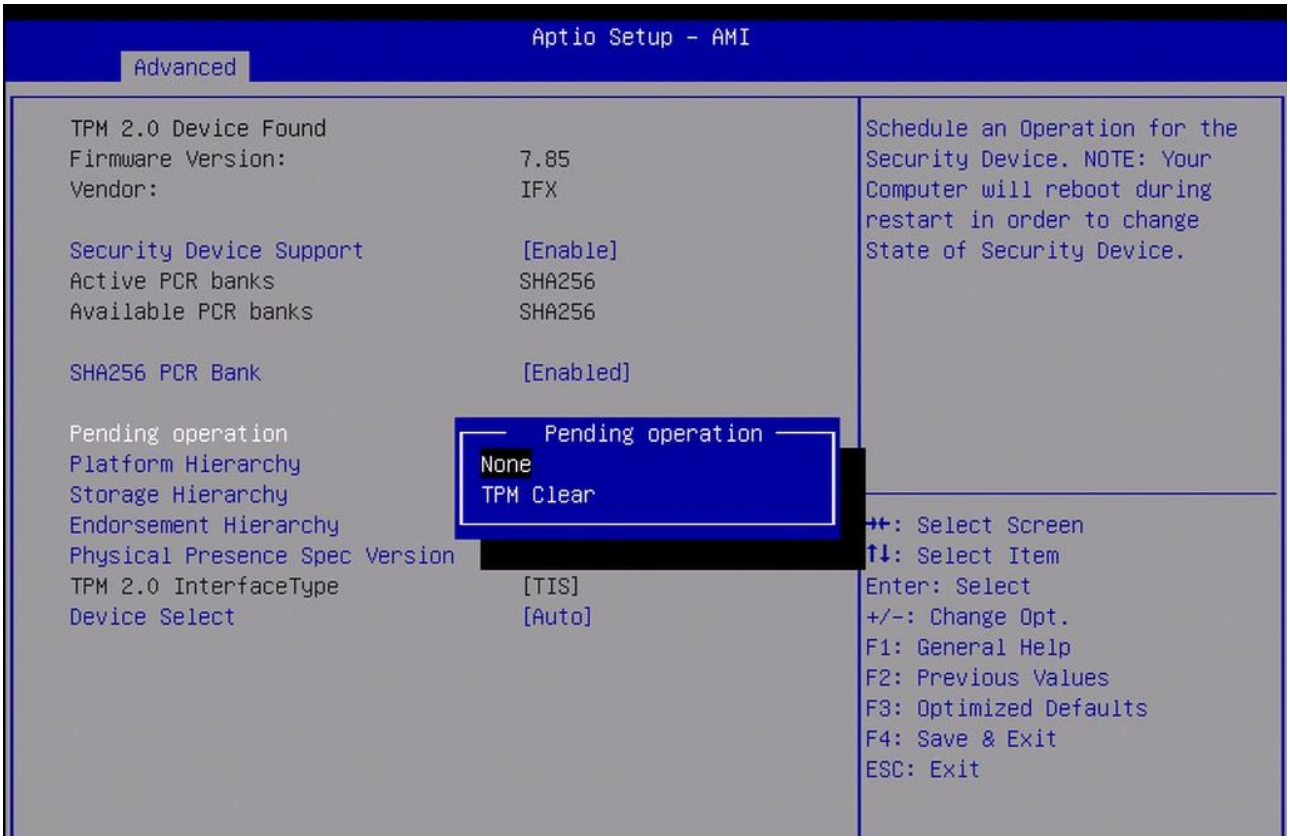
Pending operation:

Schedule an Operation for the Security Device.NOTE:Your Computer will reboot during restart in order to change State of Security Device.

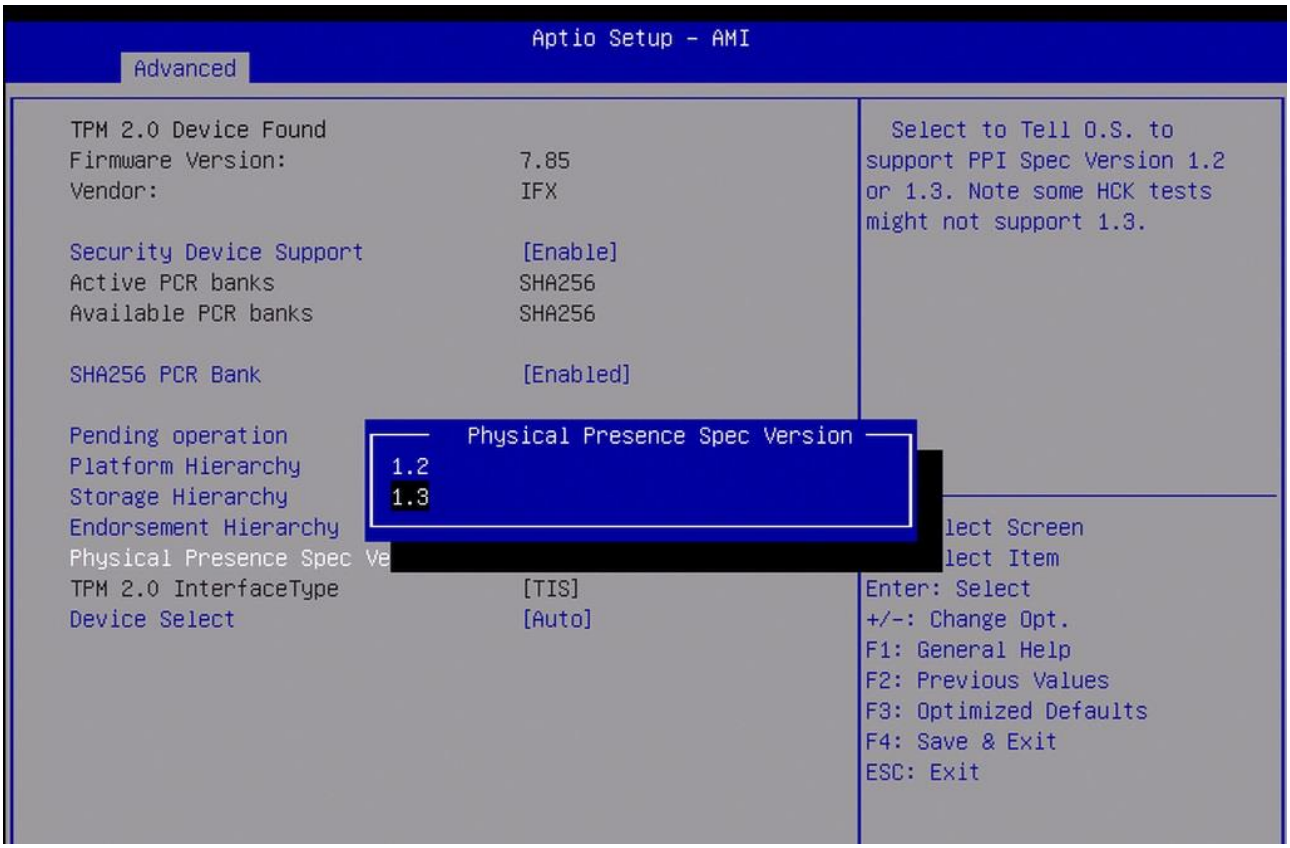
Device Select:

TPM1.2 will restict support to TPM 1.2 devices, TPM 2.0 will restict support to TPM 2.0 devices, Auto wll upport both with the default set toTPM 2.0 devices if not found,TPM 1.2 devices will be enumerated

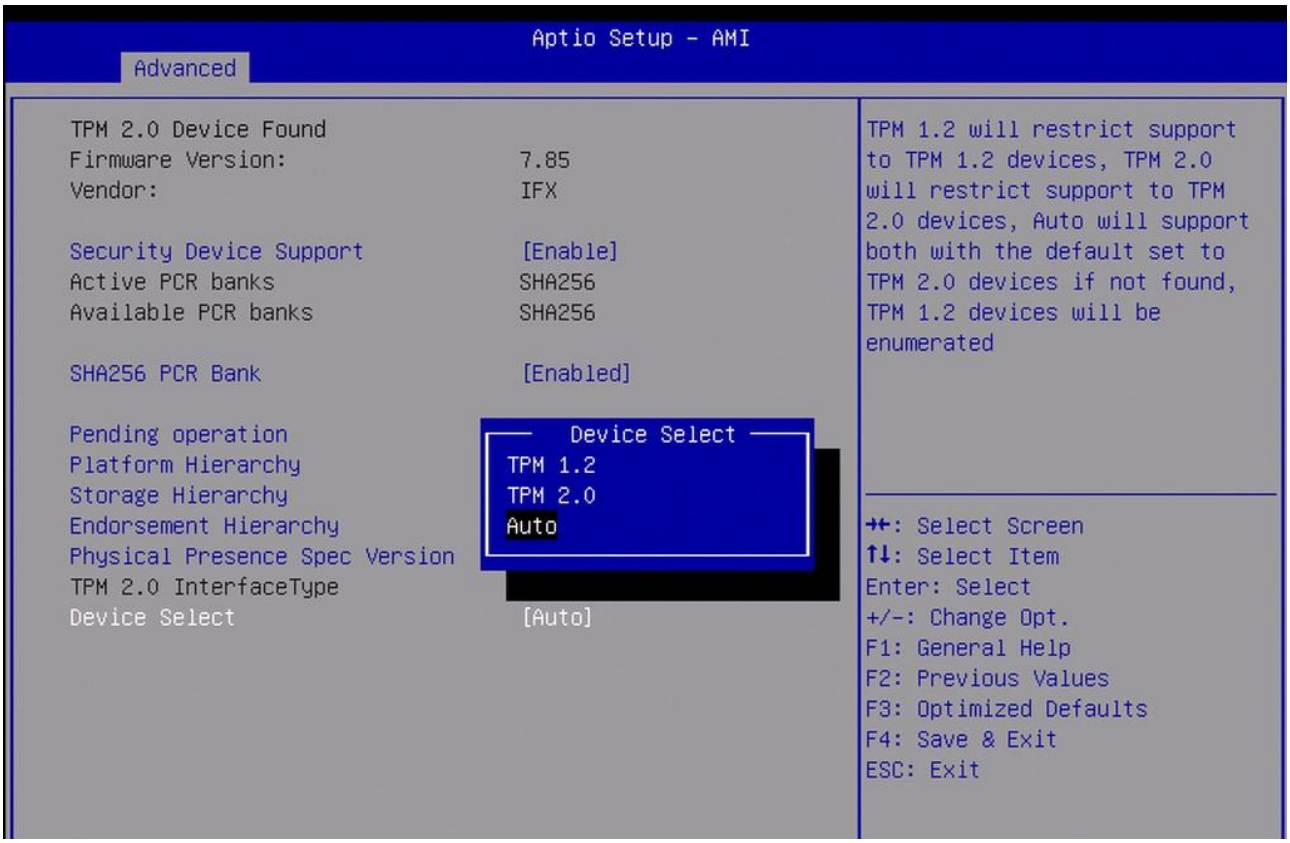
3.4.3.1 Pending operation



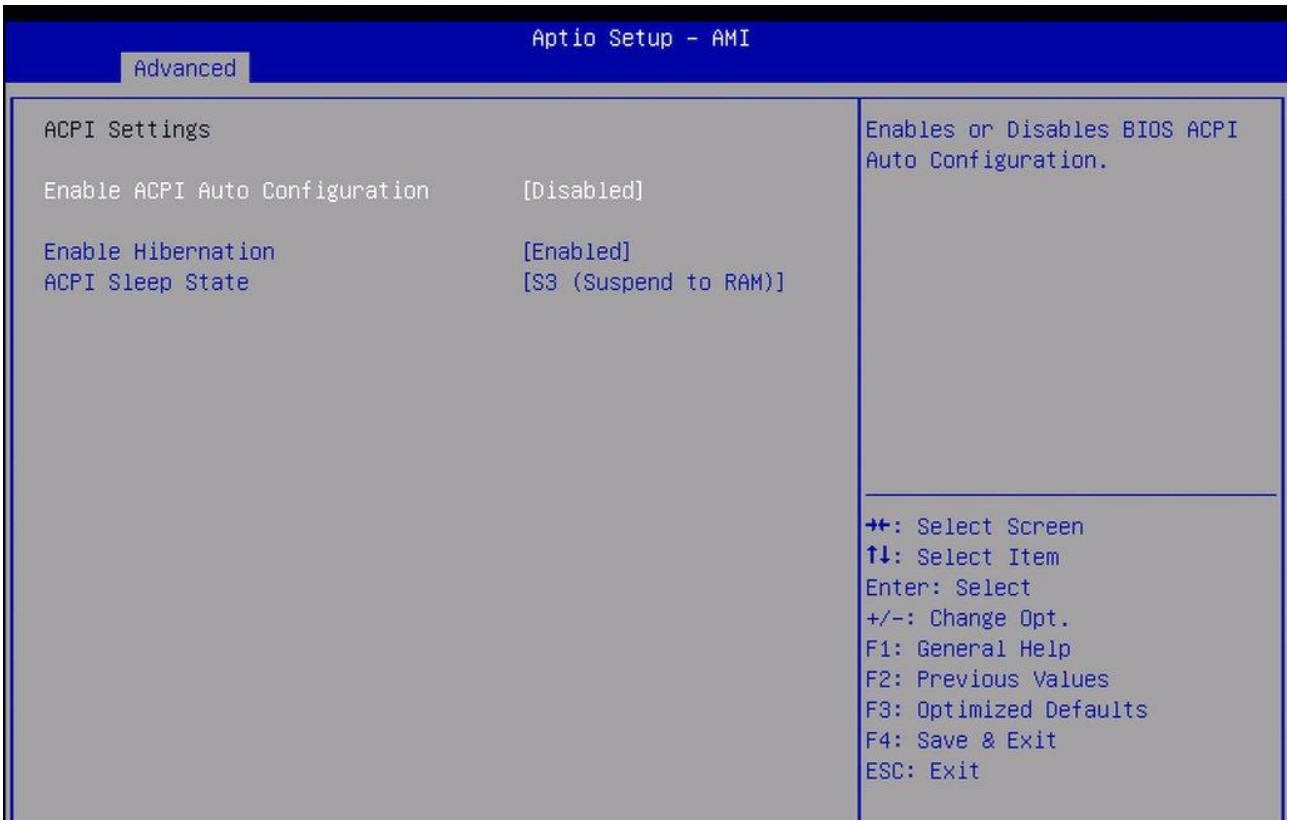
3.4.3.2 Physical Presence Spec Version



3.4.3.3 Device Select



3.4.4 ACPI Settings



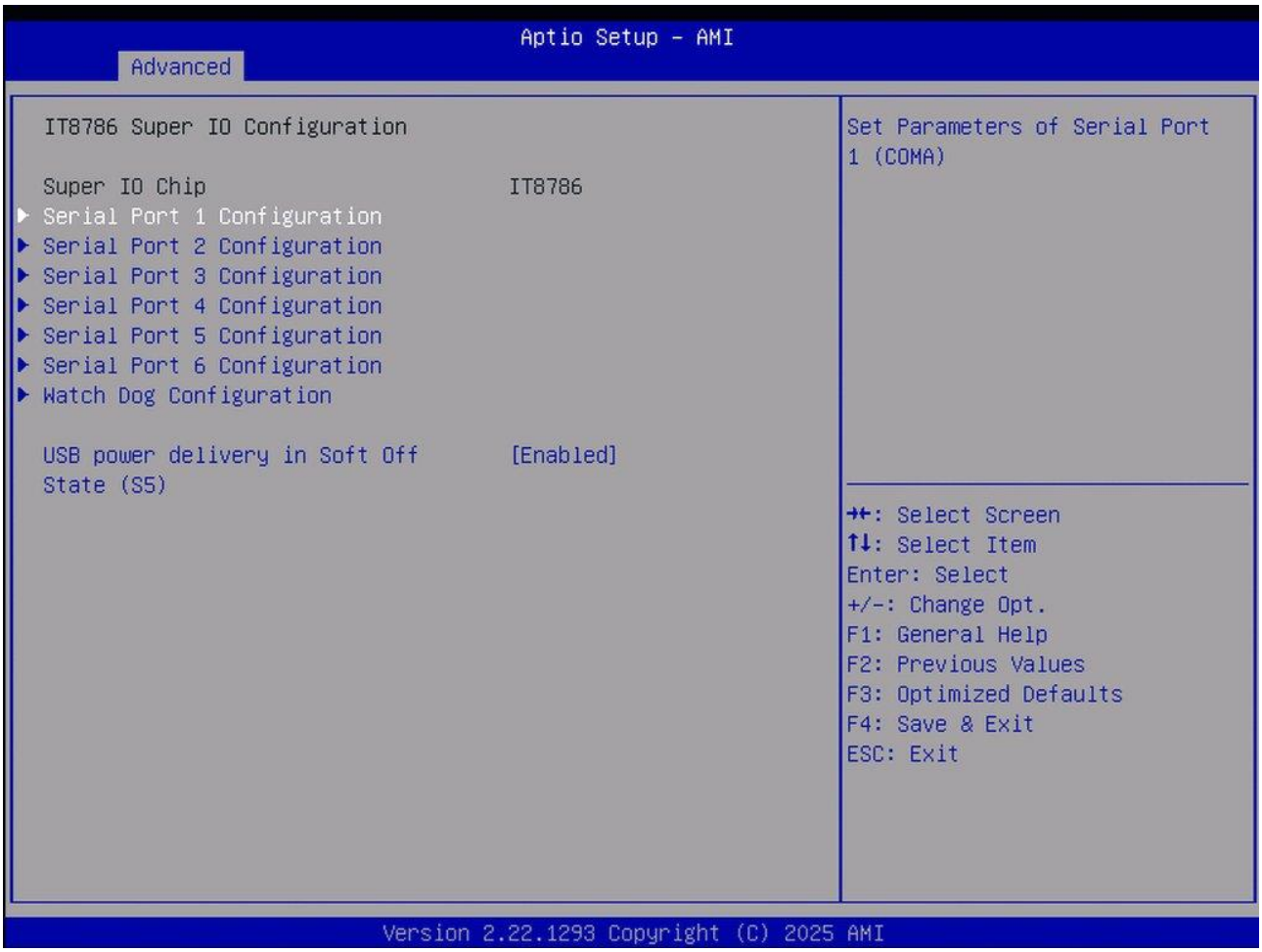
Enable Hibernation:

Enables or Disables System ability to Hibernate(OS/S4 Ssleep State). This option may not be effective with some operating systems.

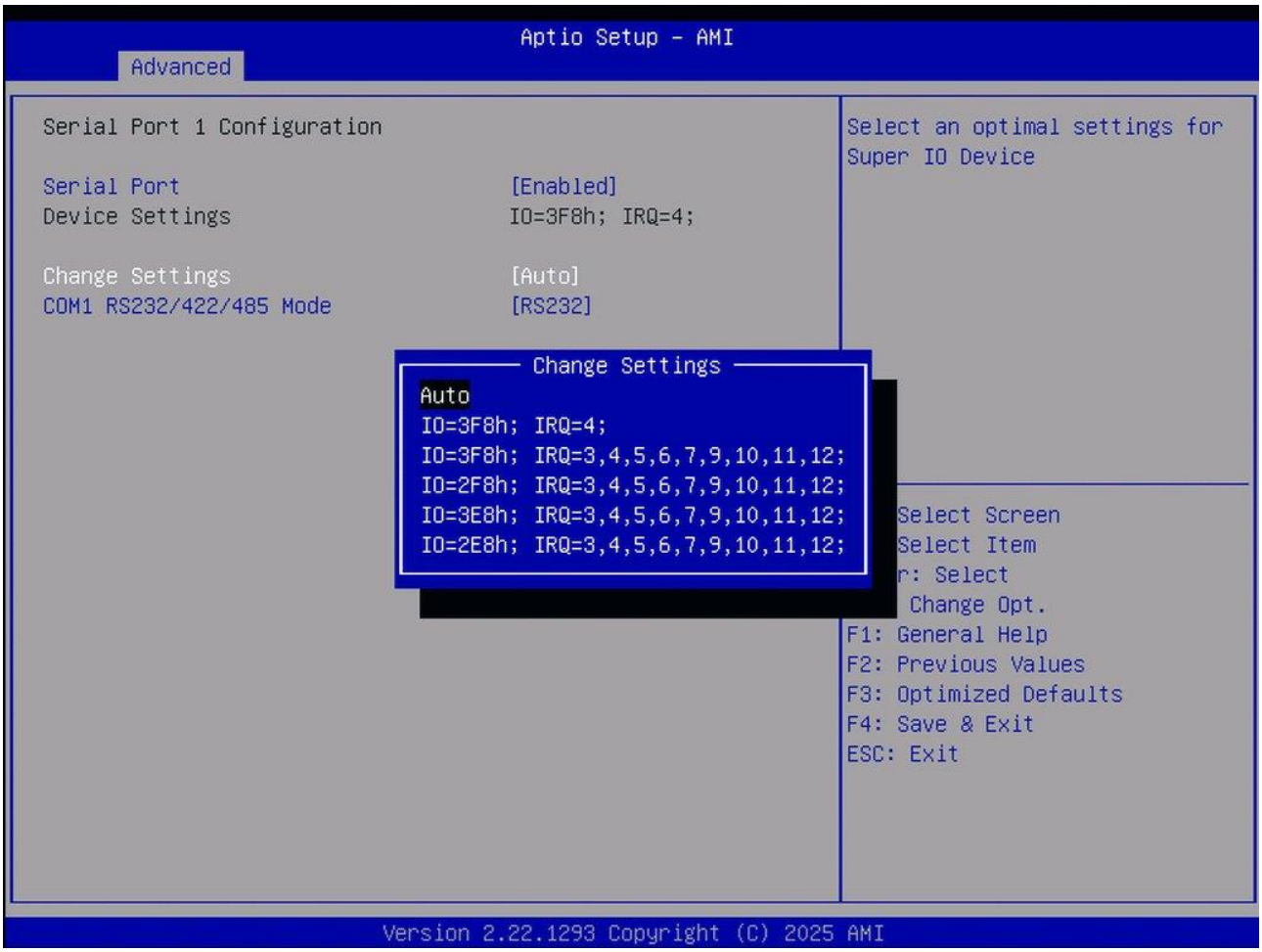
ACPI Sleep State:

Select the highest ACPI sleep state the system will enter when the SUSPEND button is pressed.

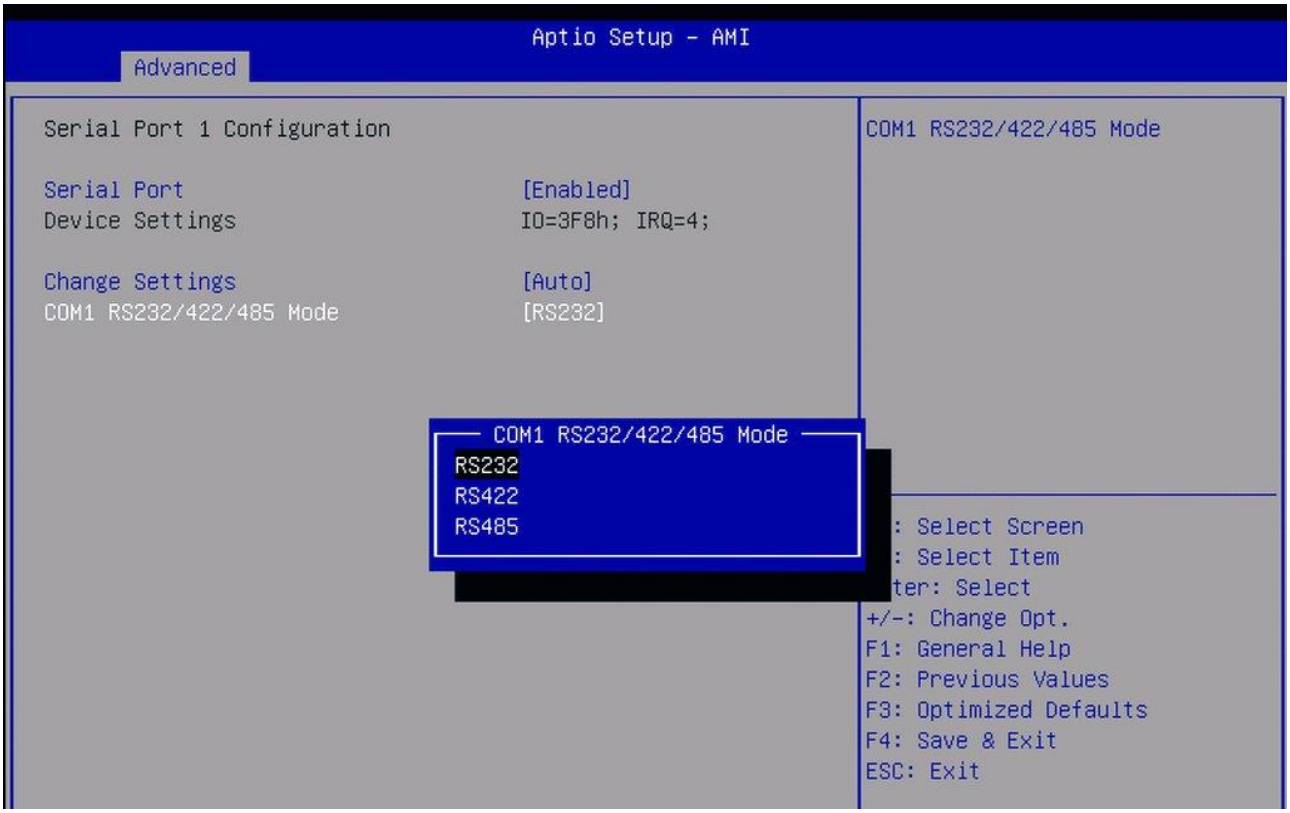
3.4.5 IT8786 Super IO Configuration



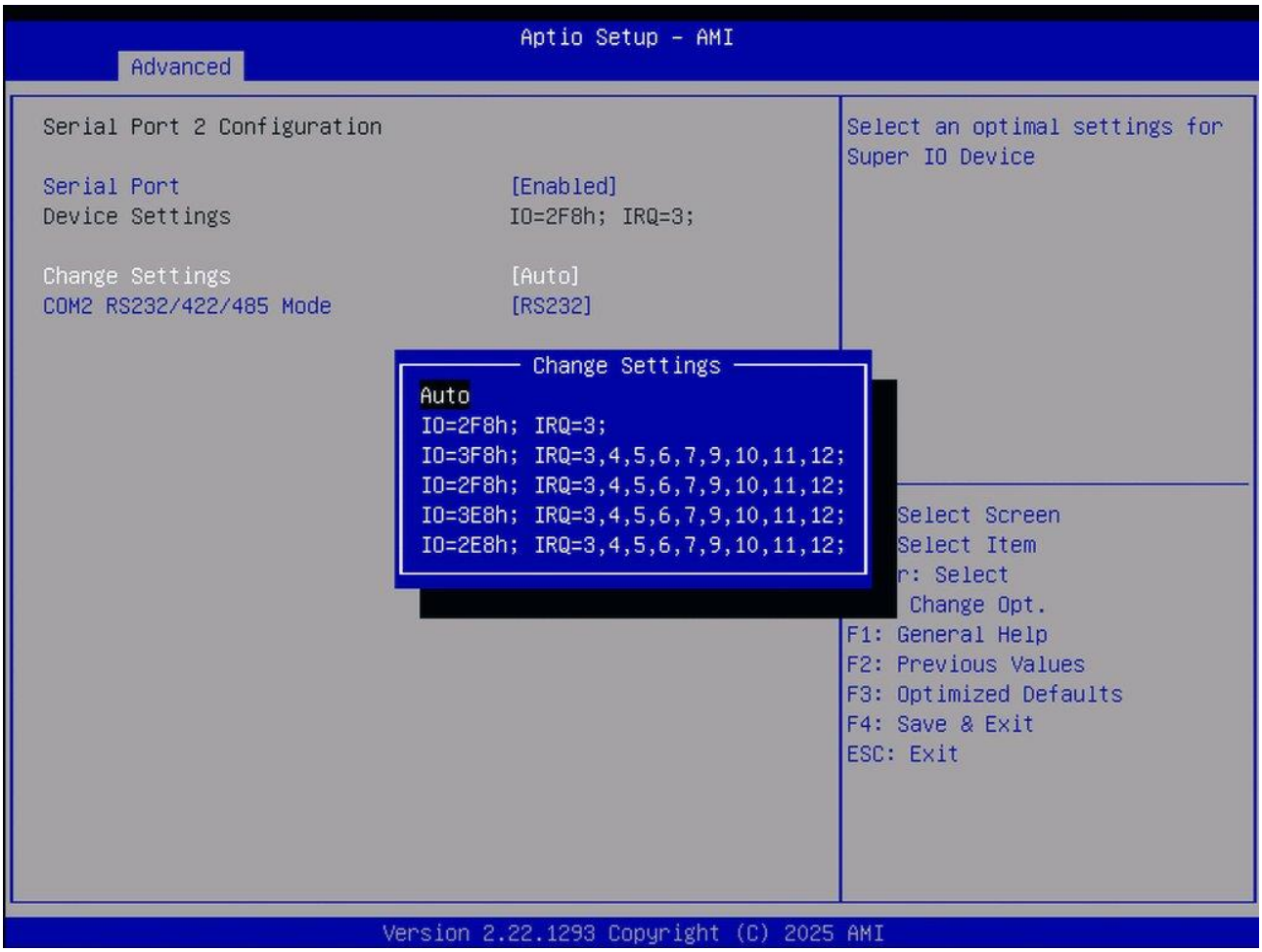
3.4.5.1 Serial Port 1 Configuration



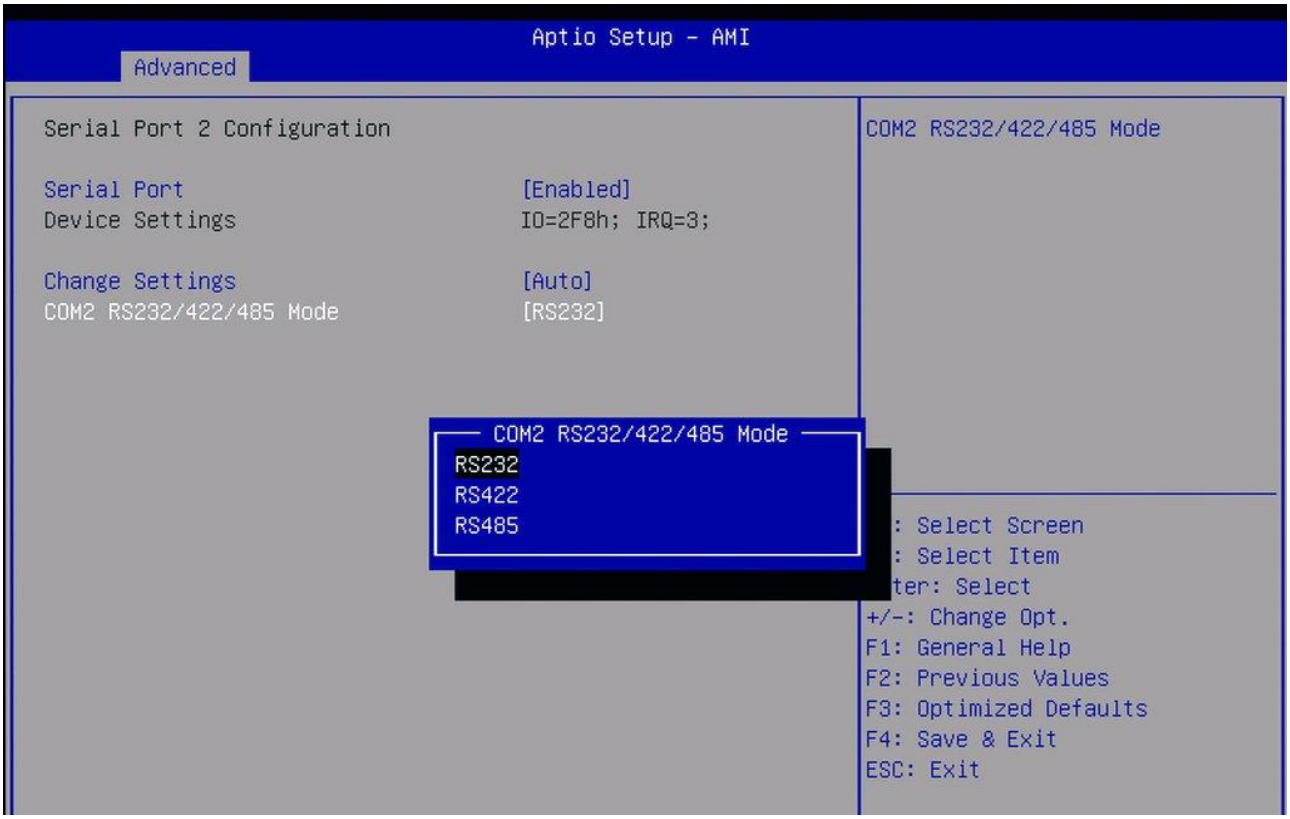
Com1 RS232/422/485 Mode



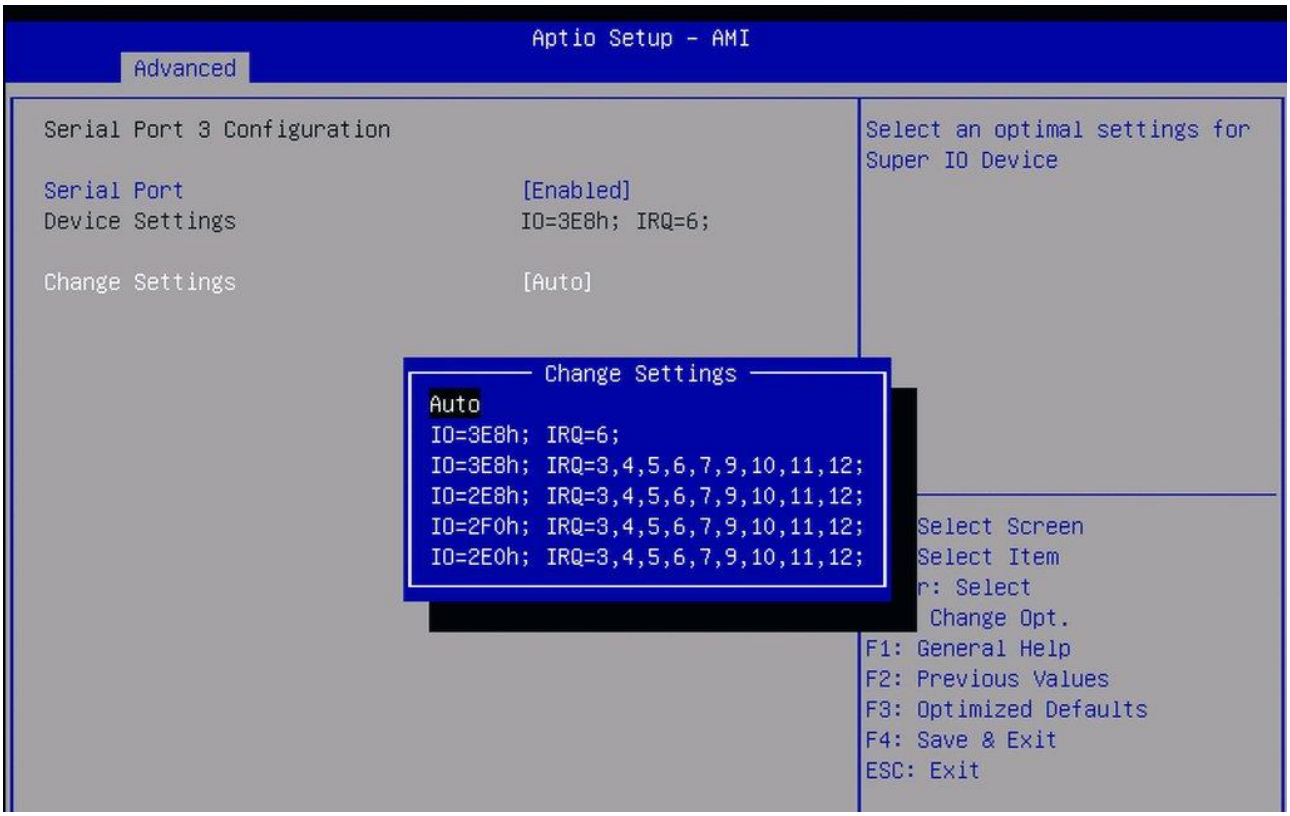
3.4.5.2 Serial Port 2 Configuration



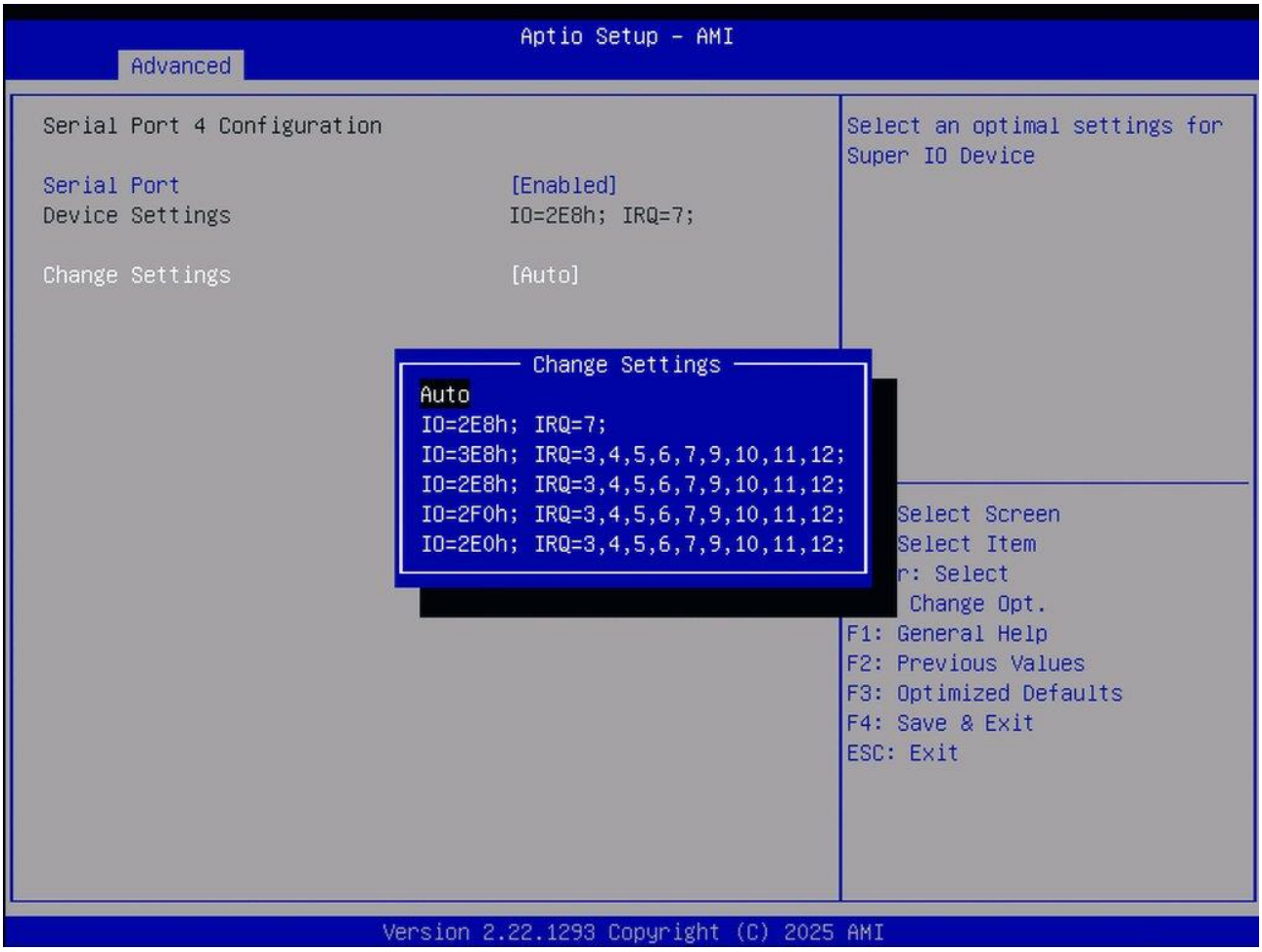
Com2 RS232/422/485 Mode



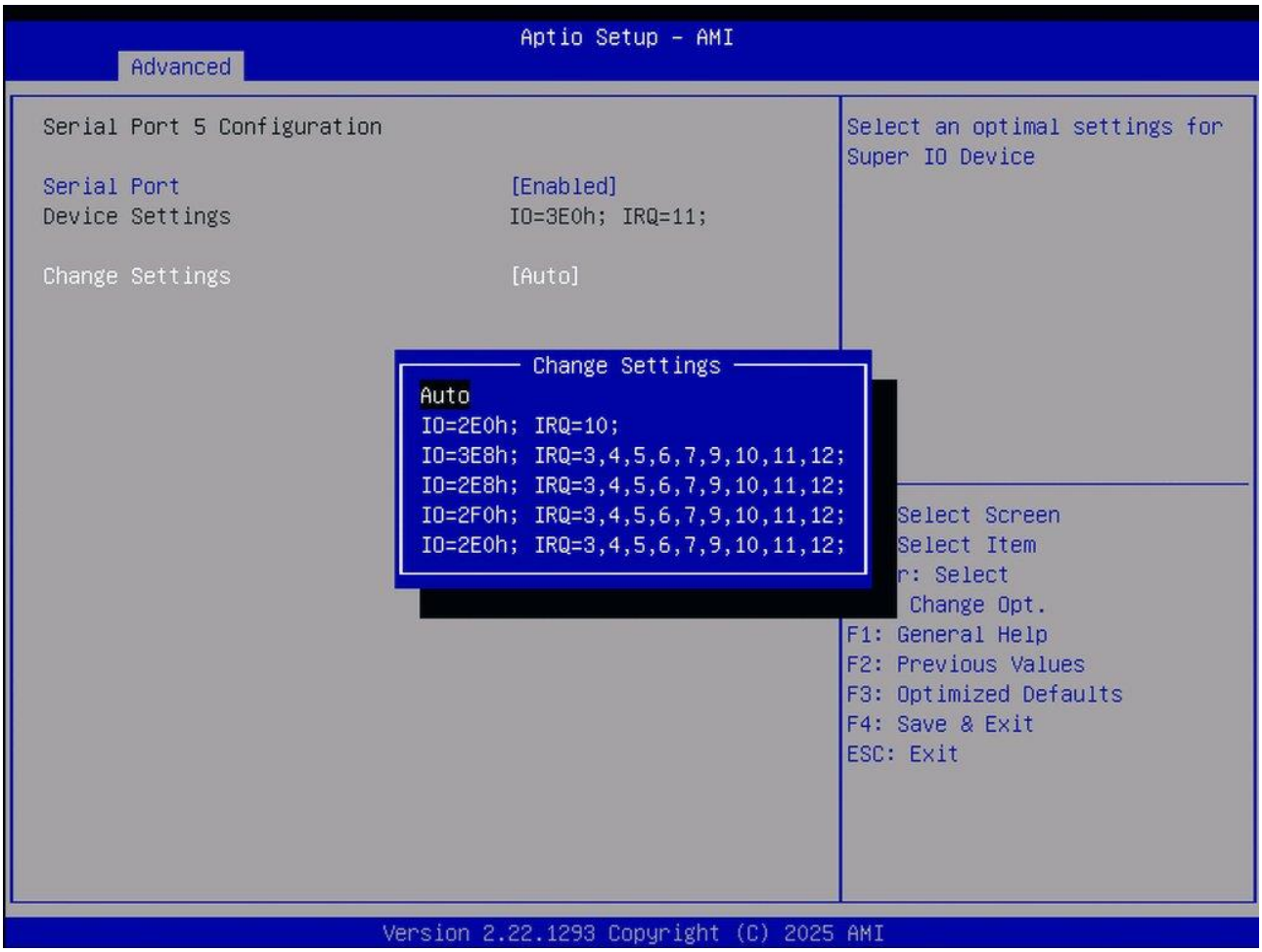
3.4.5.3 Serial Port 3 Configuration



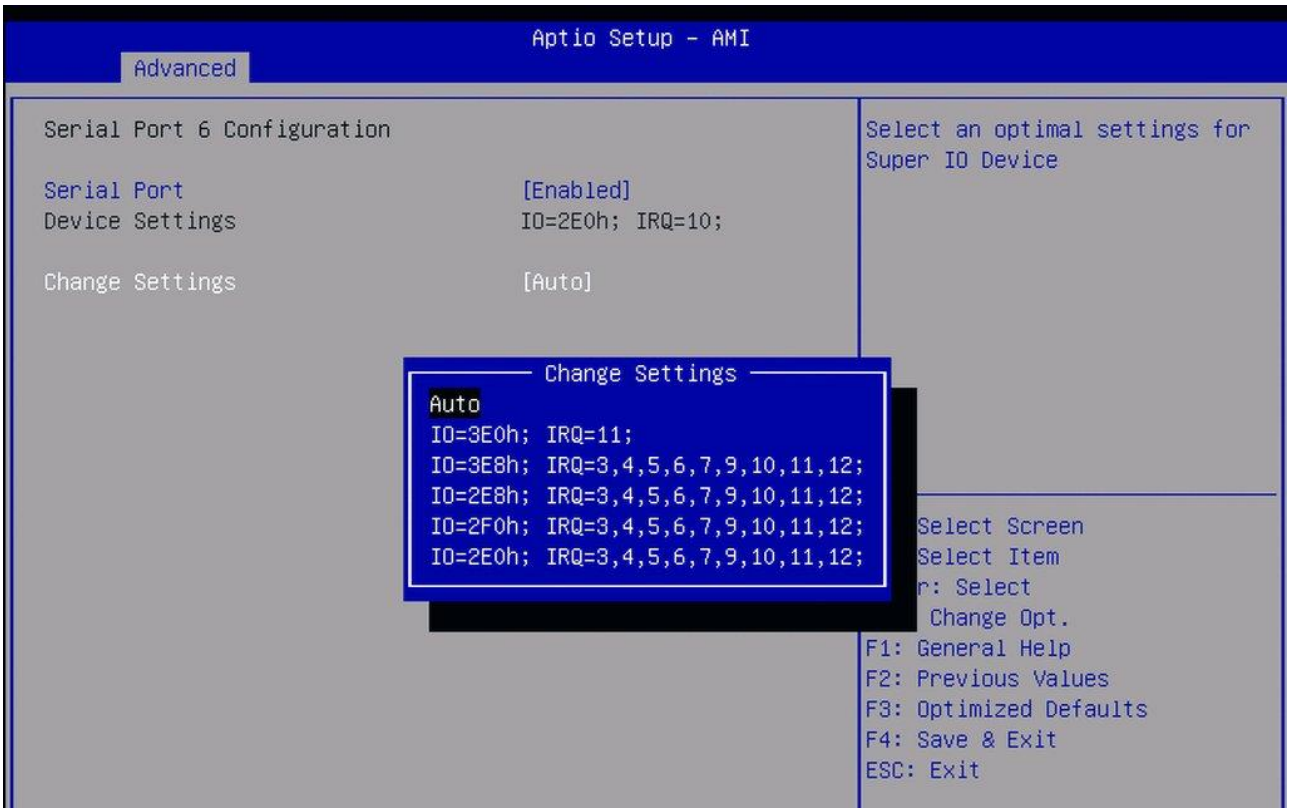
3.4.5.4 Serial Port 4 Configuration



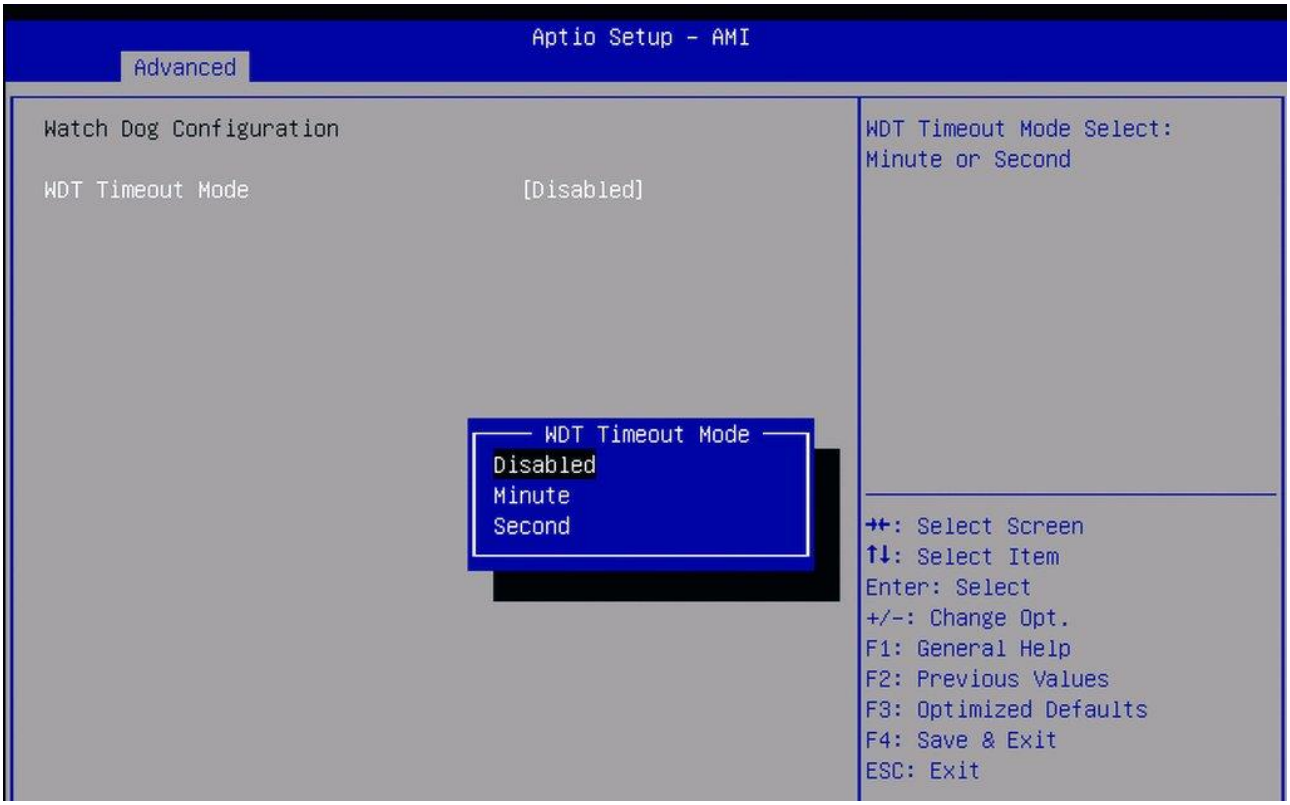
3.4.5.5 Serial Port 5 Configuration



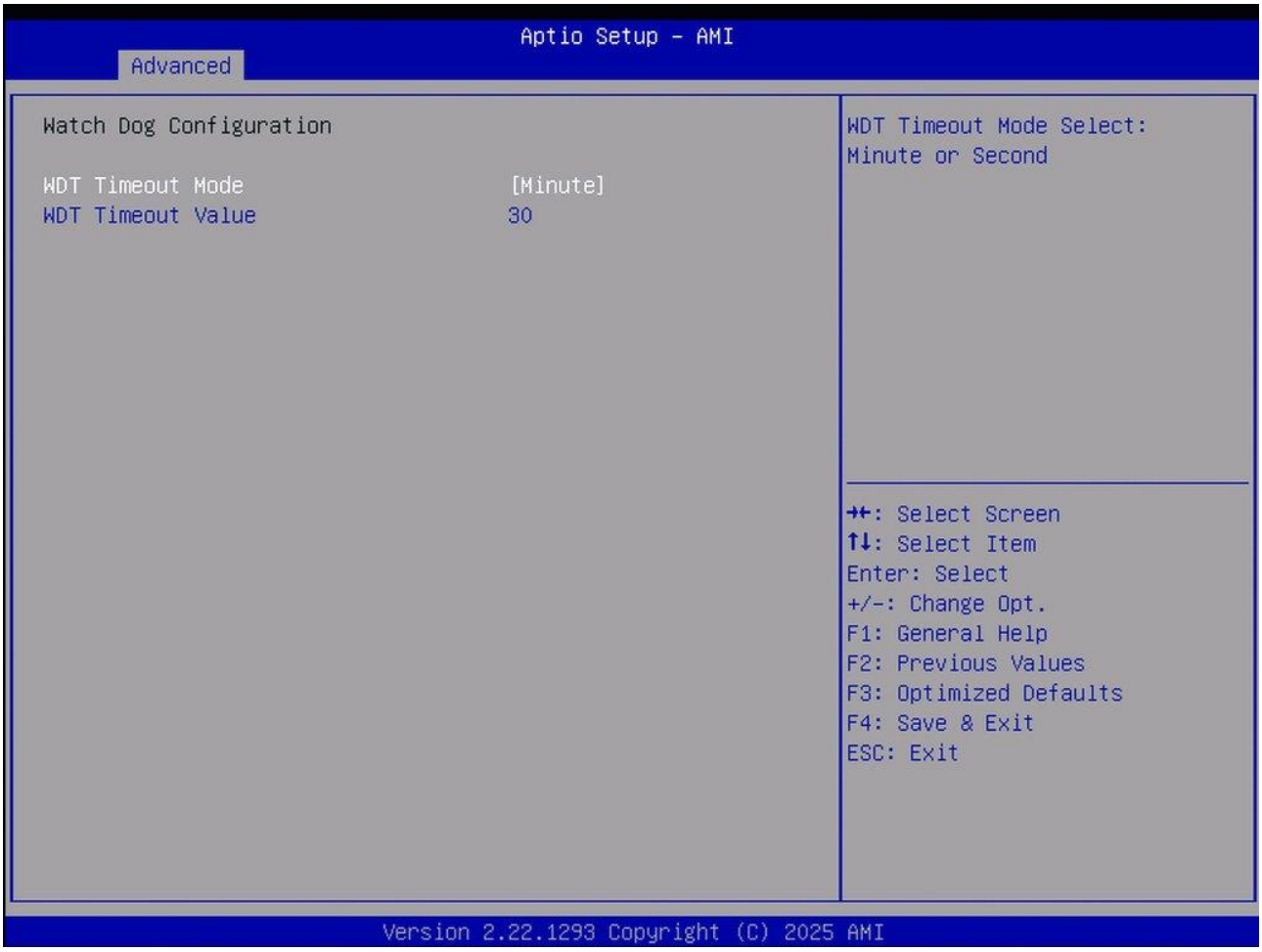
3.4.5.6 Serial Port 6 Configuration



3.4.5.7 Watch Dog Configuration

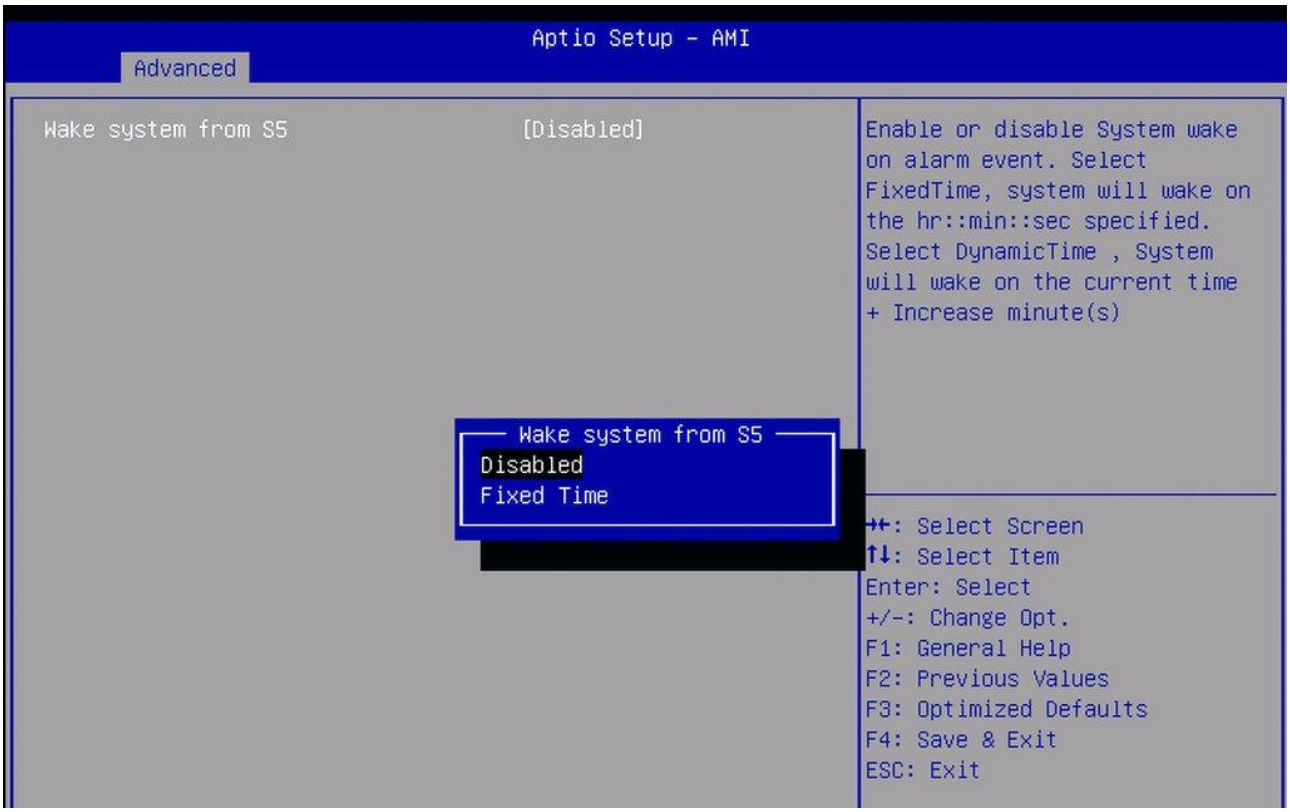


WDT Timeout Value:0~255 Miunte



WDT Timeout Value:0~255 Second.

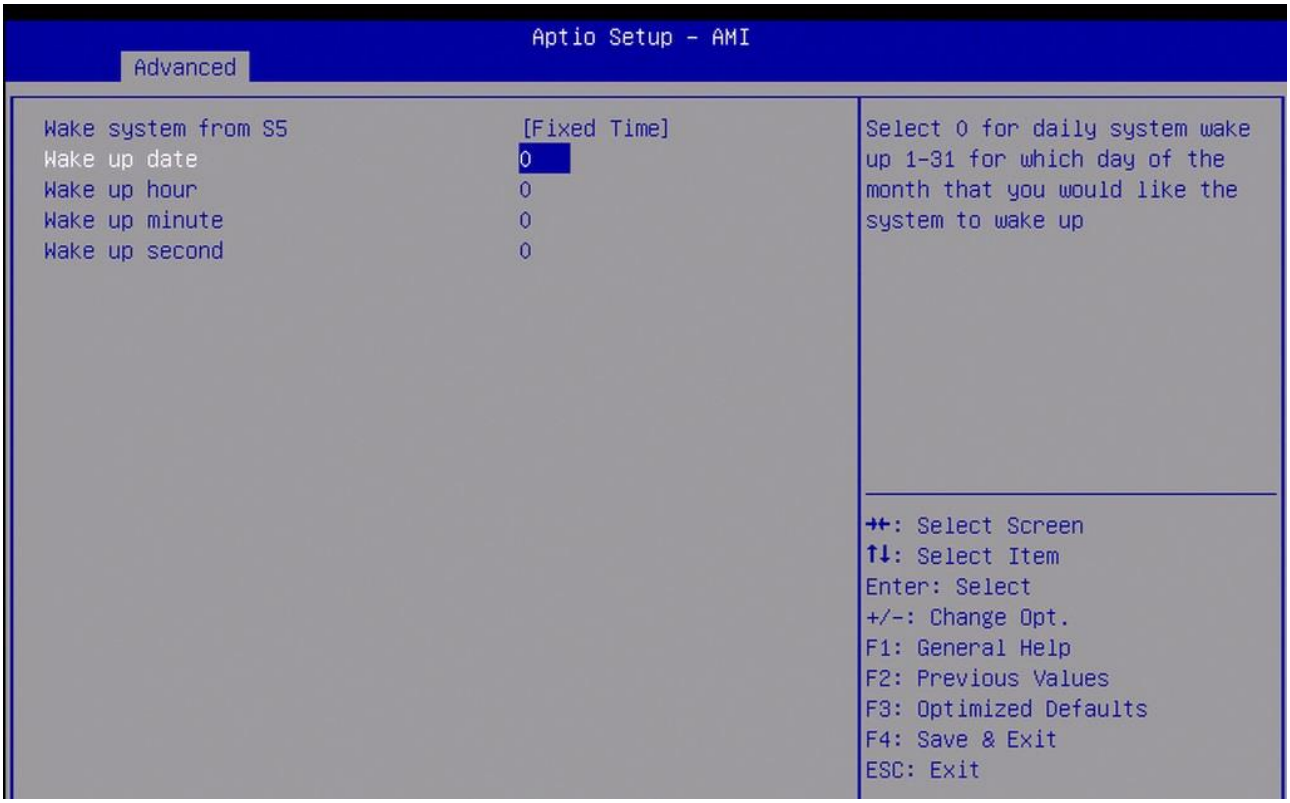
3.4.6 S5 RTC Wake Settings



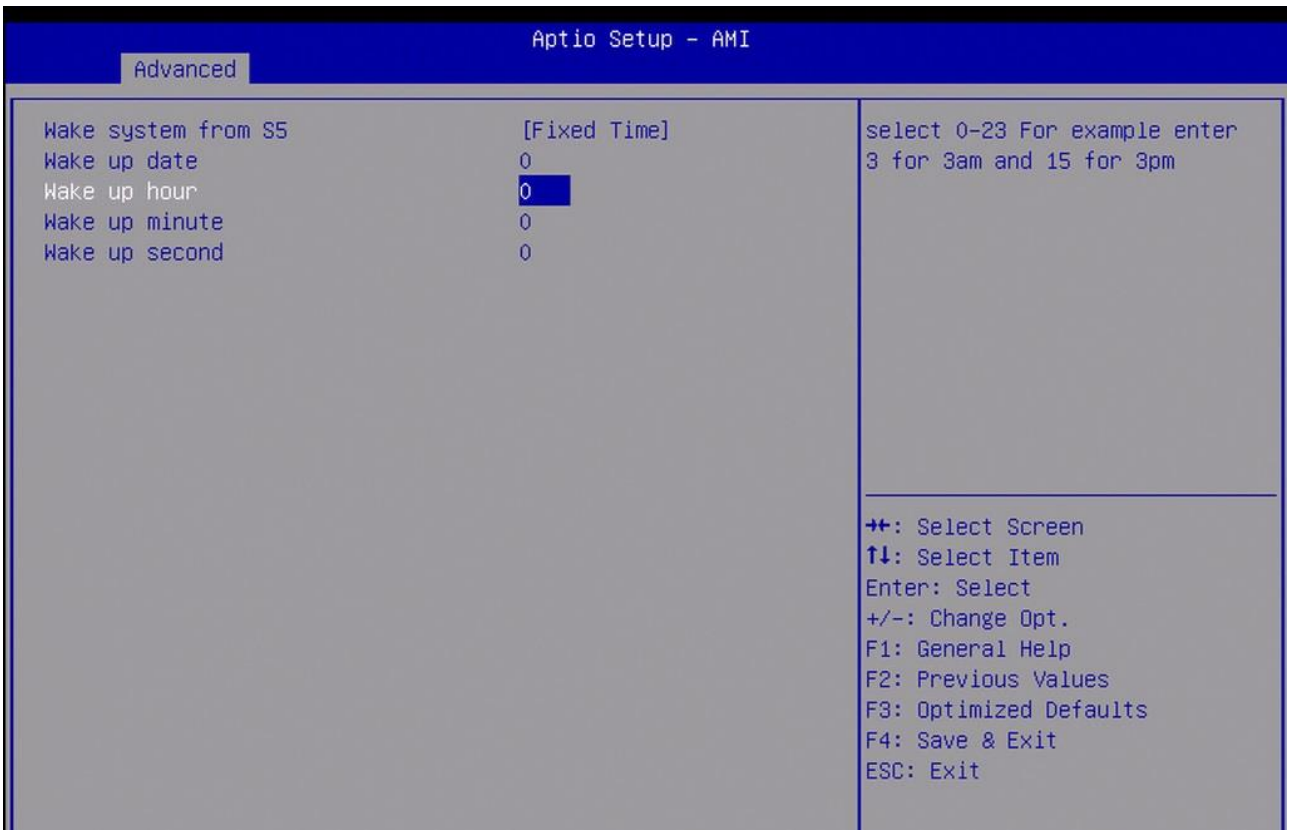
Wake system from S5:

Enable or disable System wake on alarm event. Select Fixed Time, system will wake on the hr:min:sec specified. Select Dynamic Time , System will wake on the current time + Increase minute(s)

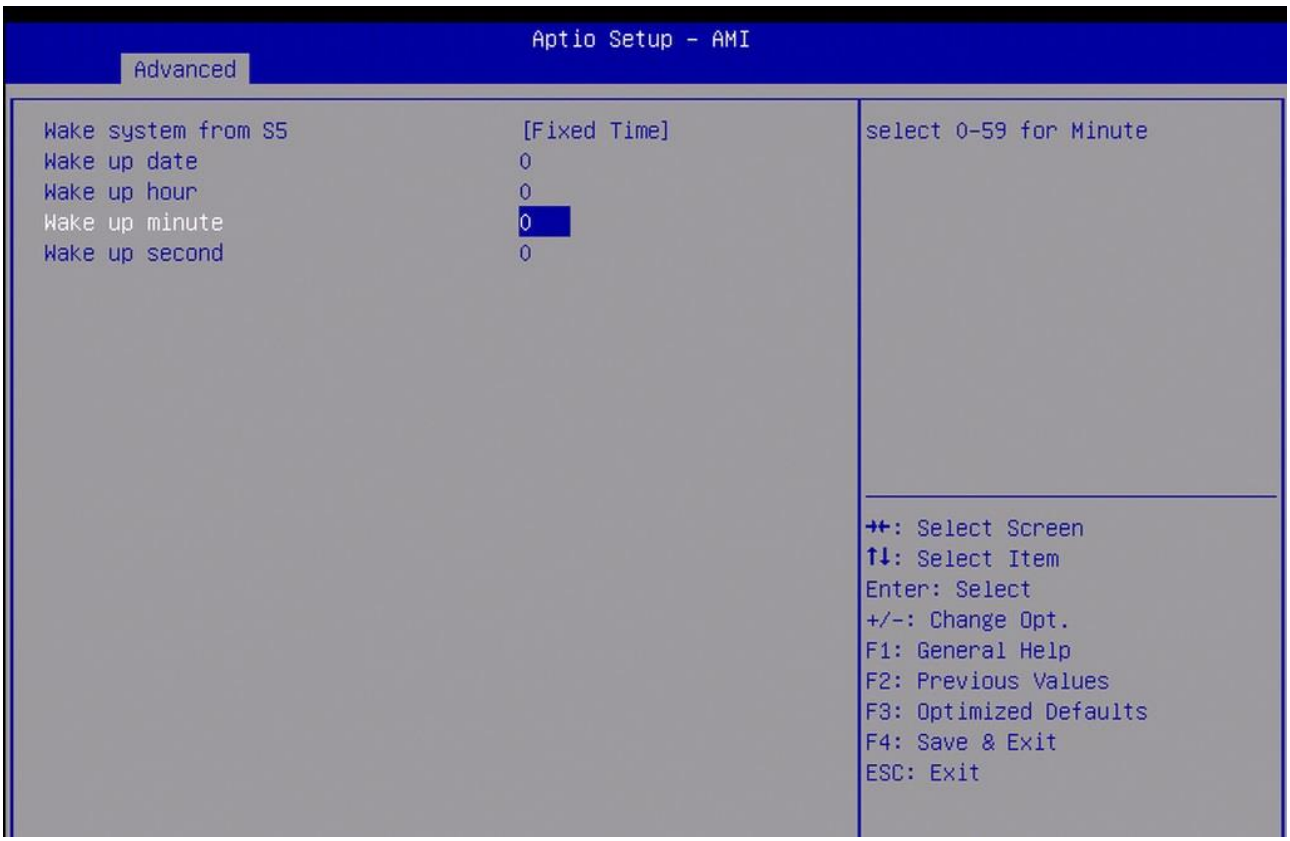
Wake up date: Select 0 for daily system wake up 1-31 for which day of the month that you would like the system to wake up



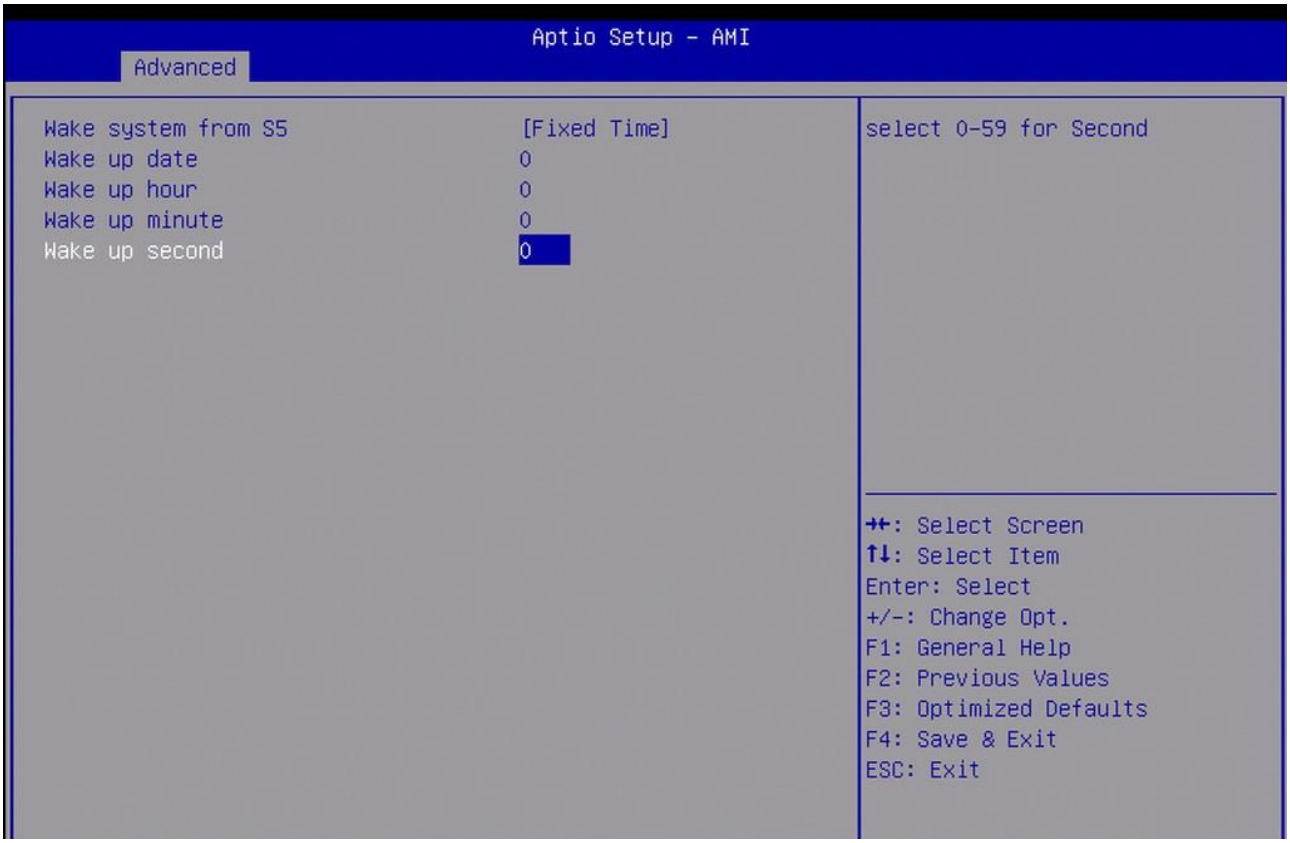
select 0-23 For example enter 3 for 3am and 15 for 3pm



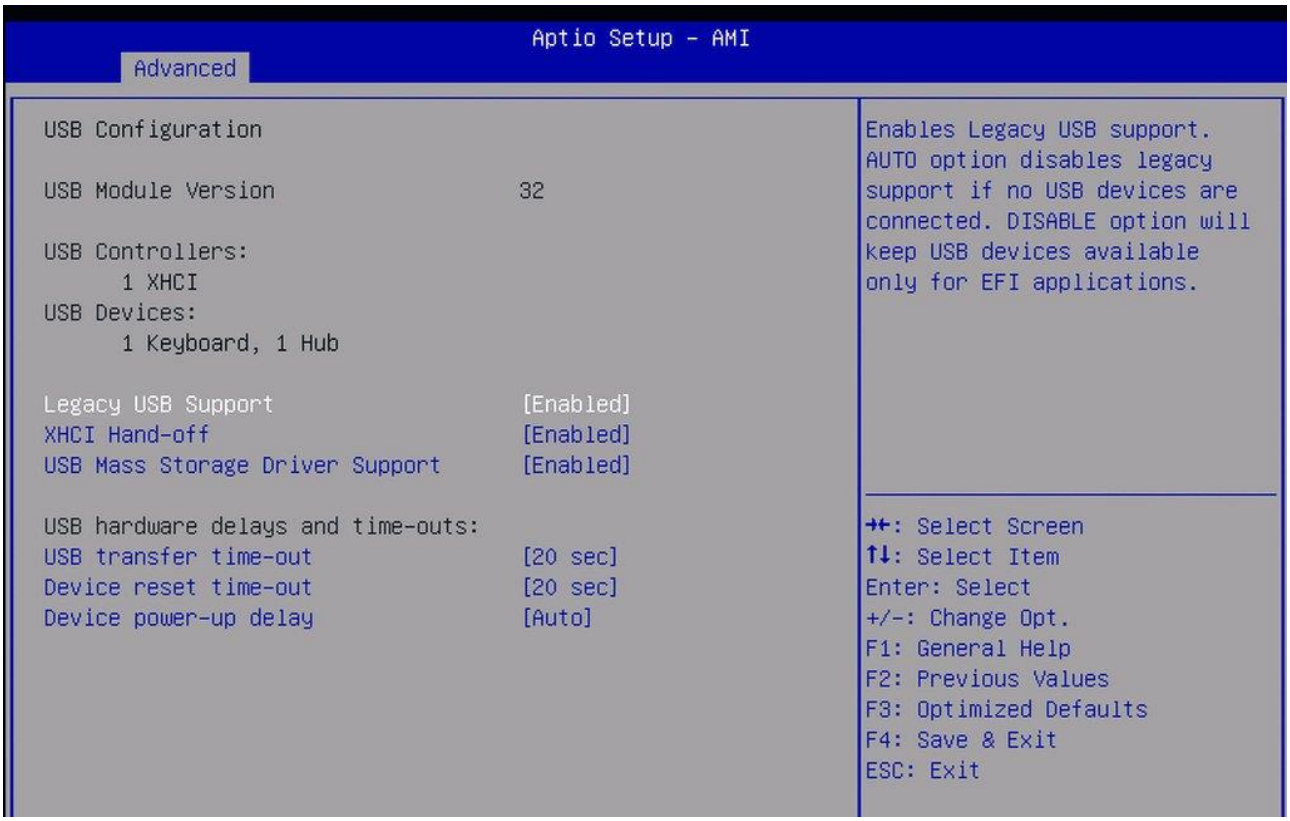
select 0-59 for Minute



select 0-59 for Second



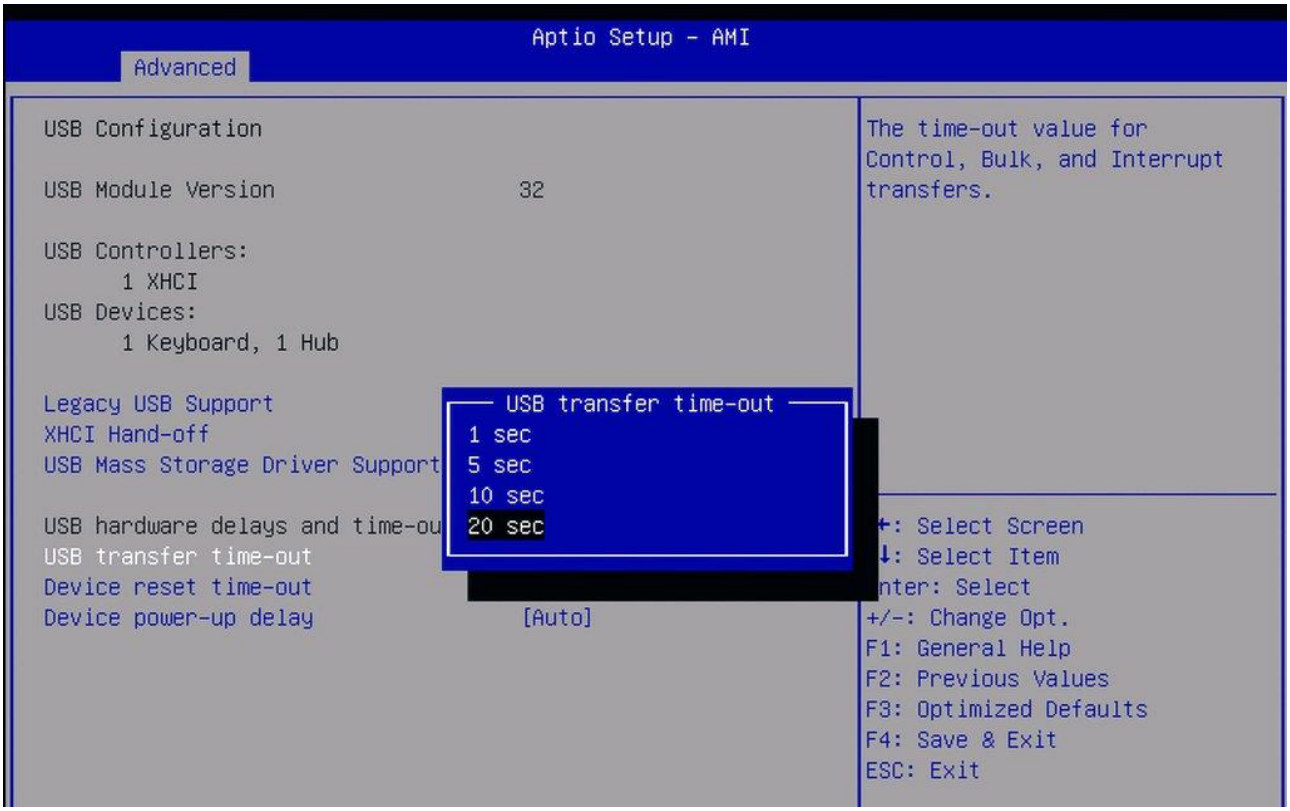
3.4.7 USB Confiruration



Legacy USB Support:

Enables Legacy USB support. AUTO option disables legacy support if no USB devices are connected.DISABLE option will keep USB devicesavailable only for EFI applications.

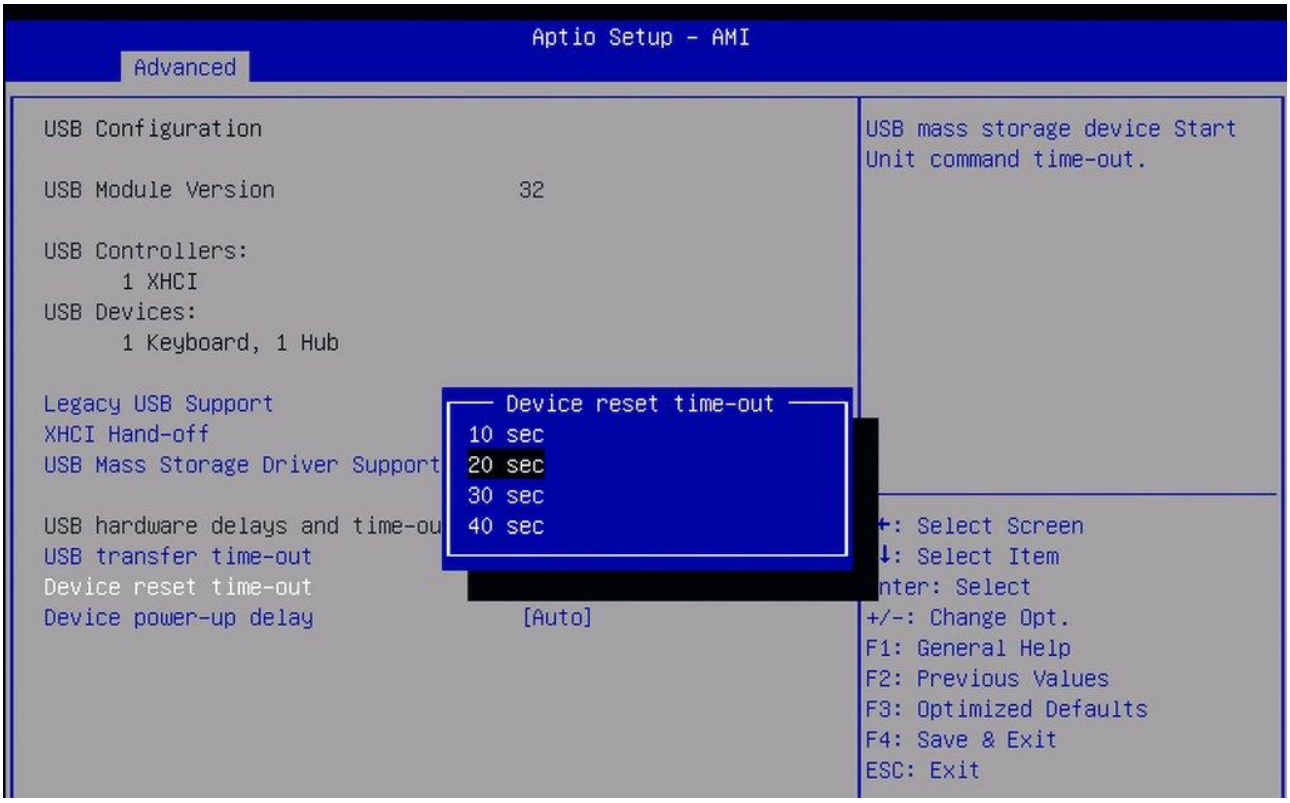
3.4.7.1 USB transfer time-out



USB transfer time-out:

The time-out value for Control,Bulk, and Interrupt transfers.

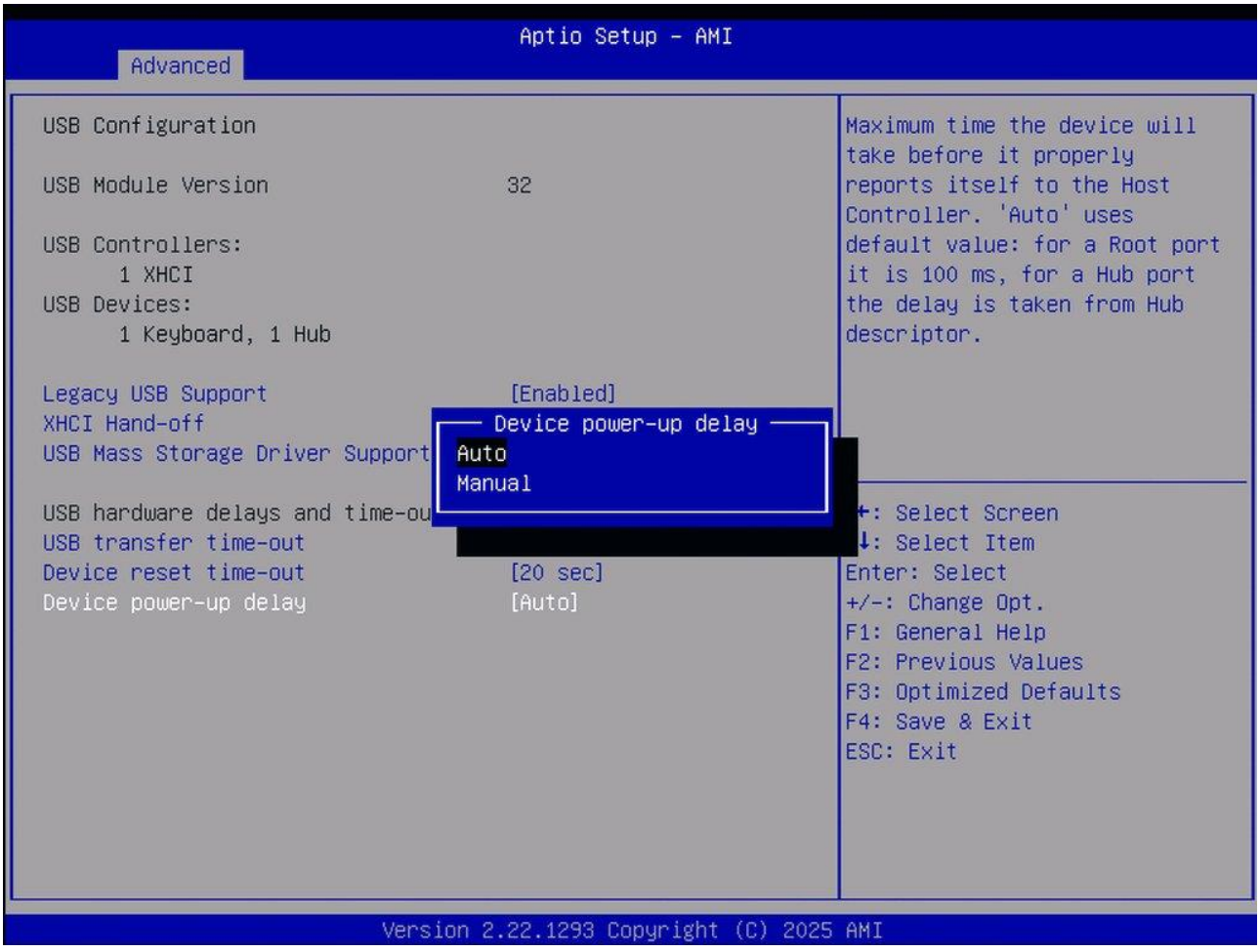
3.4.7.2 Device reset time-out



Device reset time-out:

USB mass storage device Start Unit command time-out.

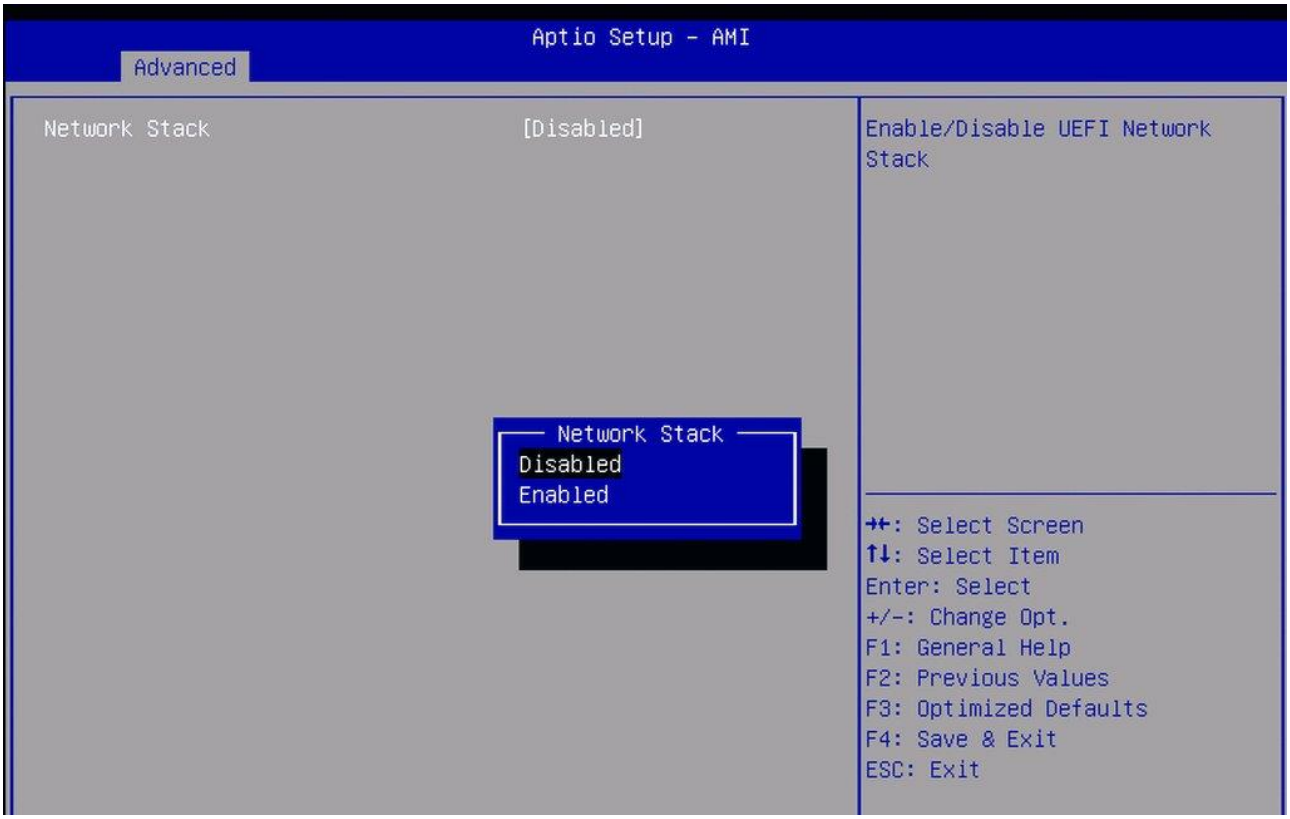
3.4.7.3 Device power-up delay



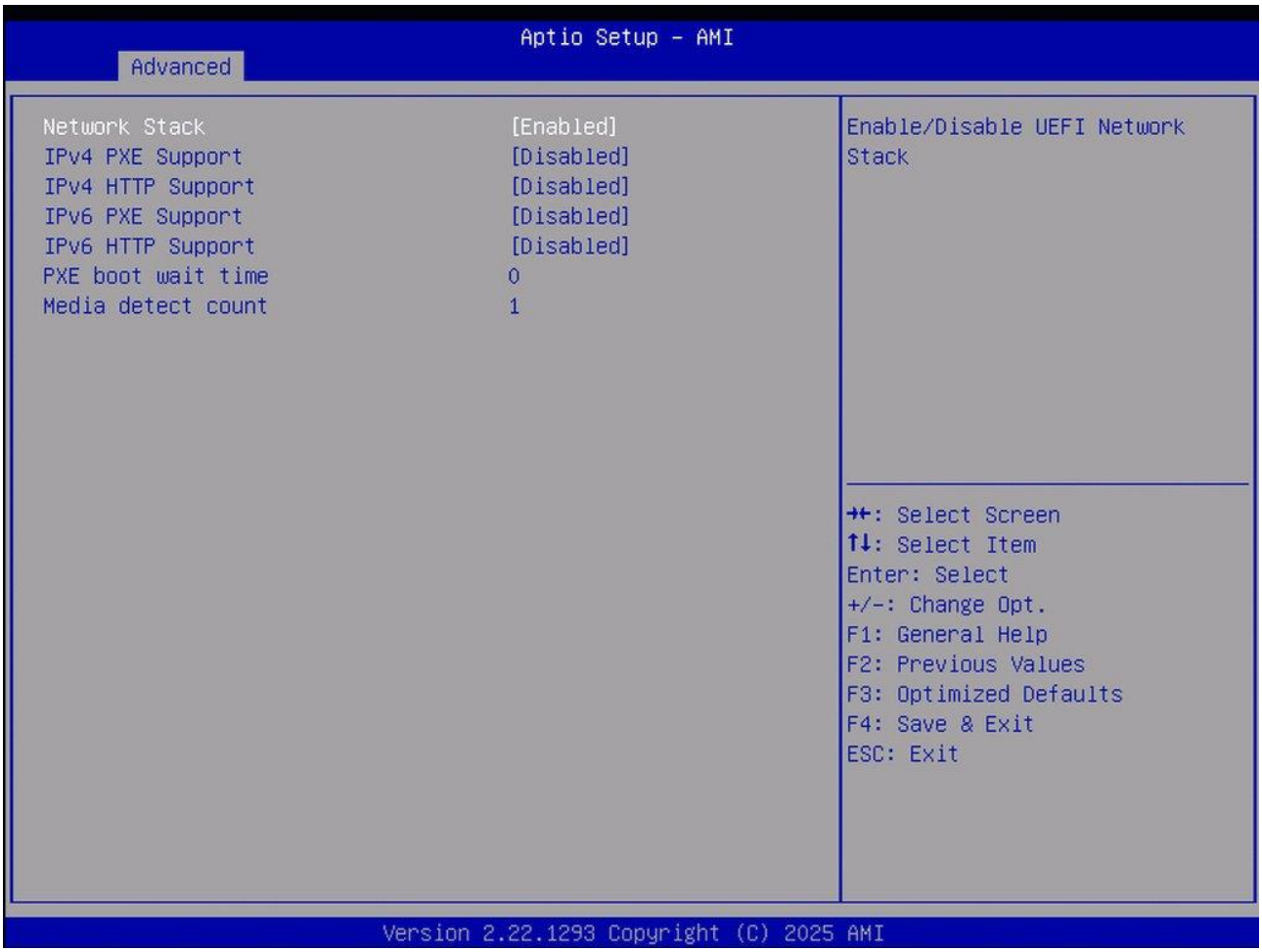
Device power-up delay:

Maximum time the device will take before it properly reports itself to the Host Controller. ‘Auto' uses default value: for a Root port it is 100ms, for a Hub port the delay is taken from Hub descriptor.

3.4.8 Network Stack Configuration



3.4.8.1 PXE boot wait time



IPV4 PXE Support:

Enable/Disable IPv4 PXE boot support. If disabled, IPv4 PXE boot support will not be available.

IPV4 HTTP Support:

Enable/Disable IPv4 HTTP boot support. If disabled, IPv4 HTTP boot support will not be available.

IPV6 PXE Support:

Enable/Disable IPv6 PXE boot support. If disabled, IPv6 PXE boot support will not be available.

IPV6 HTTP Support:

Enable/Disable IPv6 HTTP boot support. If disabled,IPv6 HTTP boot support will not be available.

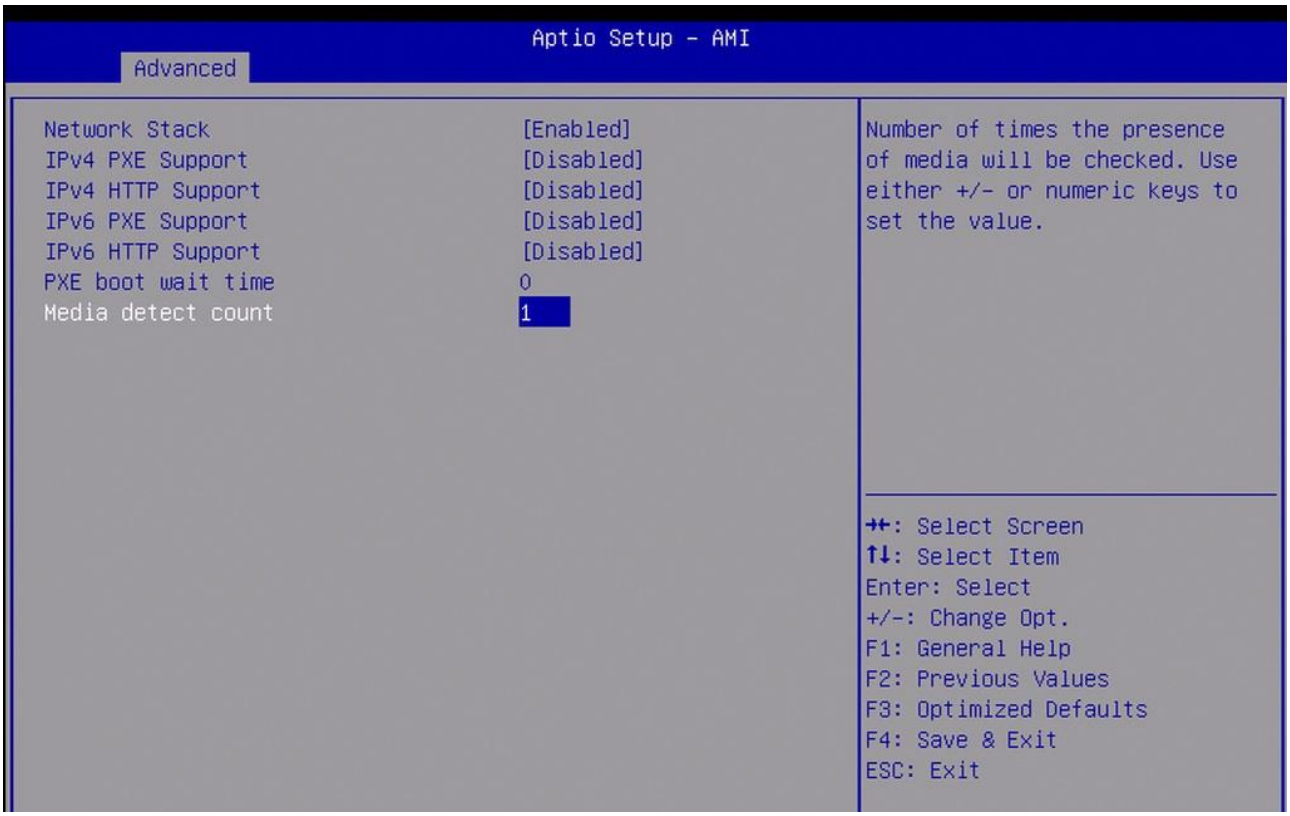
PXE Boot Wait Time:

Wait time in seconds to press ESC key to abort the PXE boot. Use either +/- or numeric keys to set the value,

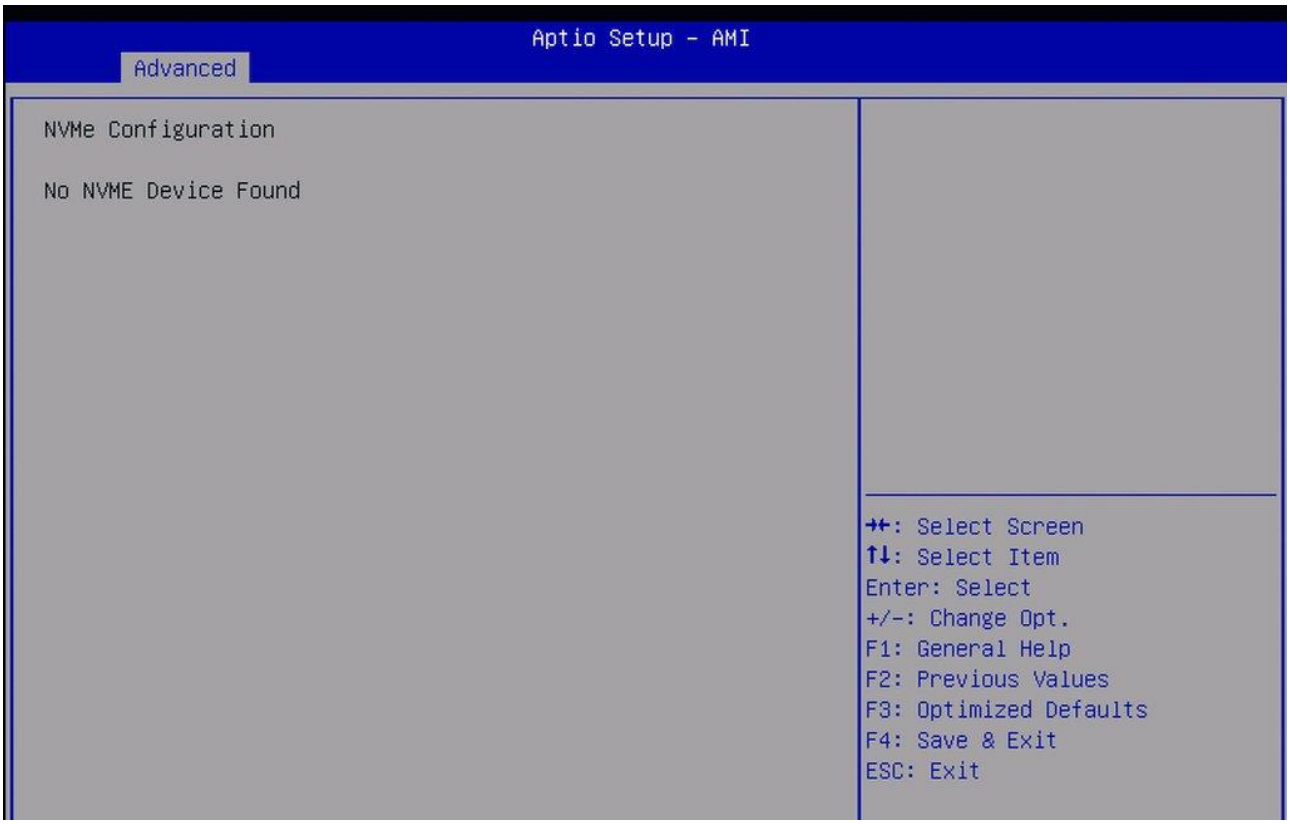
Media detect count:

Number of times the presence of media will be checked.Use either +/- or numeric keys to set the value.

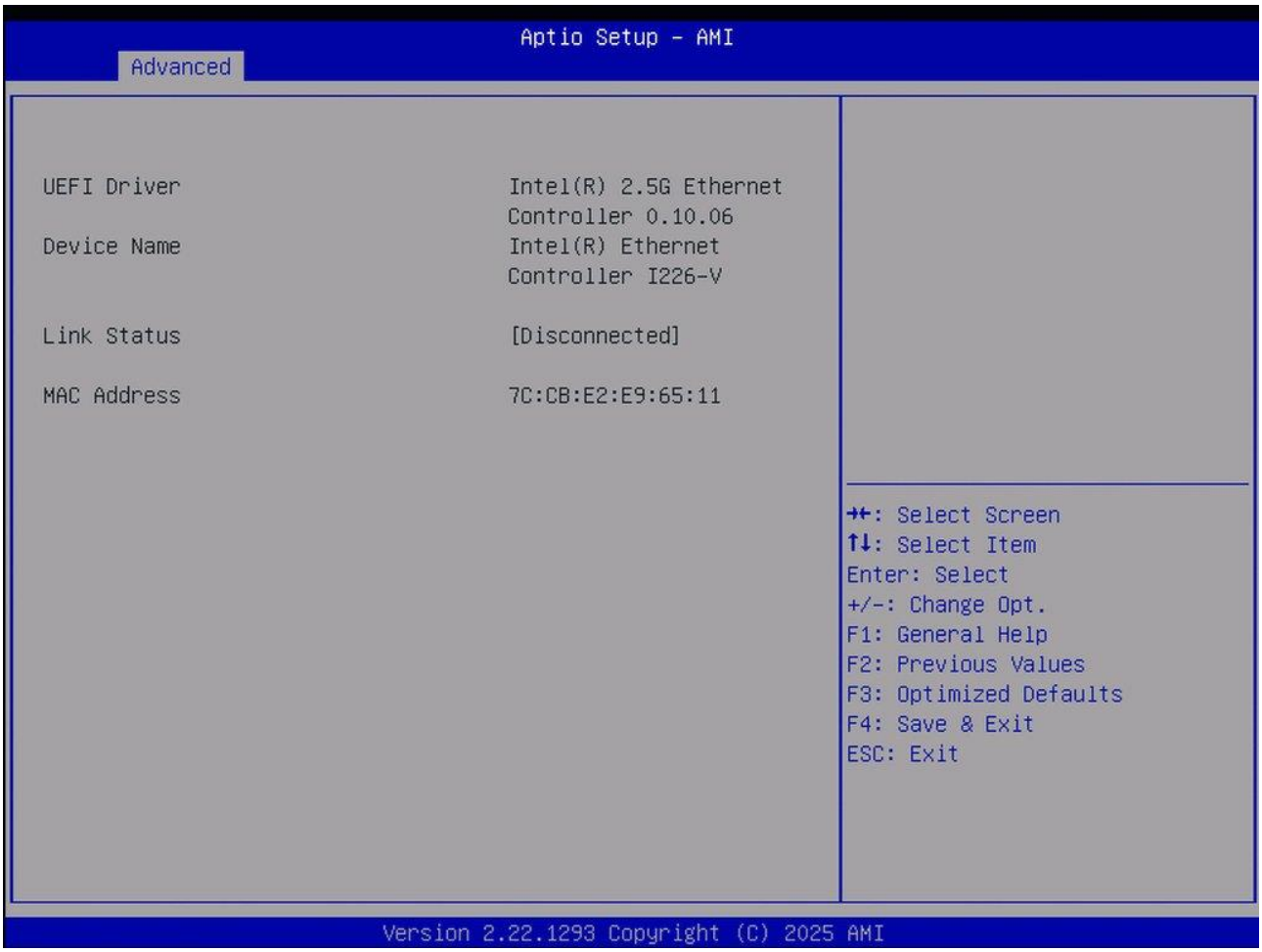
3.4.8.2 Media detect count



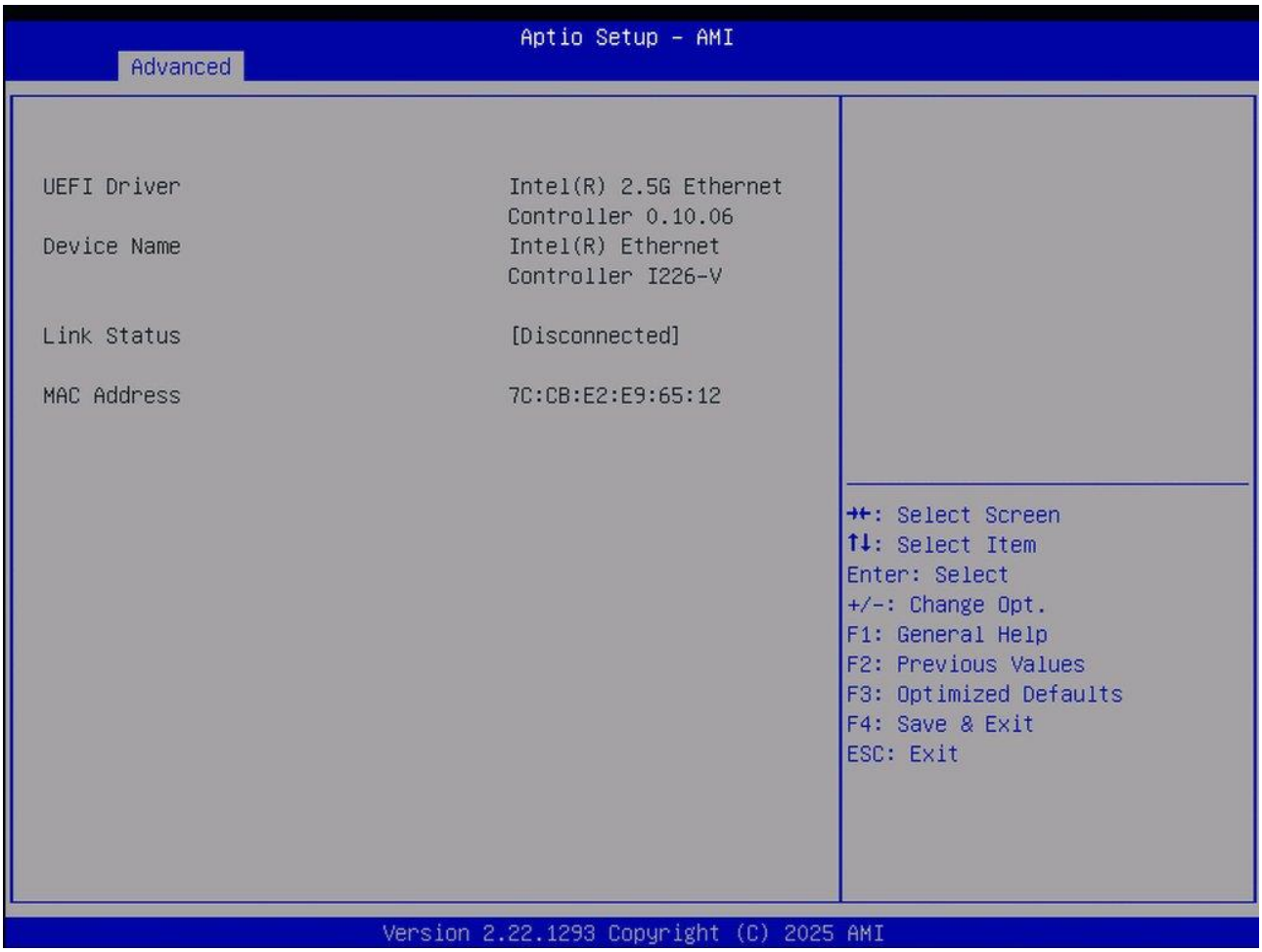
3.4.9 NVMe Configuration



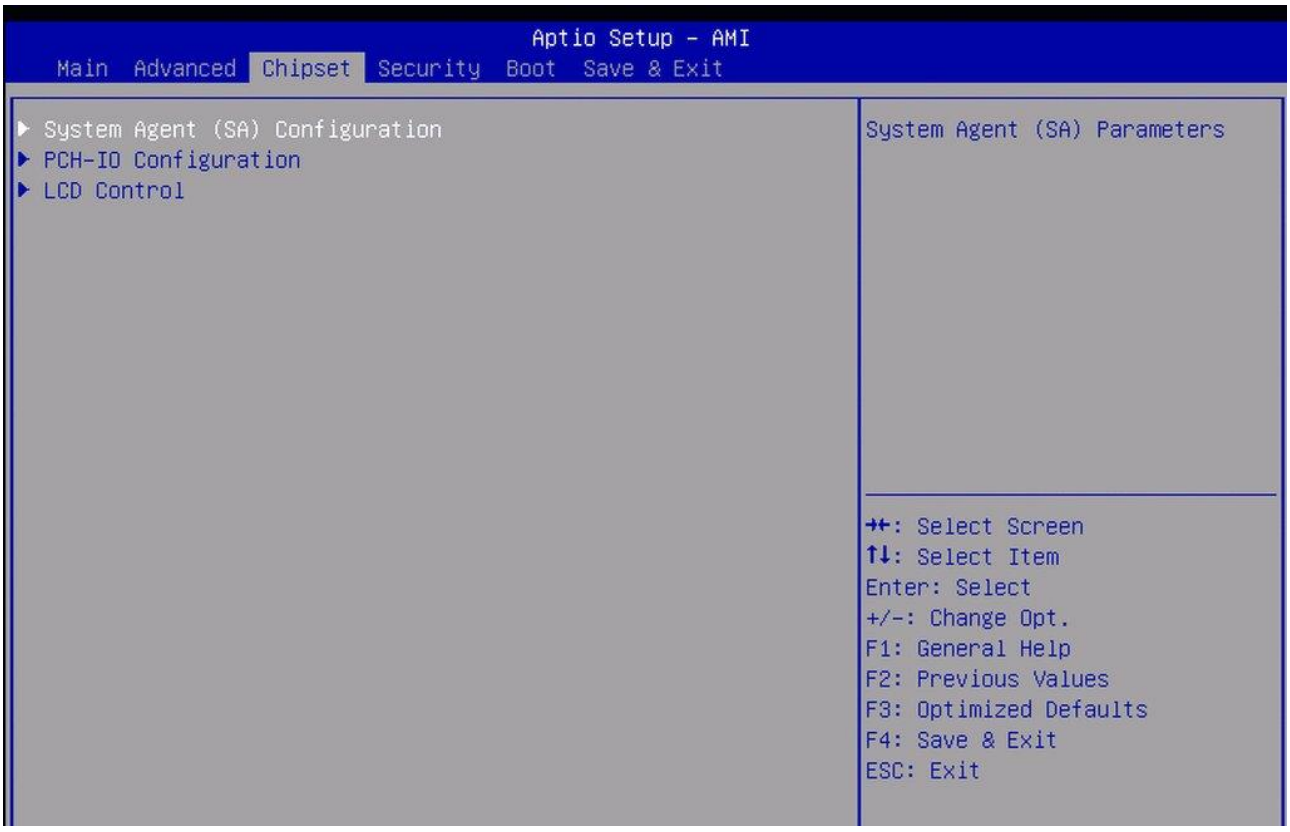
3.4.10 Intel(R) Ethernet Controller I226-V



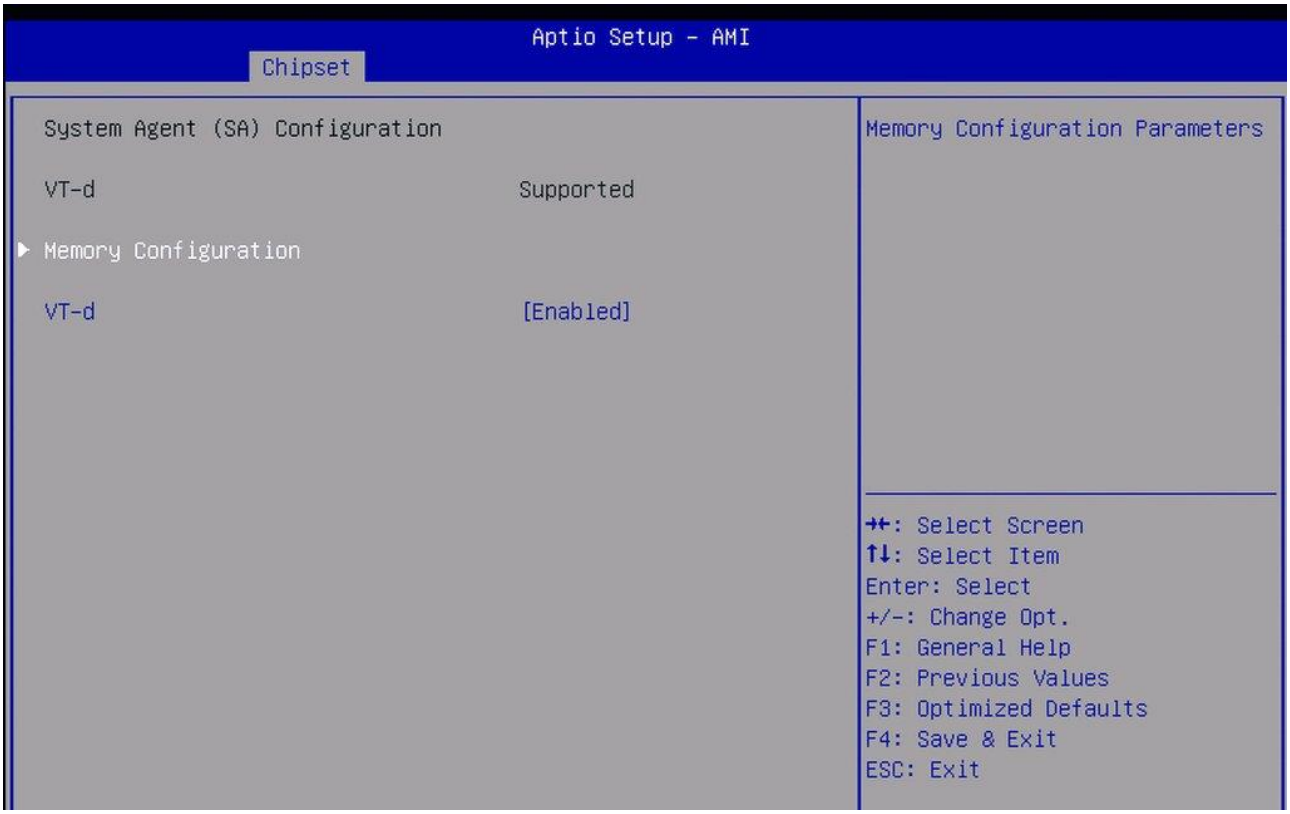
3.4.11 Intel(R) Ethernet Controller I226-V



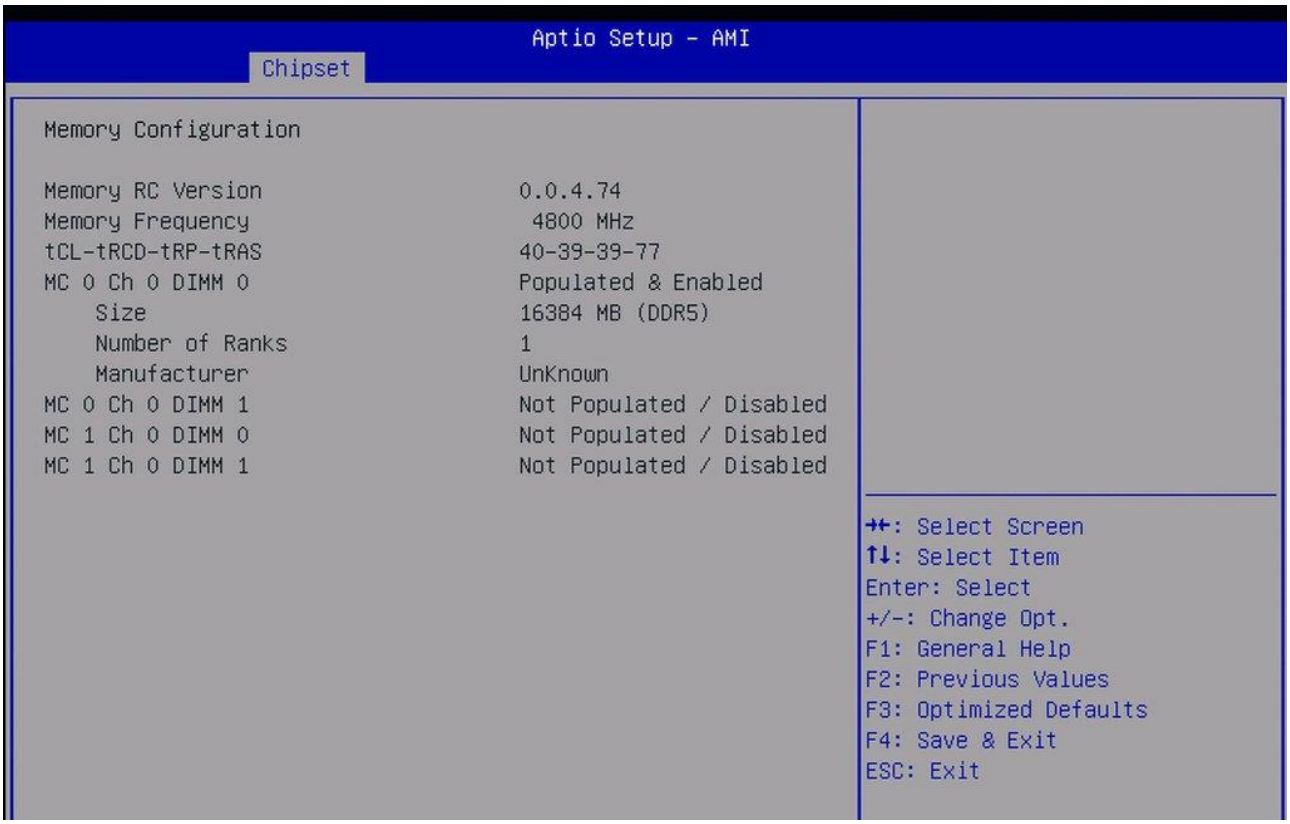
3.5 Chipset Settings



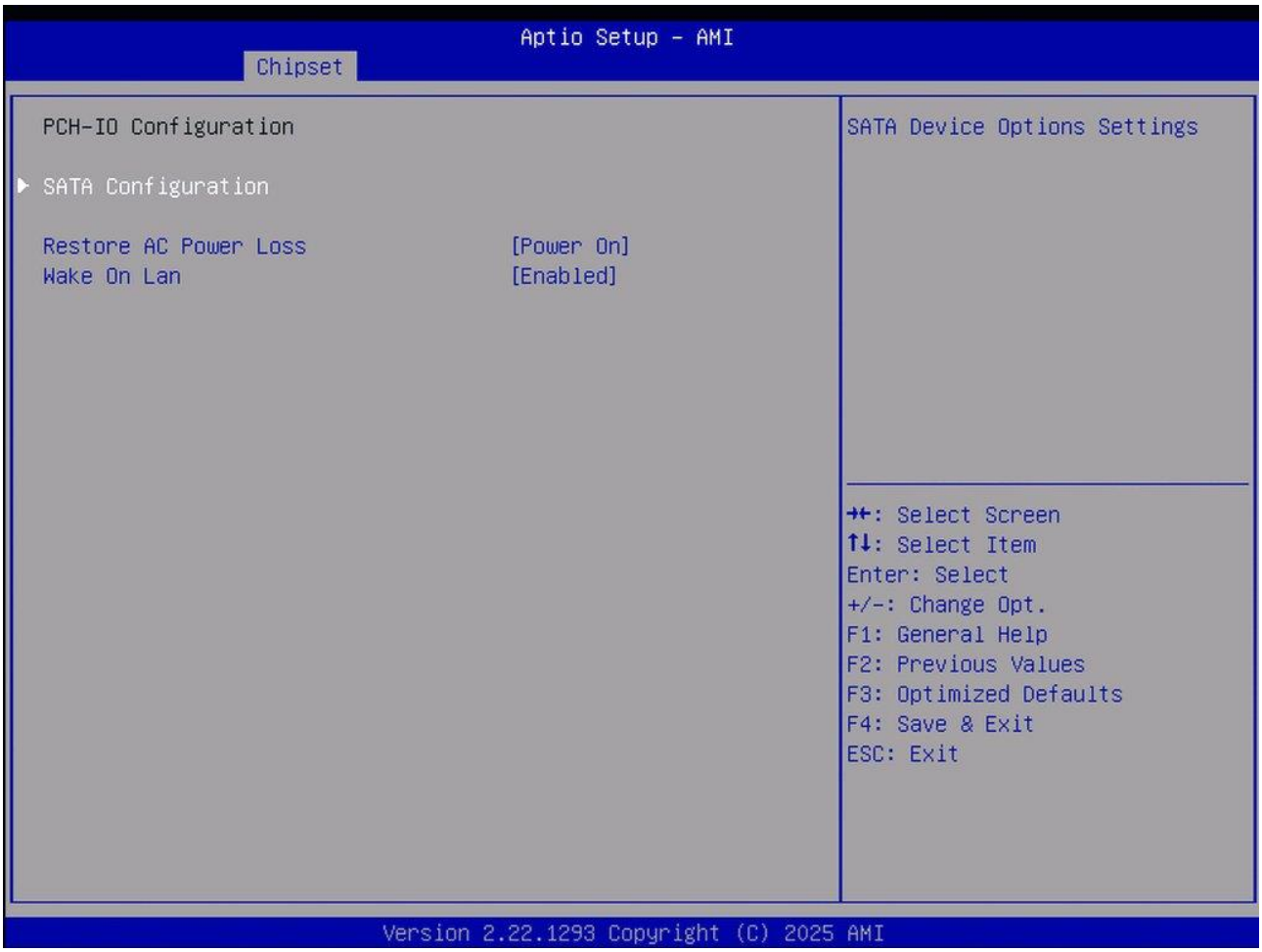
3.5.1 System Agent (SA) Configuration



3.5.1.1 Memory Configuration



3.5.2 PCH-IO Configuration



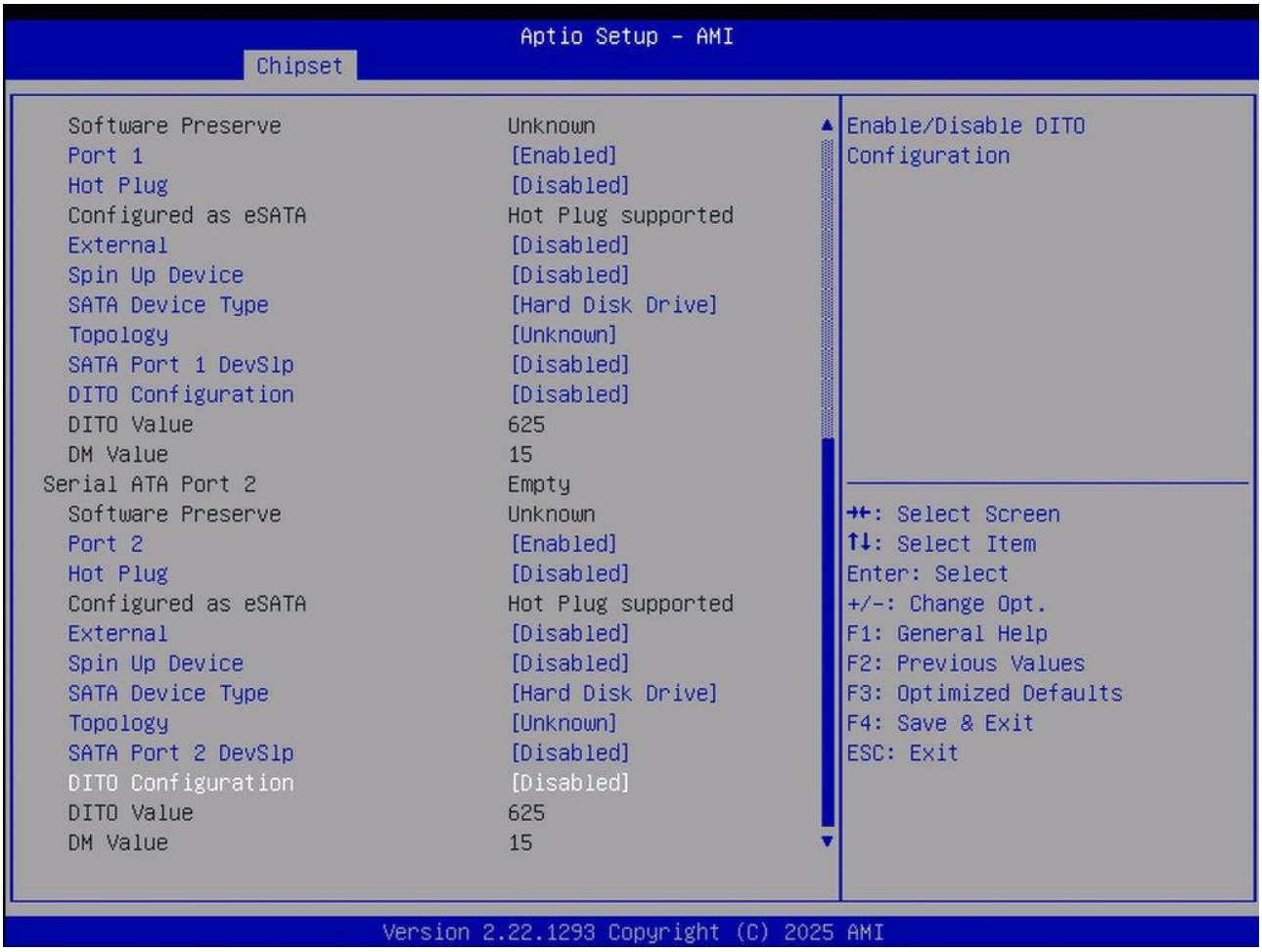
Note:

Restore AC Power Loss: Power ON(Default)

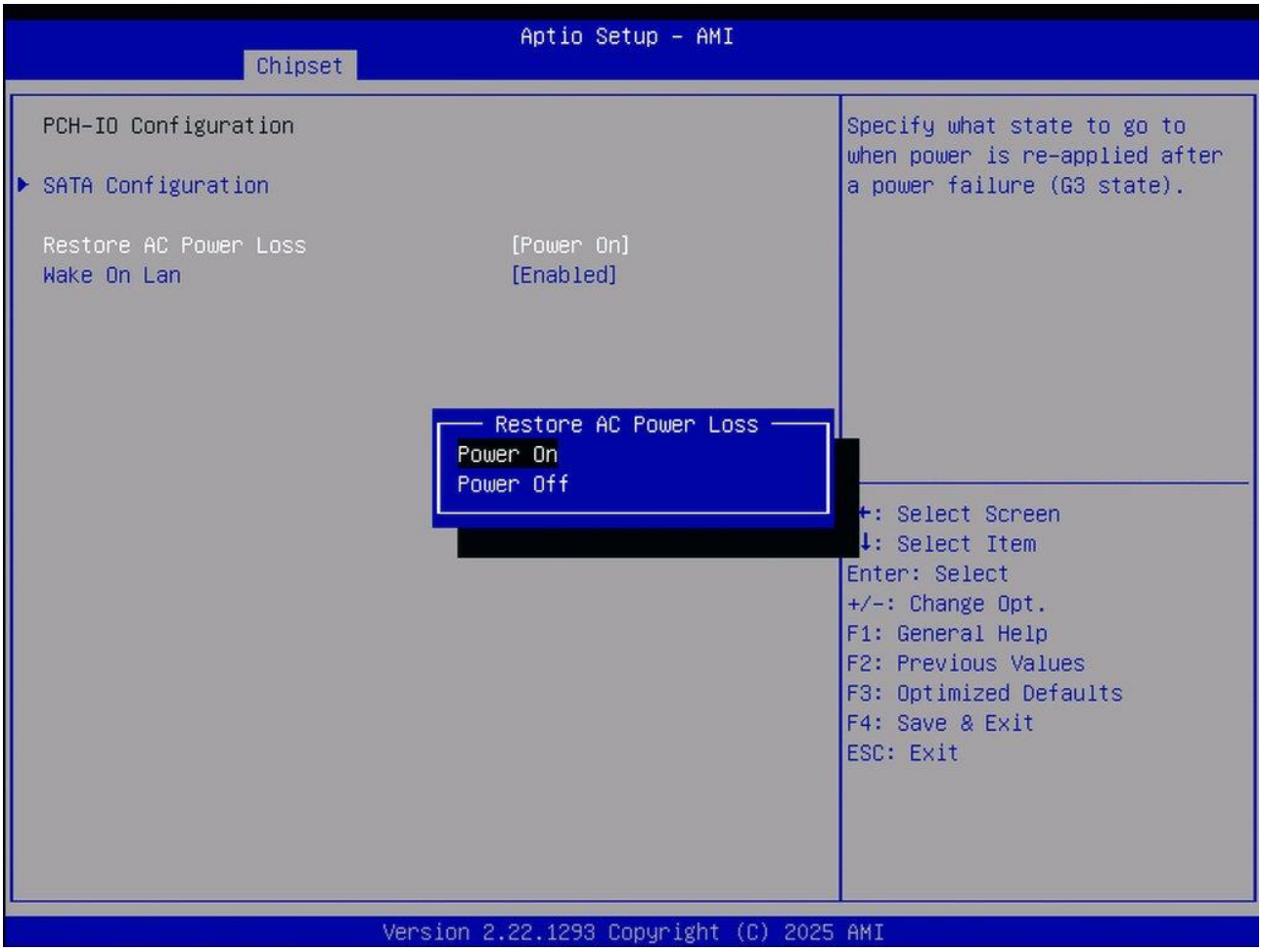
3.5.2.1 SATA Configuration

SATA Device Type:

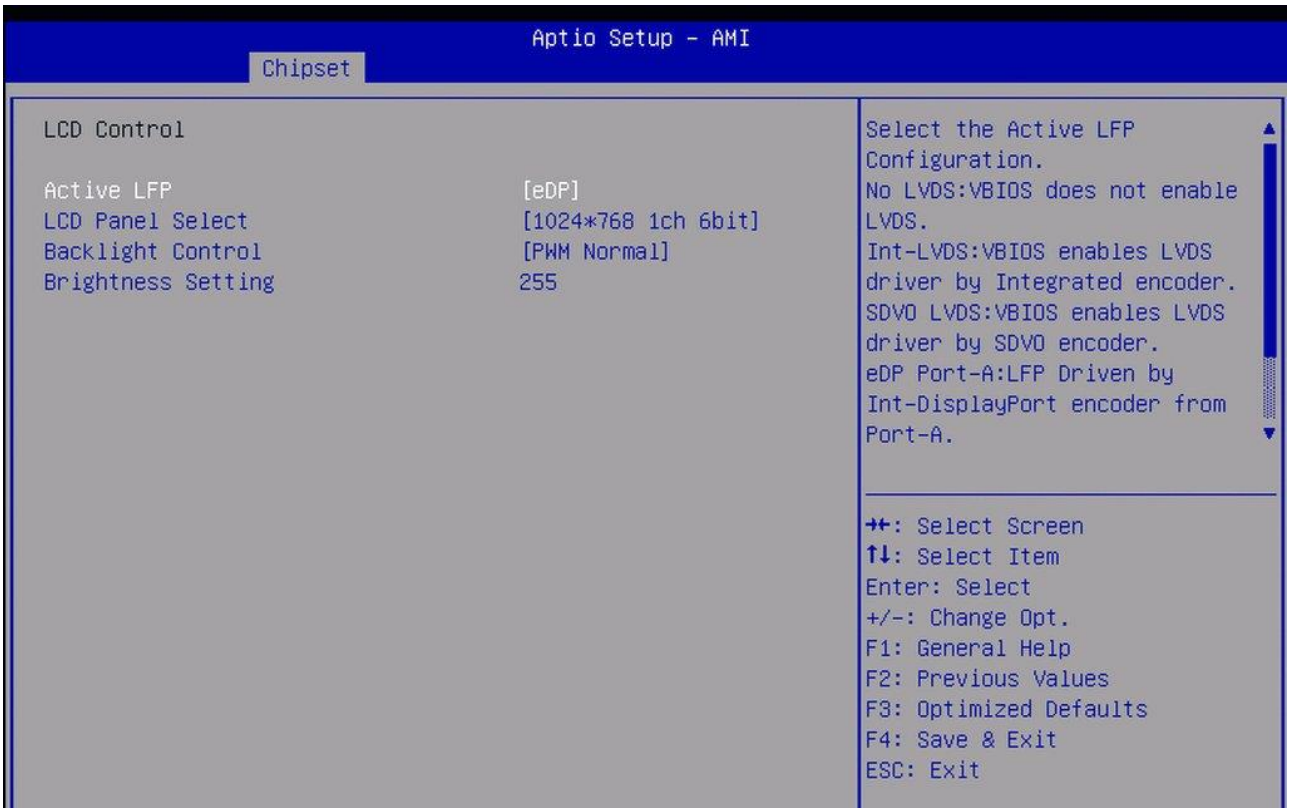
Identify the SATA port is connected to Solid State Drive or Hard Disk Drive



3.5.2.2 Restore AC Power Loss



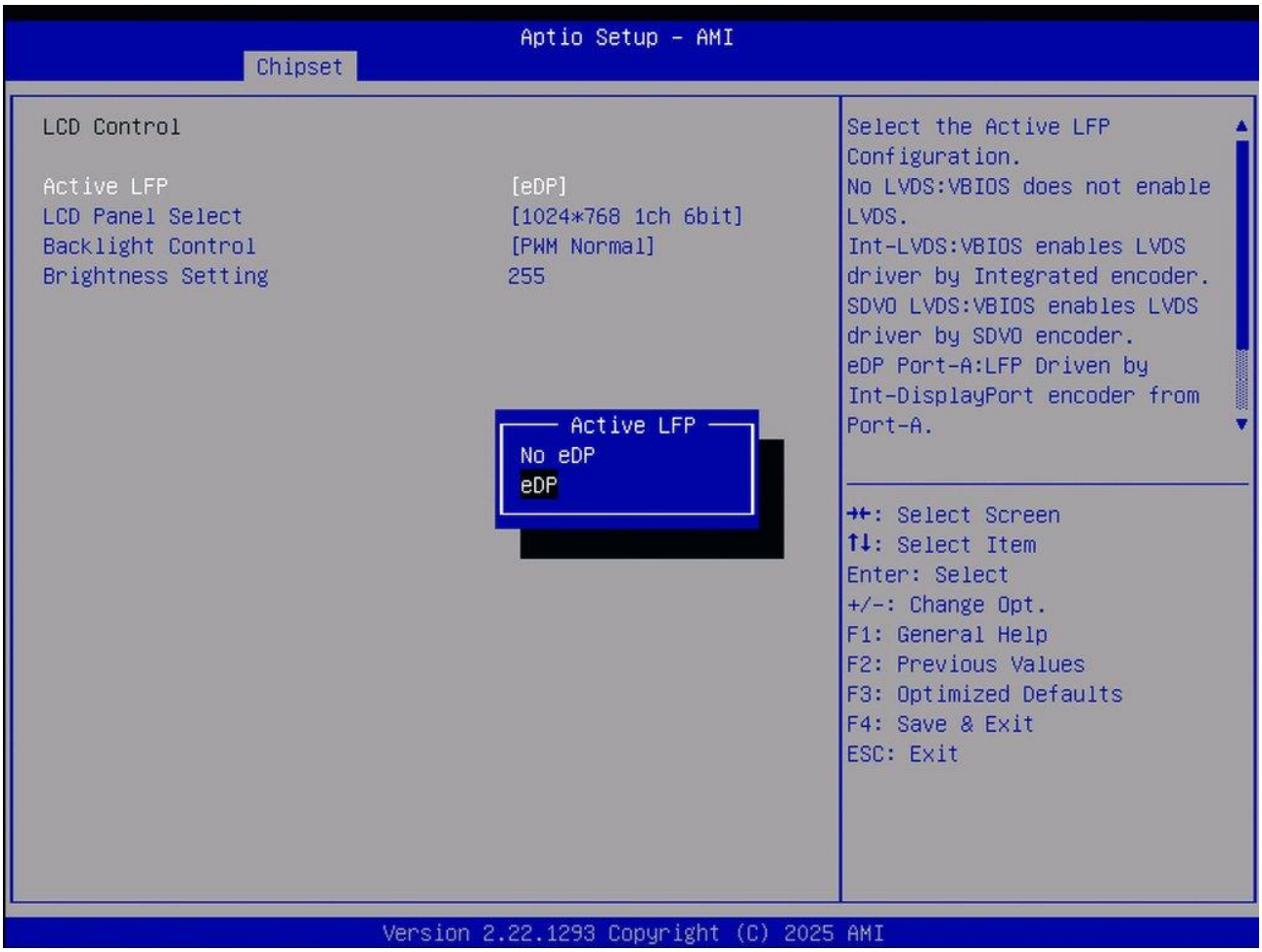
3.5.3 LCD Control



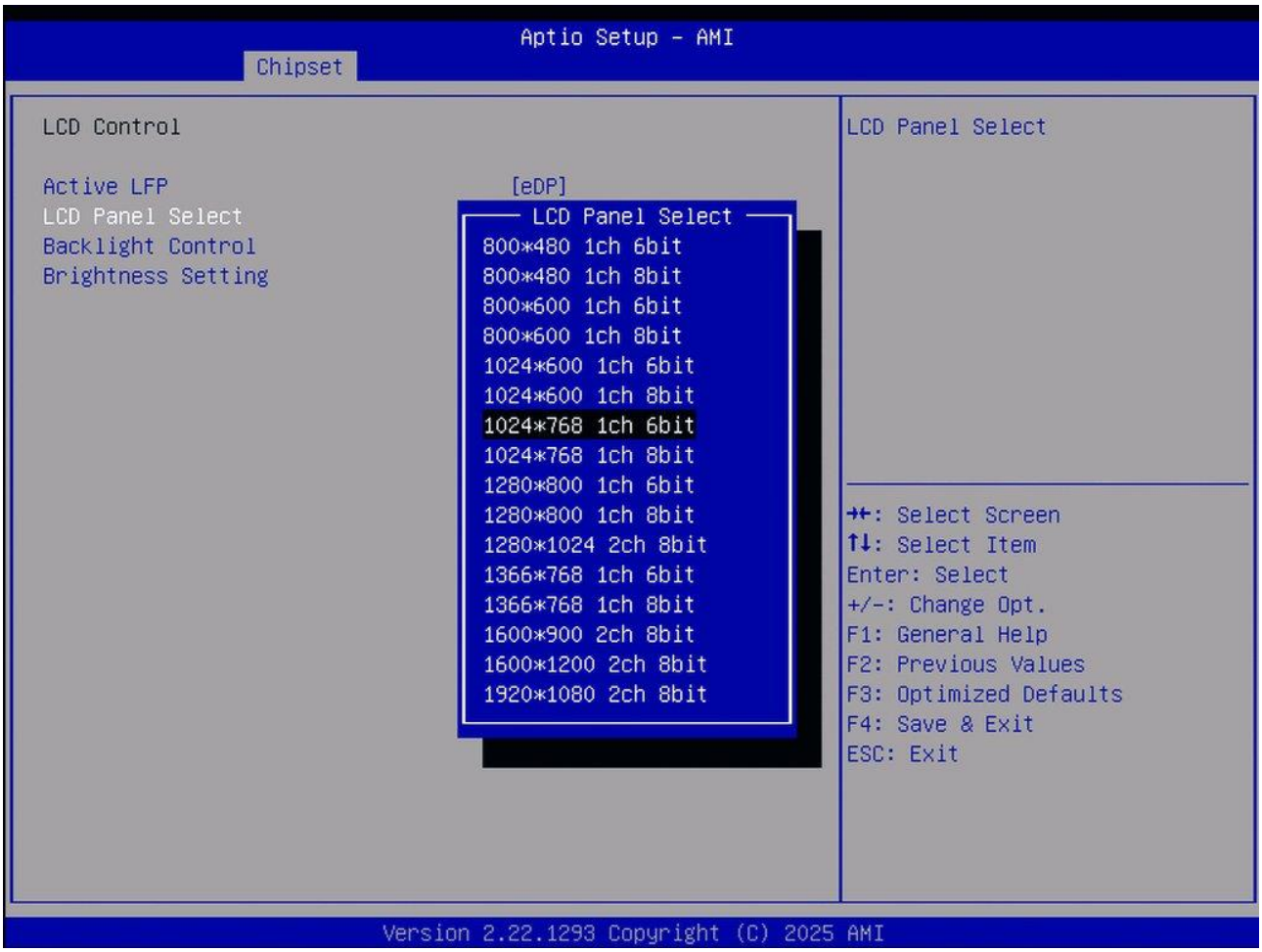
Active LFP:

Select the Active LFP Configuration. No edp: vBIos does not enable LVDS. edp: VBIOS enables LVDS driver by integrated encoder. .

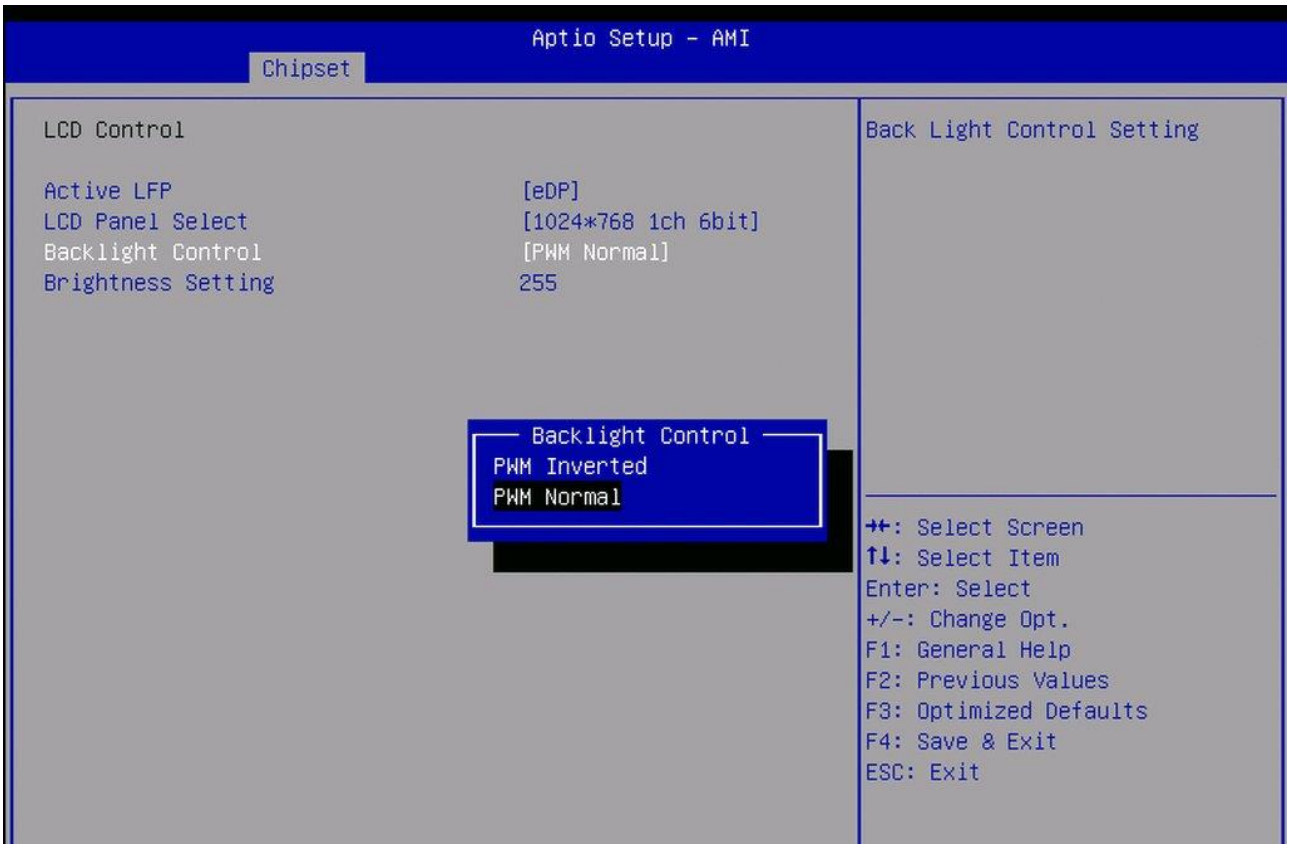
3.5.3.1 Active LFP



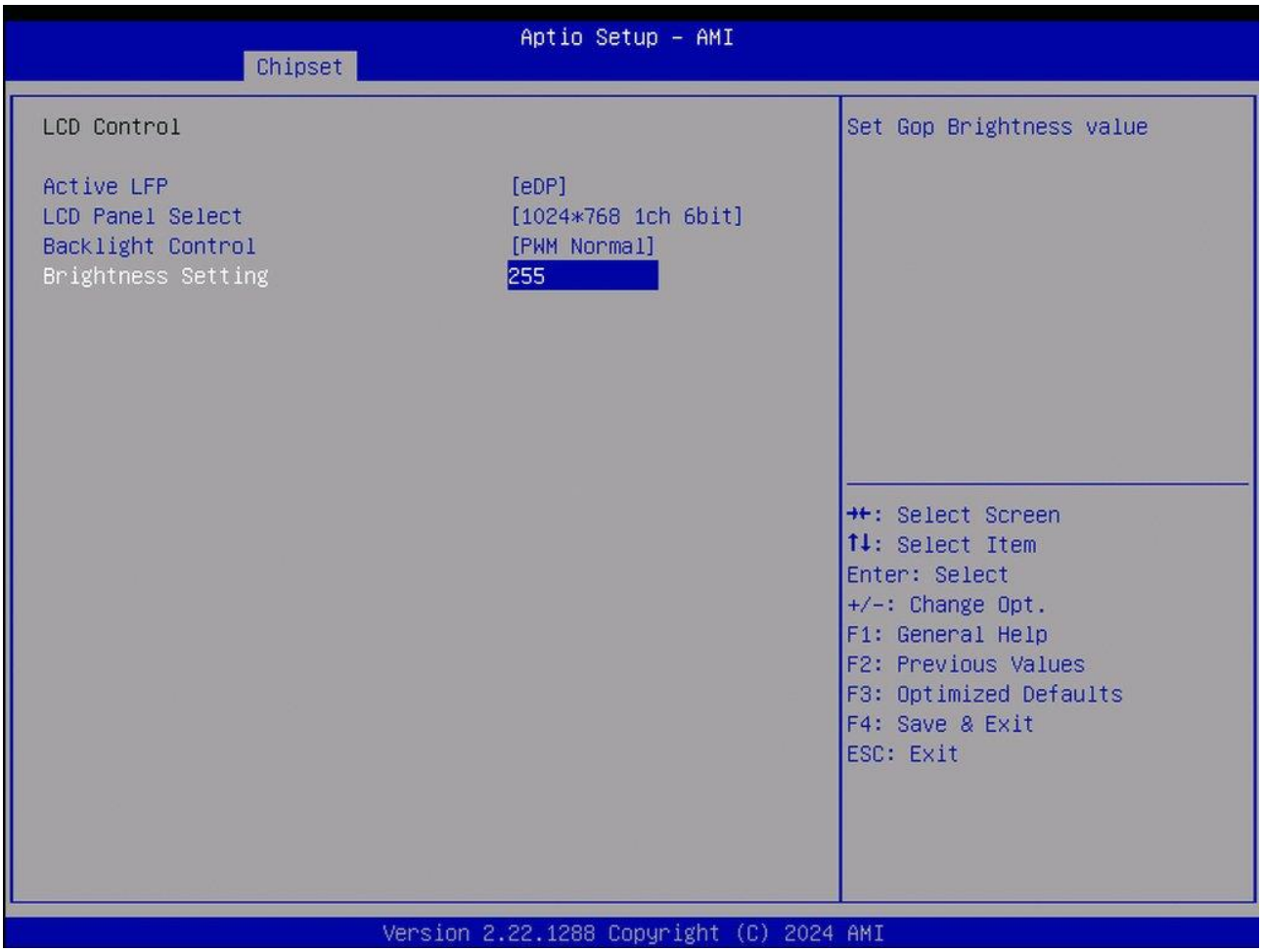
3.5.3.2 LCD Panel Select



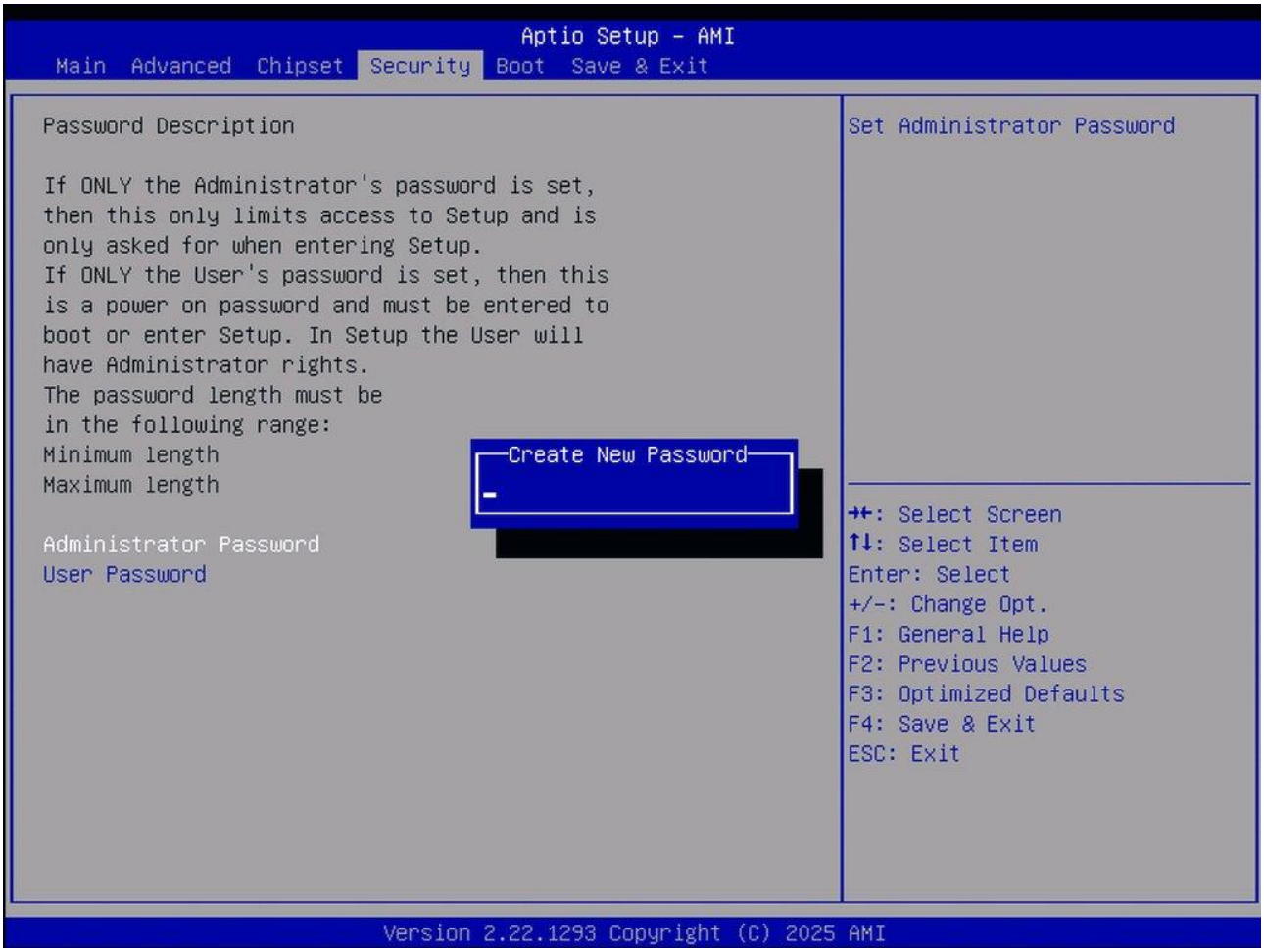
3.5.3.3 Backlight Control



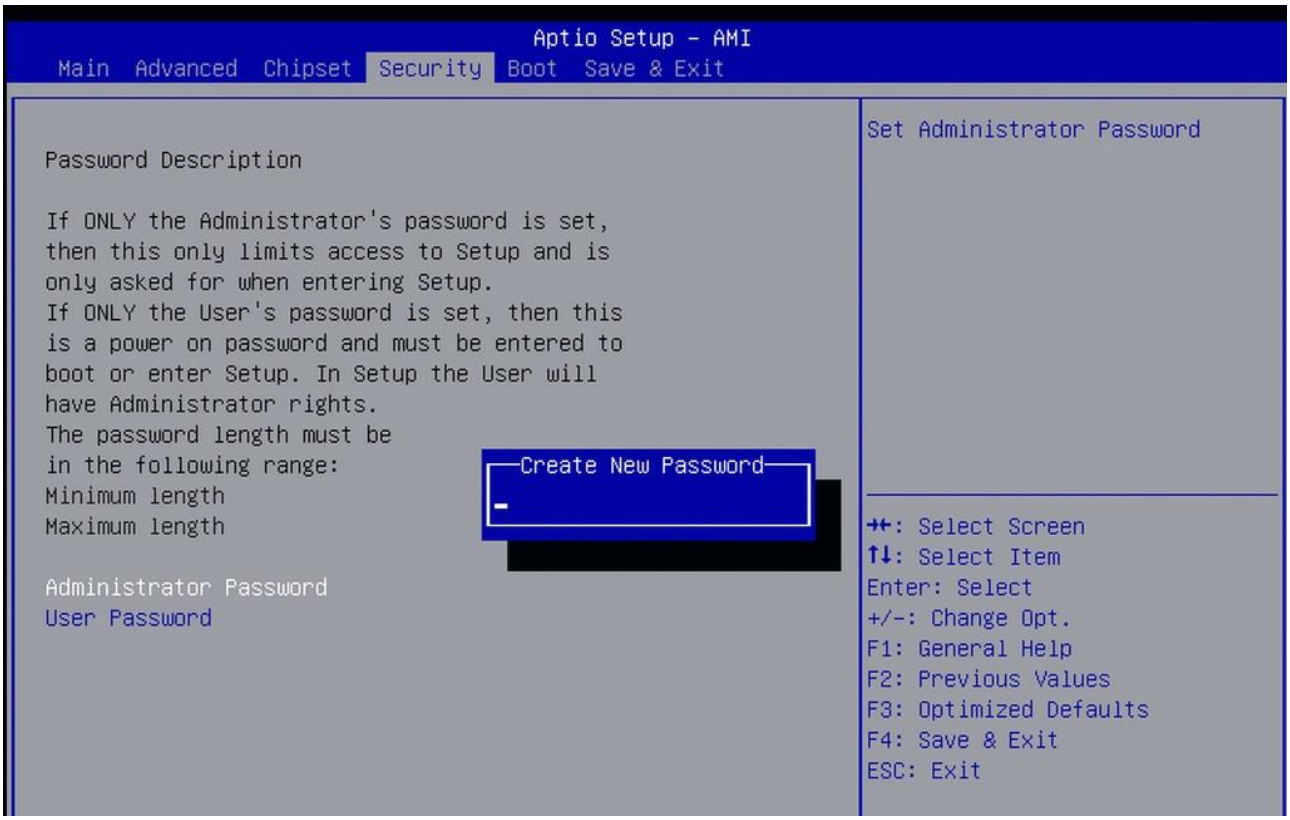
3.5.3.4 Brightness Setting



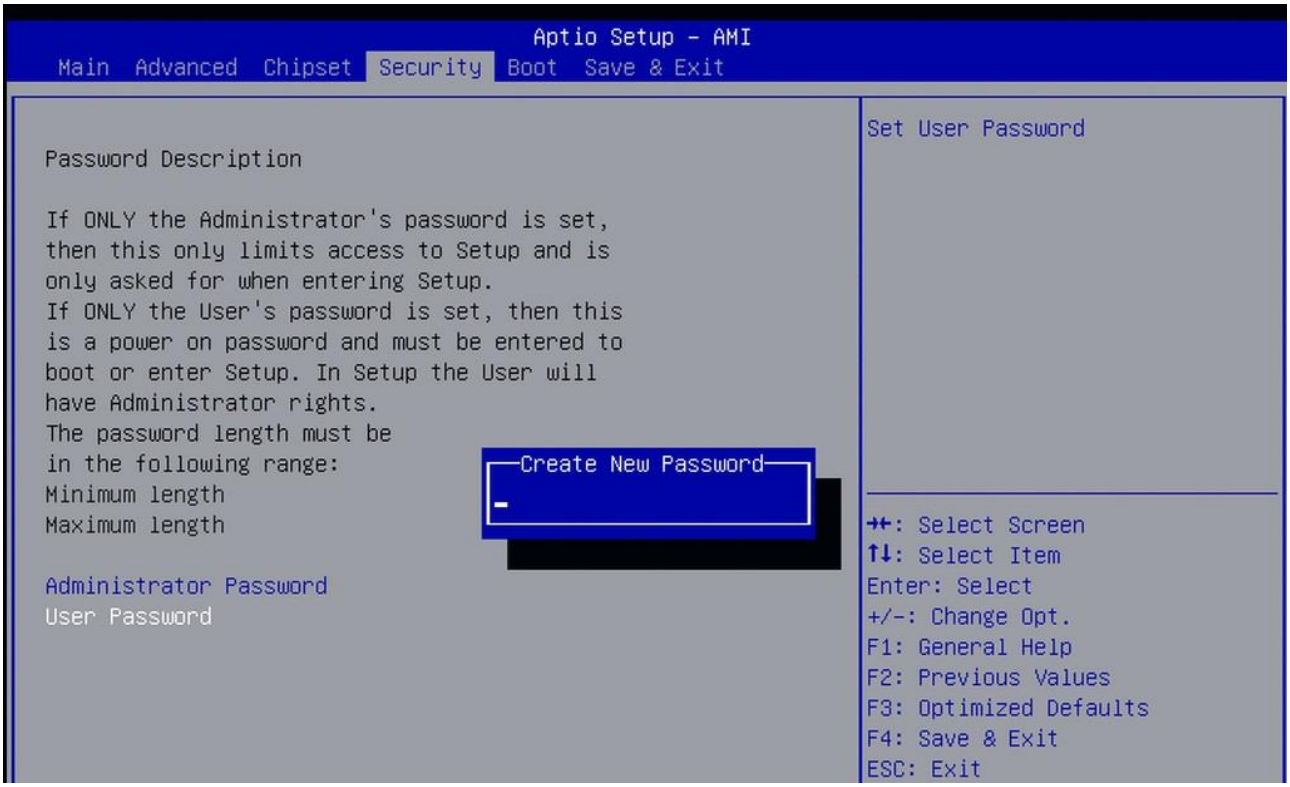
3.6 Security Settings



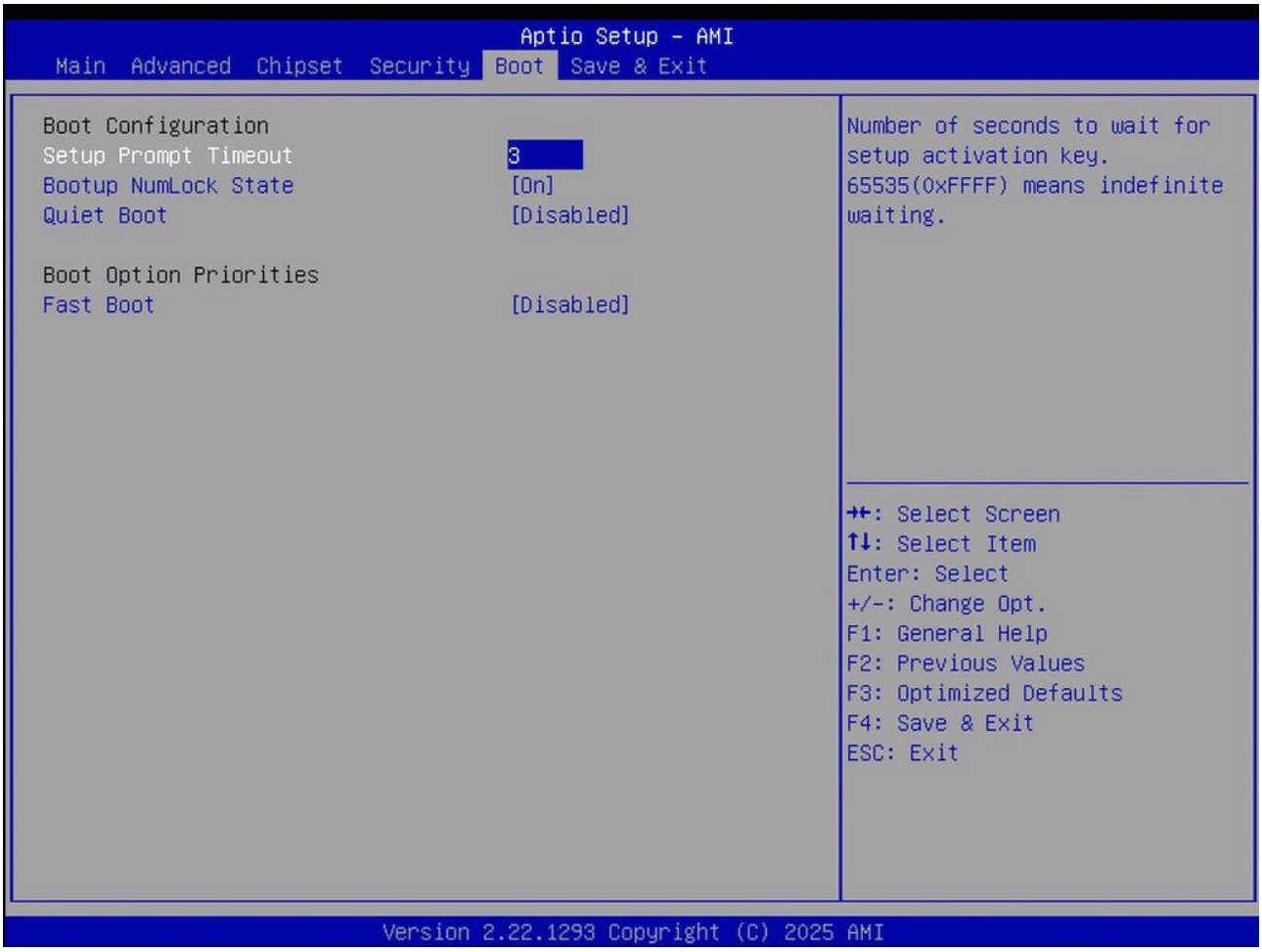
3.6.1 Administrator Password



3.6.2 User Password



3.7 Boot Settings



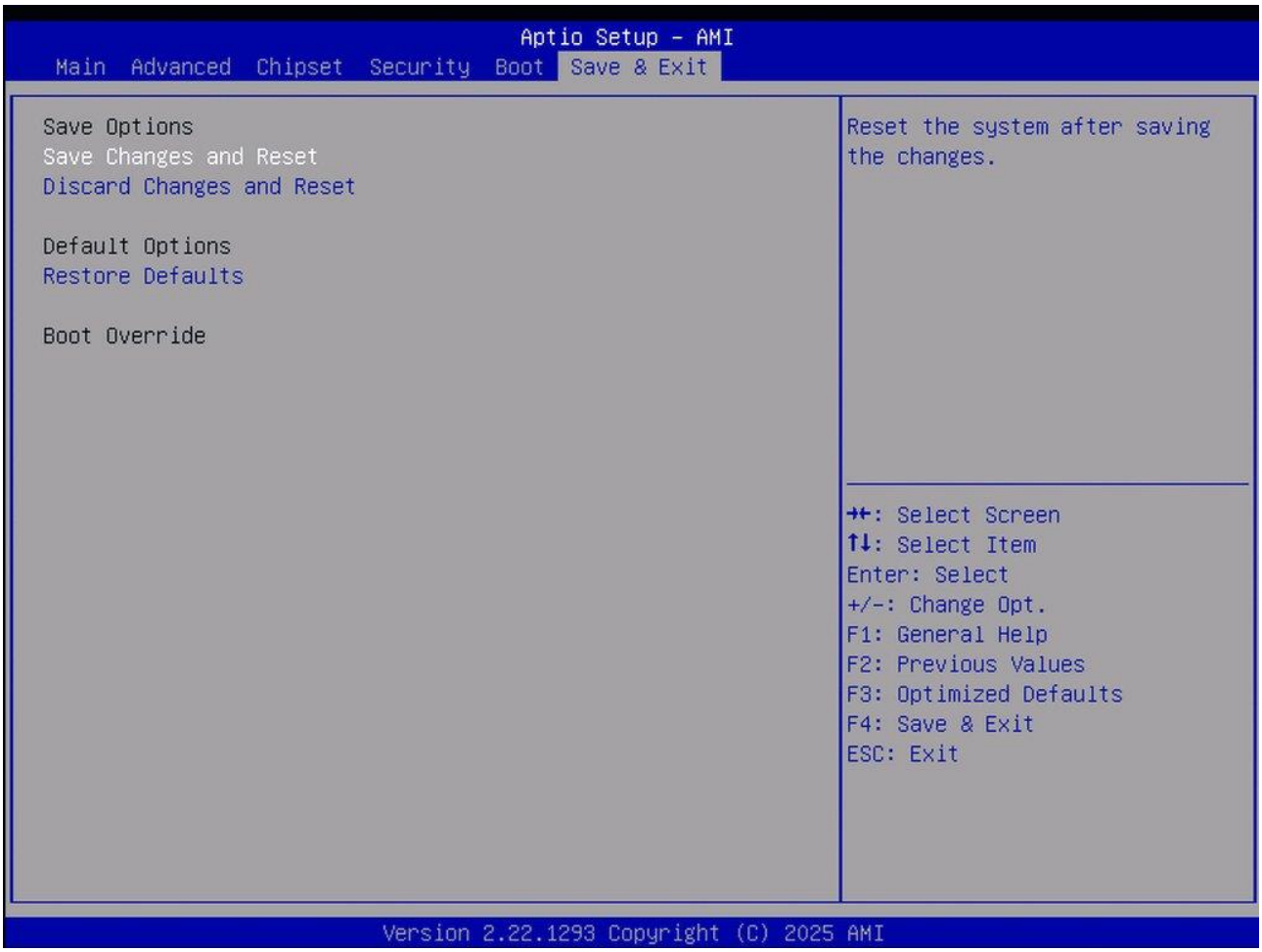
Setup Prompt Timeout:

Number of seconds to wait for setup activation key.65535(OxFFFF) means indefinite waiting.

Fast Boot:

Enables or disables boot with initiaization of a minimal set of devices required to launch active boot option.Has no effect for BBS boot options.

3.8 Save & Exit Settings



Restore Defaults:

Restore/Load Default values for all the setup options.

Chapter 4 Installation of Drivers

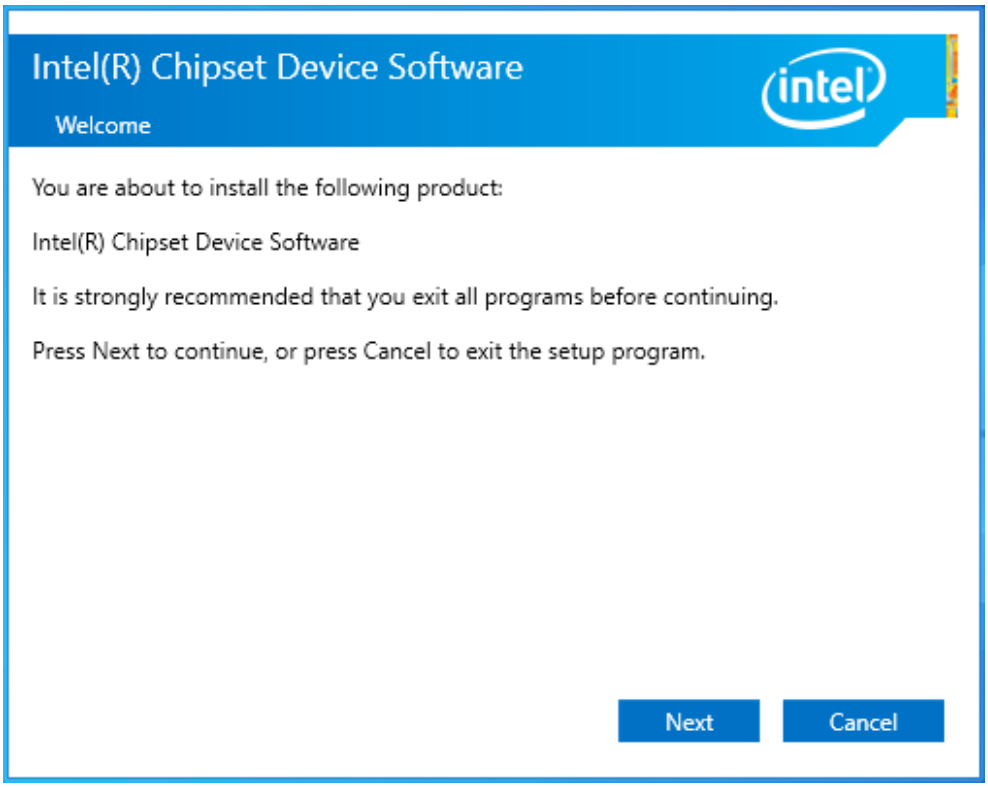
This chapter describes the installation procedures for software and drivers under the windows 10. The software and drivers are included with the motherboard. The contents include Intel Chipset, Graphics chipset driver, Audio driver, LAN driver and Intel® management engine interface. The instructions are as below.

Important Note:
After installing your Windows operating system, you must install first the Intel Chipset Software Installation Utility before proceeding with the installation of drivers.

4.1 Intel Chipset

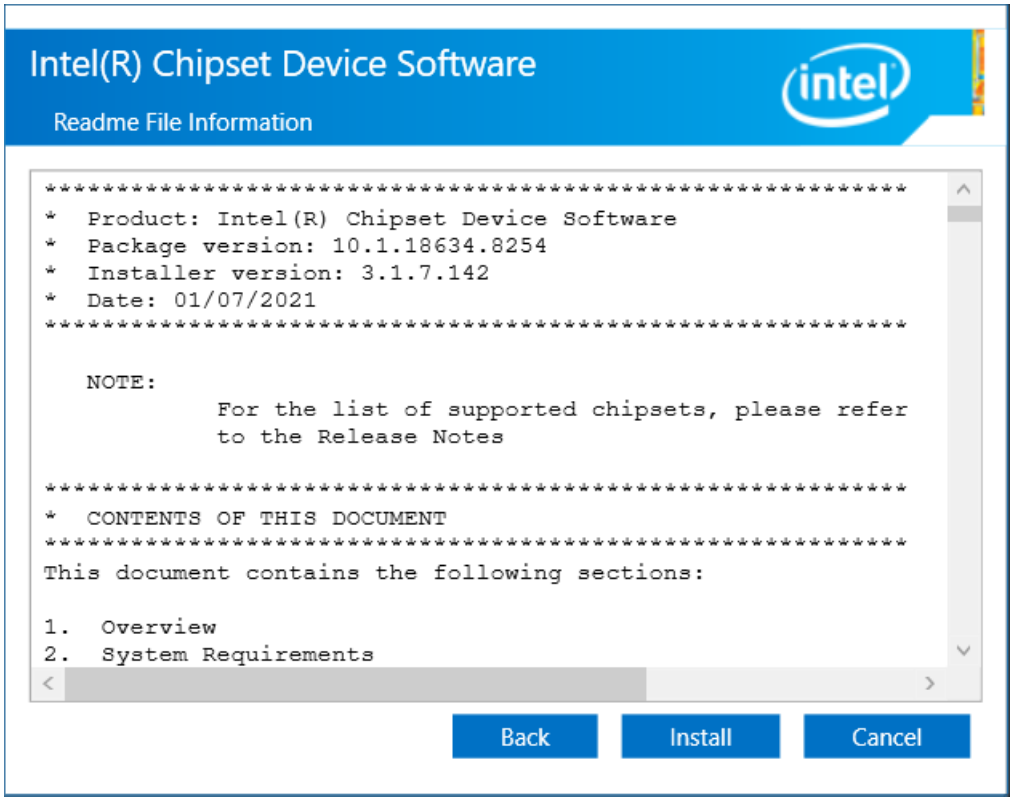
To install the Intel chipset driver, please follow the steps below.

Step 1. Here is welcome page. Please make sure you save and exit all programs before install. Click **Next**.



Step 2. Read the license agreement. Click **Accept** to accept all of the terms of the license agreement.

Step 3. Click **Install** to begin the installation.



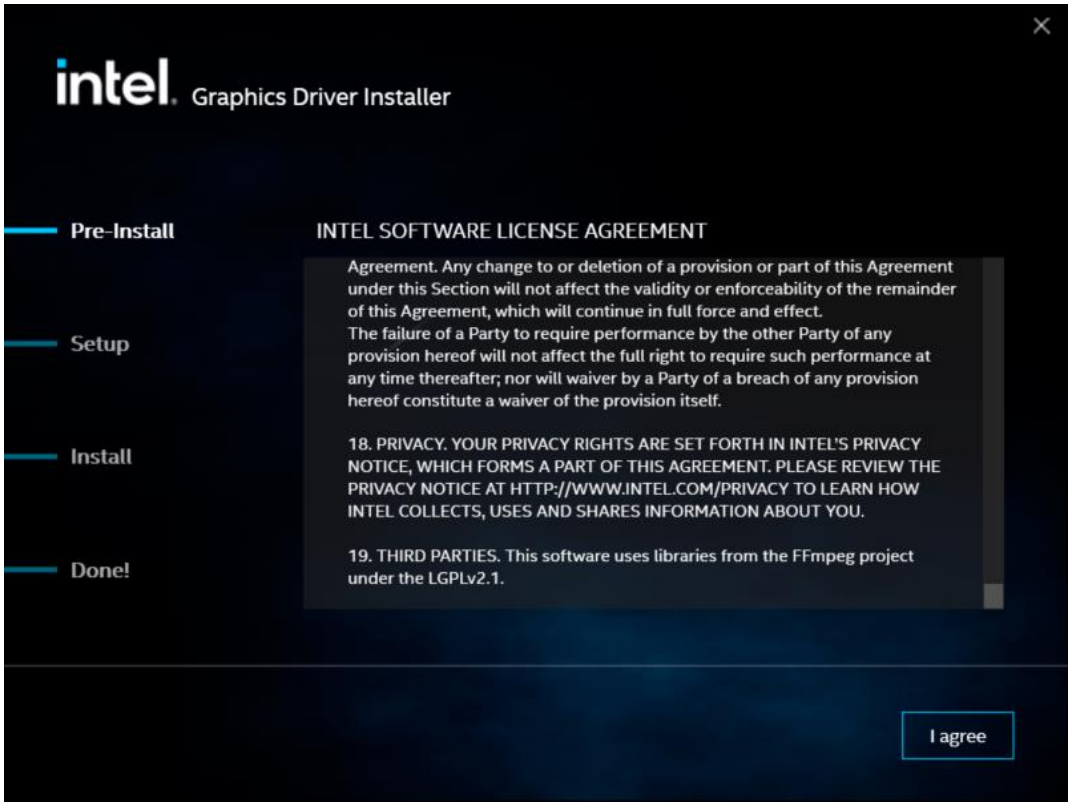
Step 4. Select **Restart Now** to reboot your computer for the changes to take effect.

4.2 Intel® HD Graphics Chipset

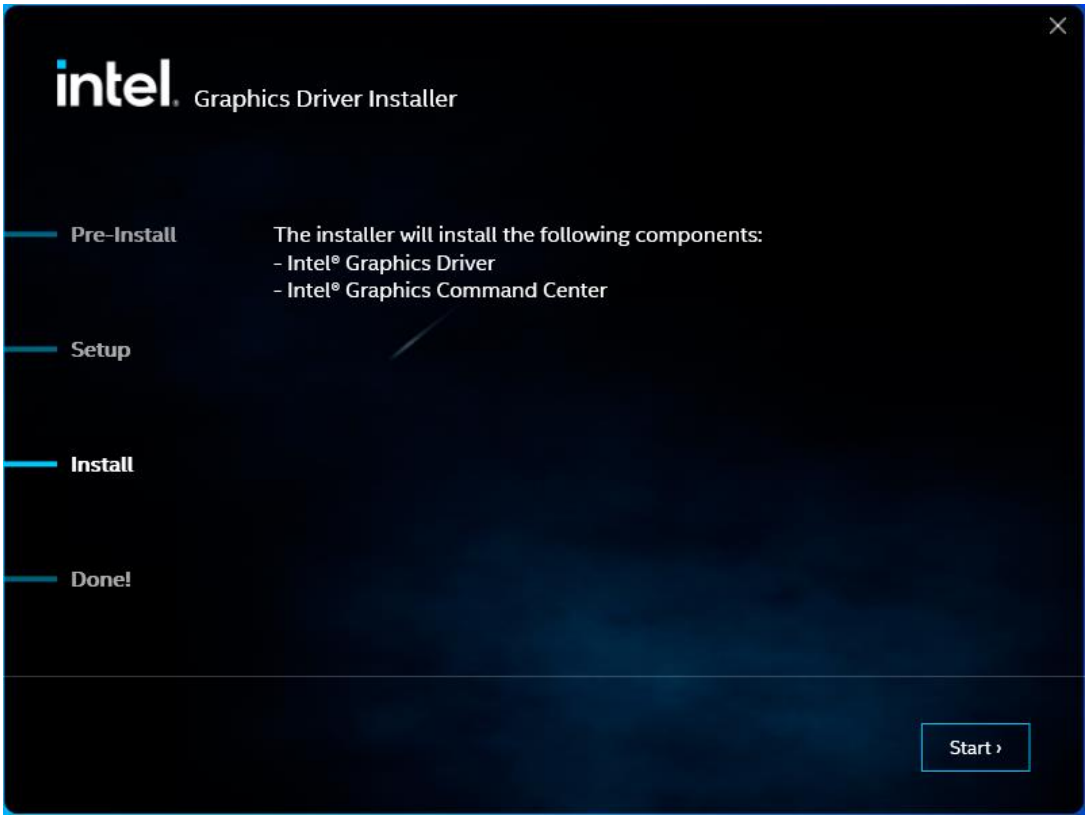
To install the Intel® HD Graphics Chipset, please follow the steps below.

Step 1. Click **Begin installation.**

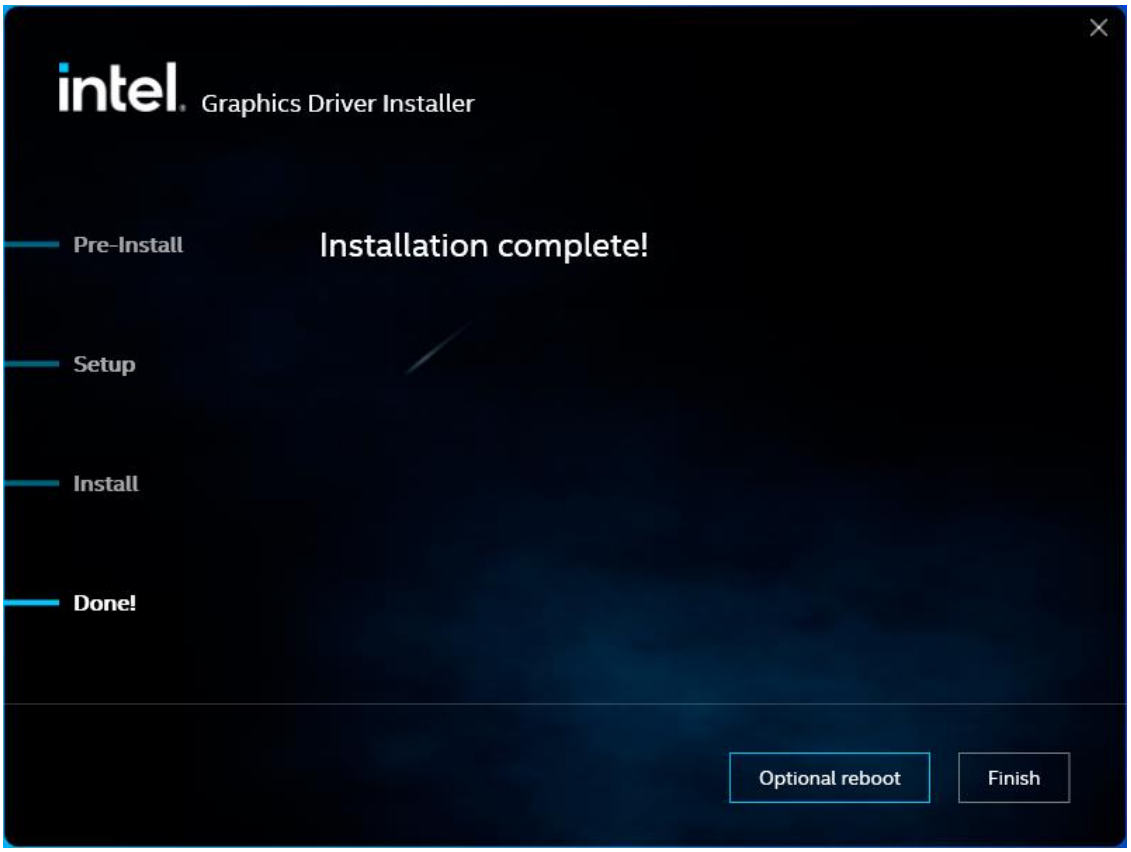
Step 2. Read the license agreement. Click **I agree** to accept all the terms of the license agreement.



Step 3. Choose **Install** function and Click **Start** to setup program.



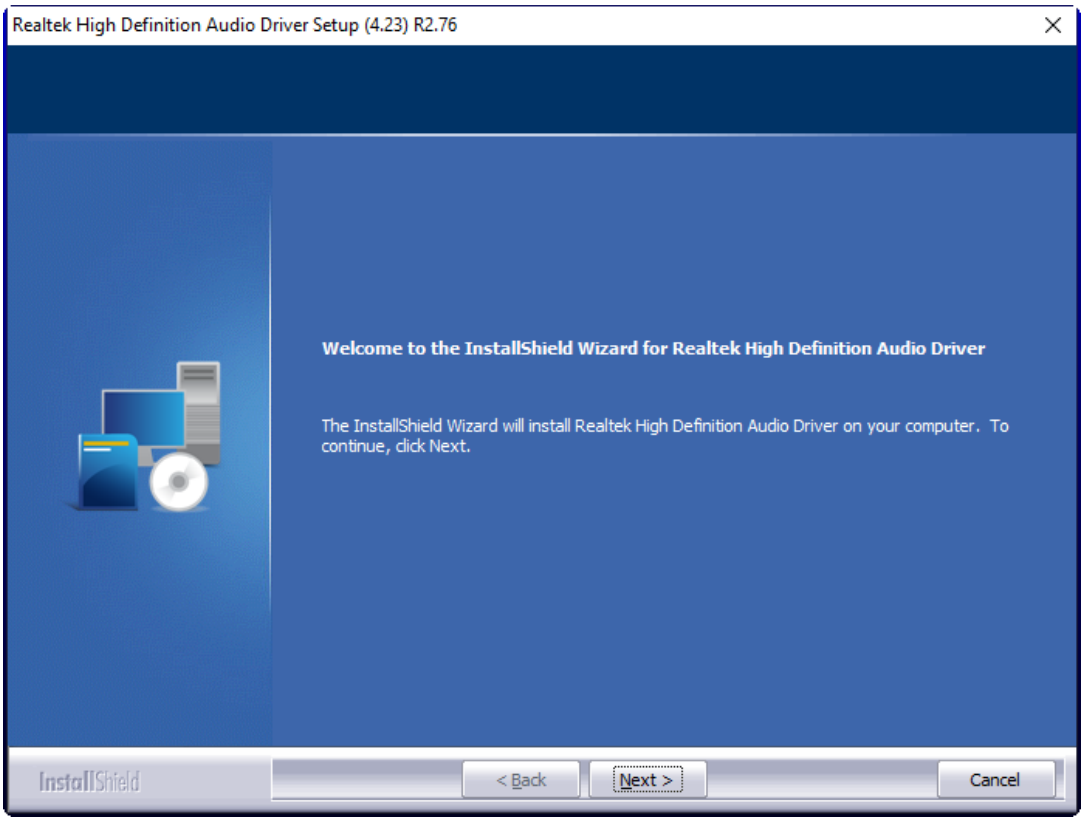
Step 4. Click **Finish** to complete installation.



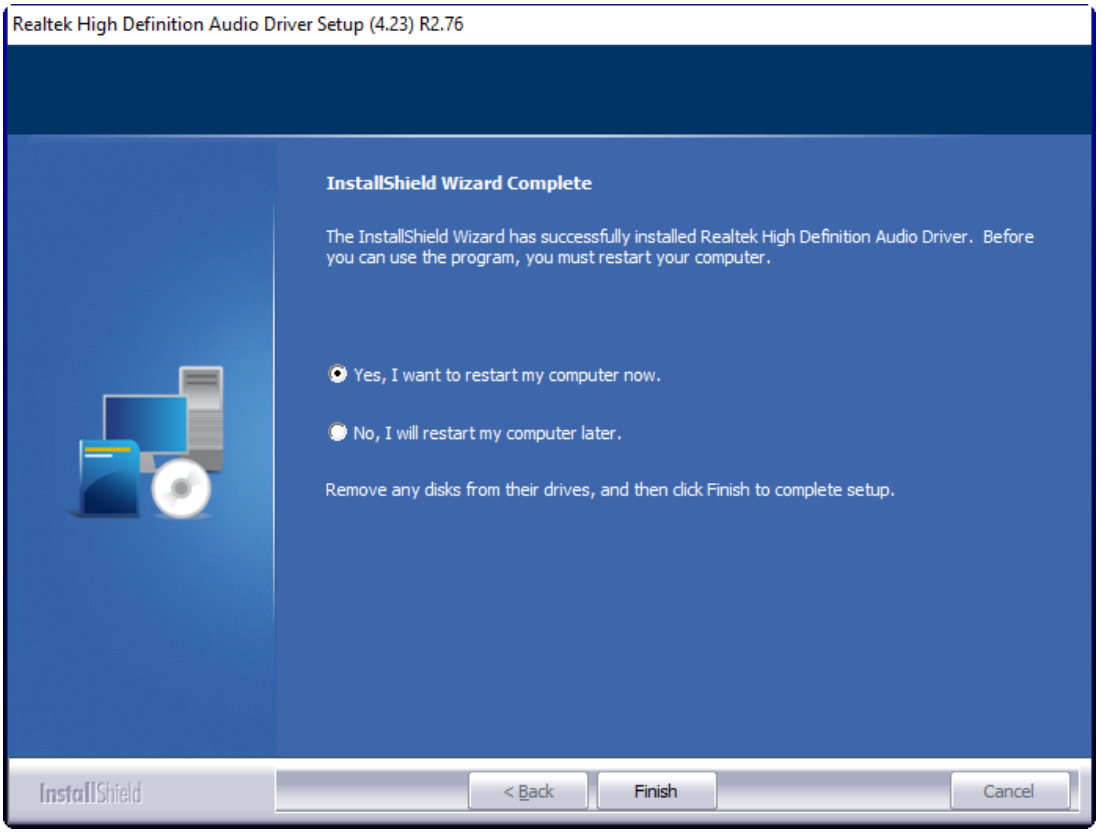
4.3 Intel® HD Graphics Chipset

To install the Realtek HD Audio Driver, please follow the steps below.

Step 1. Click **Next** to continue.



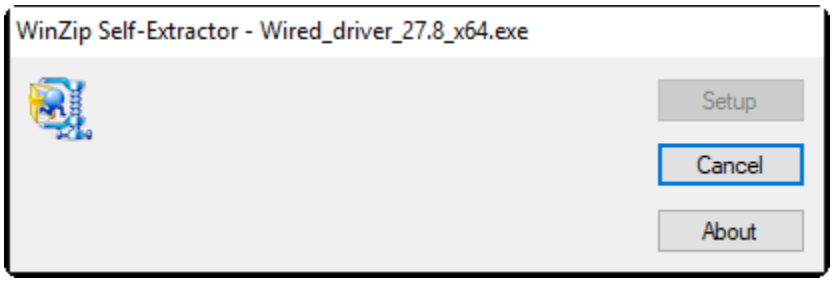
Step 2. Click **Yes, I want to restart my computer now**. Click **Finish** to complete the installation.



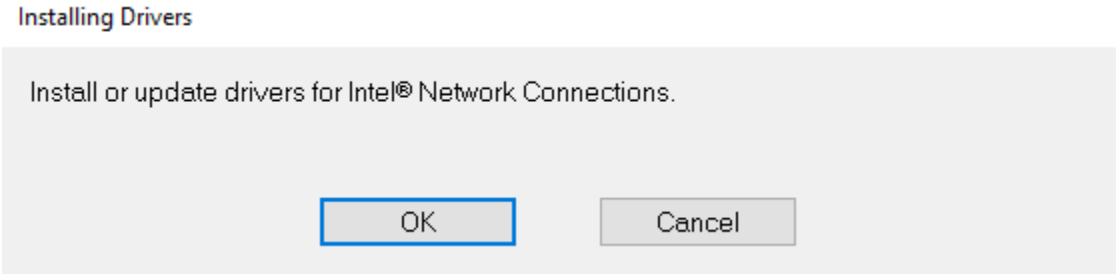
4.4 | LAN Driver

To install the LAN driver, please follow the steps below.

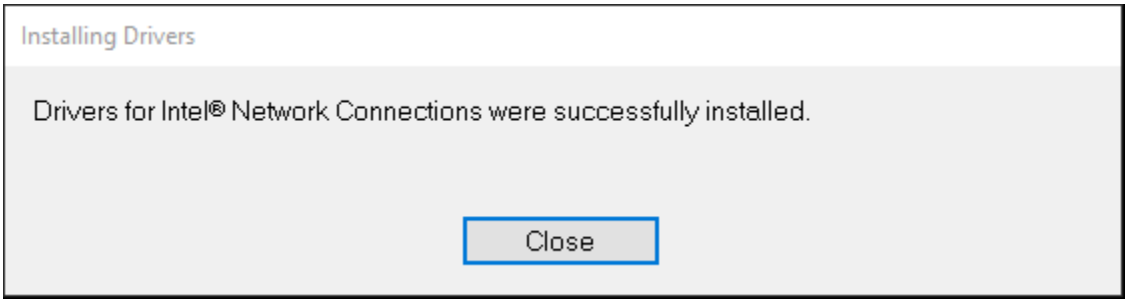
Step 1. Click **Zip File** to continue.



Step 3. Click **OK** to begin the installation.



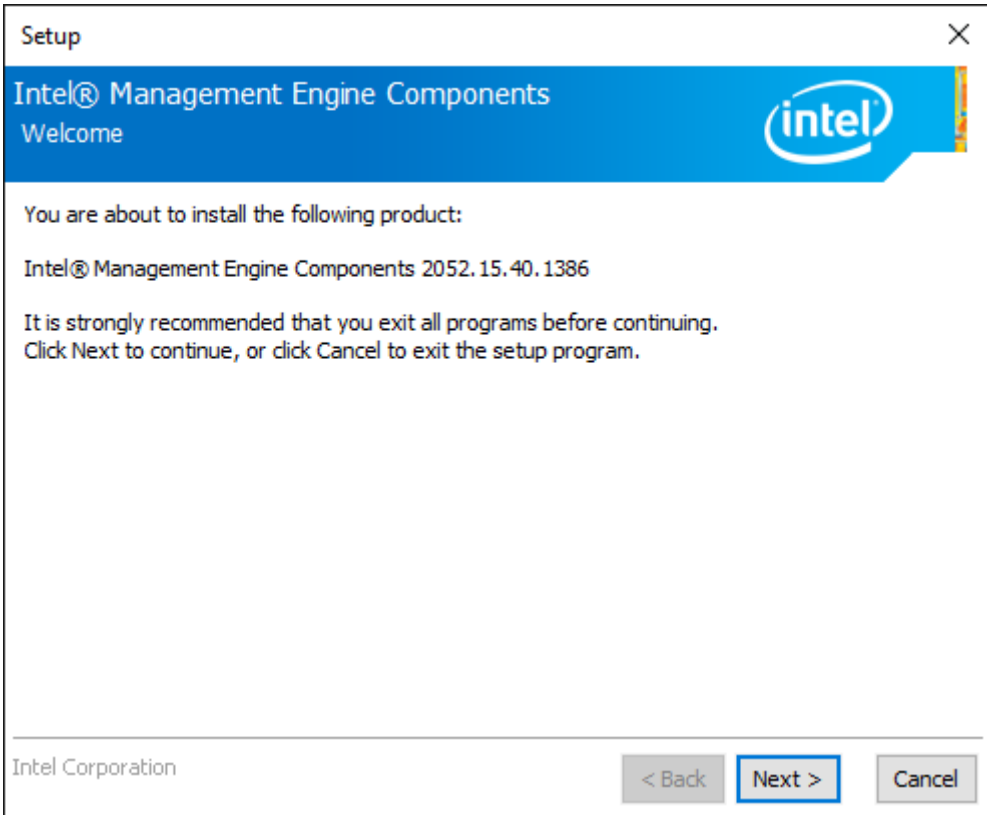
Step 4. Click **Close** to finish installation.



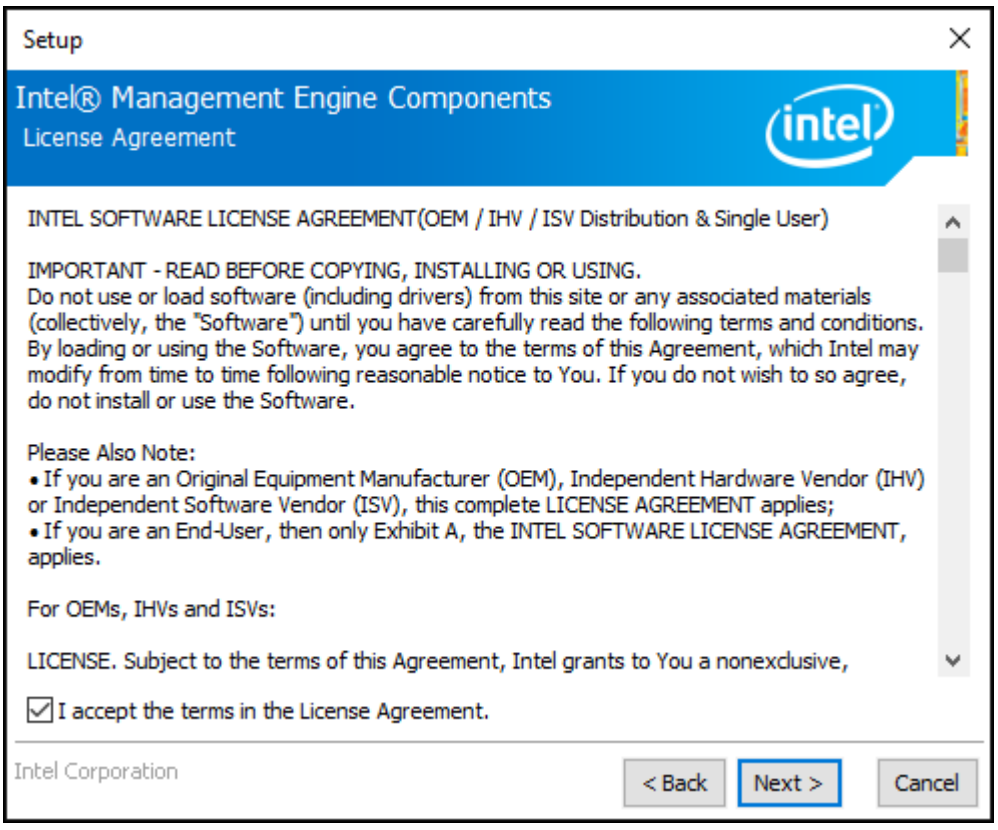
4.5 Intel® Management Engine Interface

To install the Intel® Management Engine Interface, please follow the steps below.

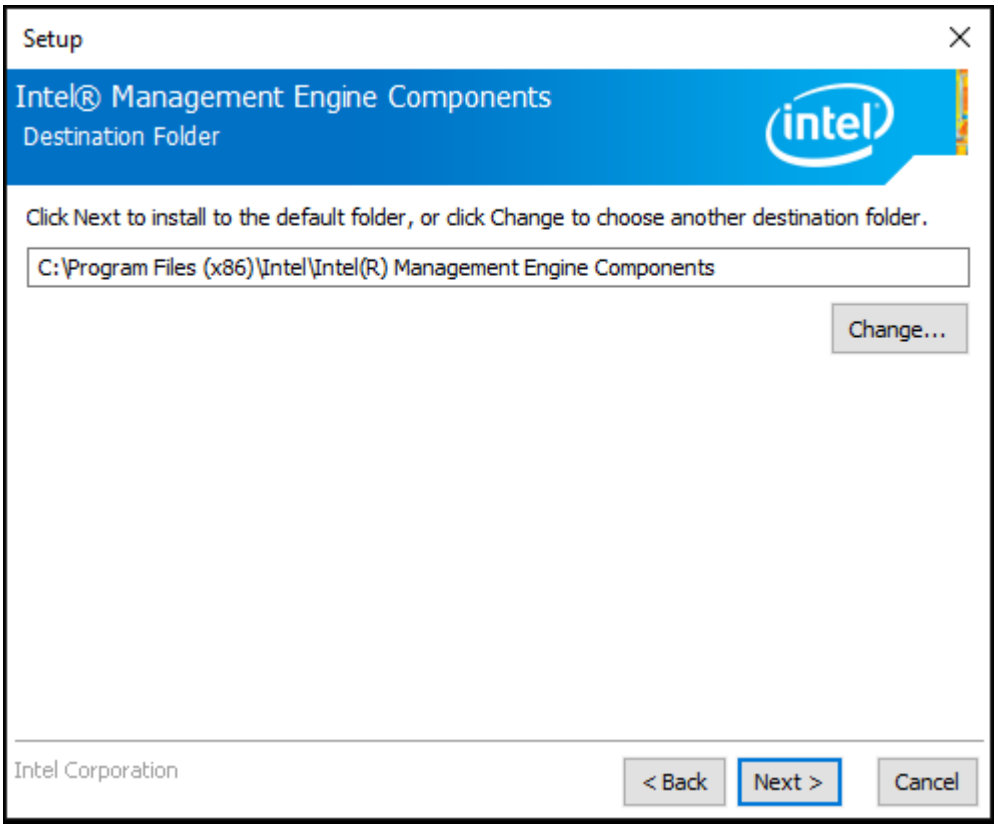
Step 1. Select setup language you need. Click **Next** to continue.



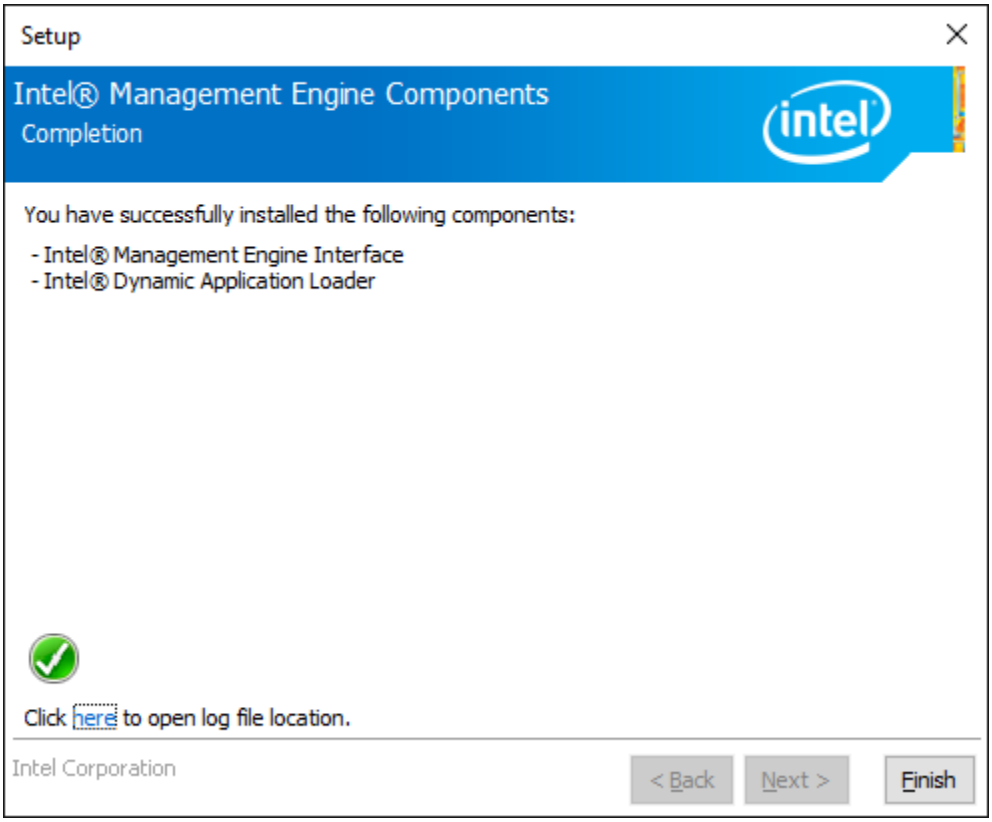
Step 2. Choose **I accept the terms in the License Agreement** and click **Next** to begin the installation.



Step 3. Click **Next** to continue.



Step 4. Click **Finish** to complete the installation.



4.6 Touch Screen Installation

This chapter describes how to install drivers and other software that will allow your touch screen work with different operating systems.

4.6.1 Windows 10 Universal Driver Installation for PenMount 6000 Series

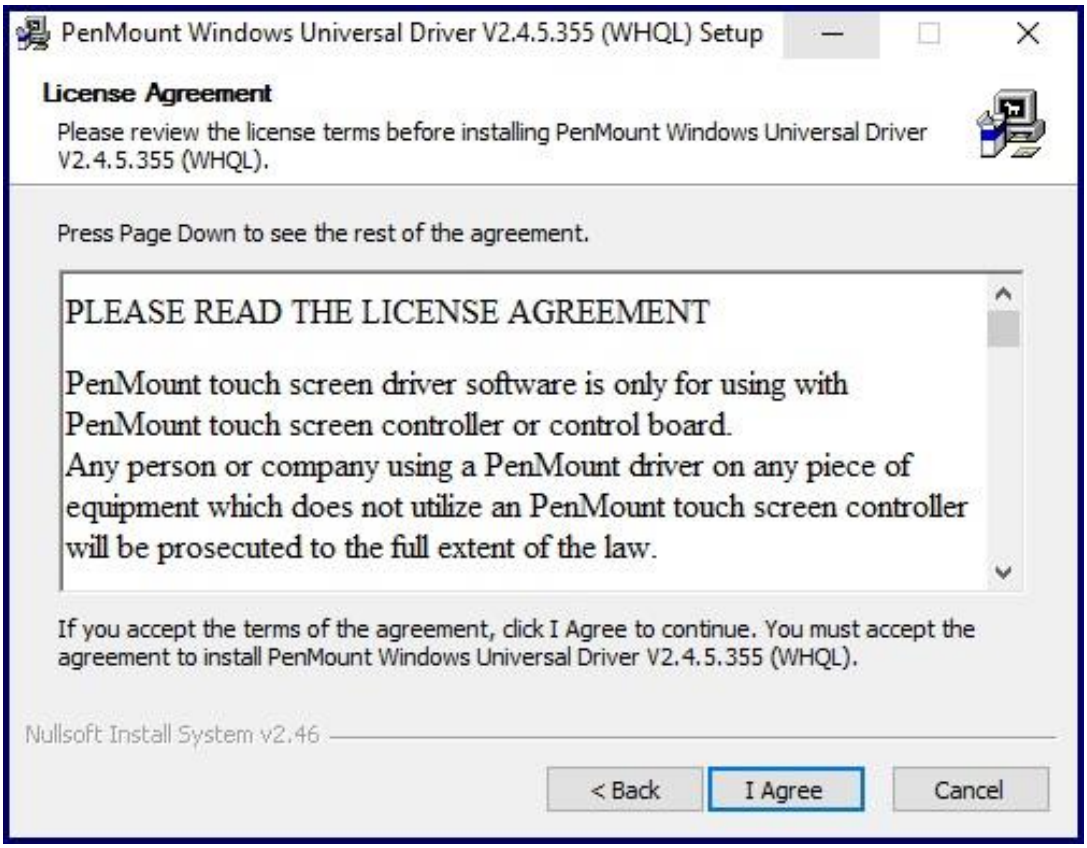
Before installing the Windows 10 driver software, you must have the Windows 10 system installed and running on your computer. You must also have one of the following PenMount 6000 series controller or control boards installed: PM6500, PM6300.

Resistive Touch

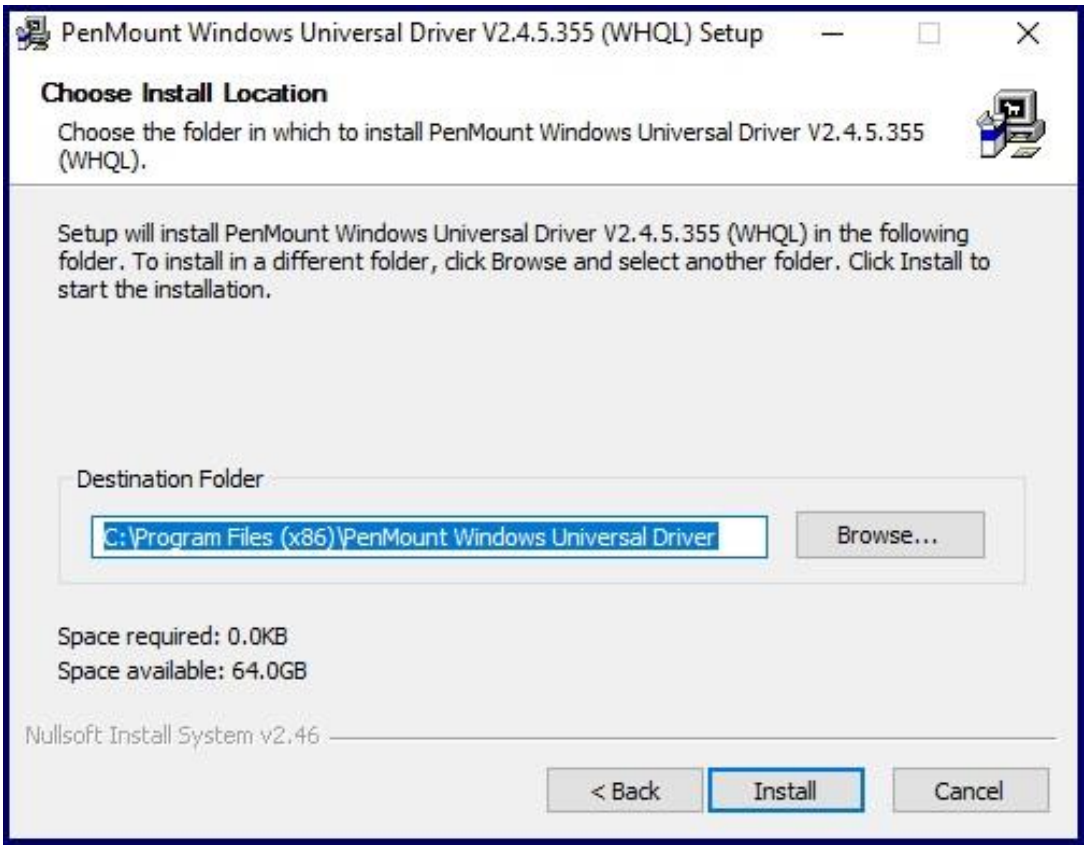
If you have an older version of the PenMount Windows 7 driver installed in your system, please remove it first. Follow the steps below to install the PenMount DMC6000 driver.

Step 1. Click **Next** to continue.

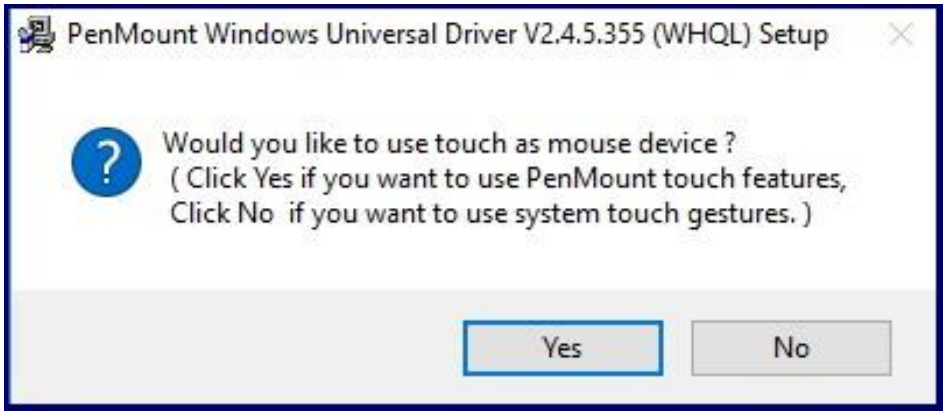
Step 2. Read the license agreement. Click **I Agree** to agree the license agreement.



Step 3. Choose the folder in which to install PenMount Windows Universal Driver. Click **Install** to start the installation.



Step 4. Click **Yes** to continue.



Step 5. Click **Finish** to complete installation.

4.6.2 Software Functions

Resistive Touch

Upon rebooting, the computer automatically finds the new 6000 controller board. The touch screen is connected but not calibrated. Follow the procedures below to carry out calibration.

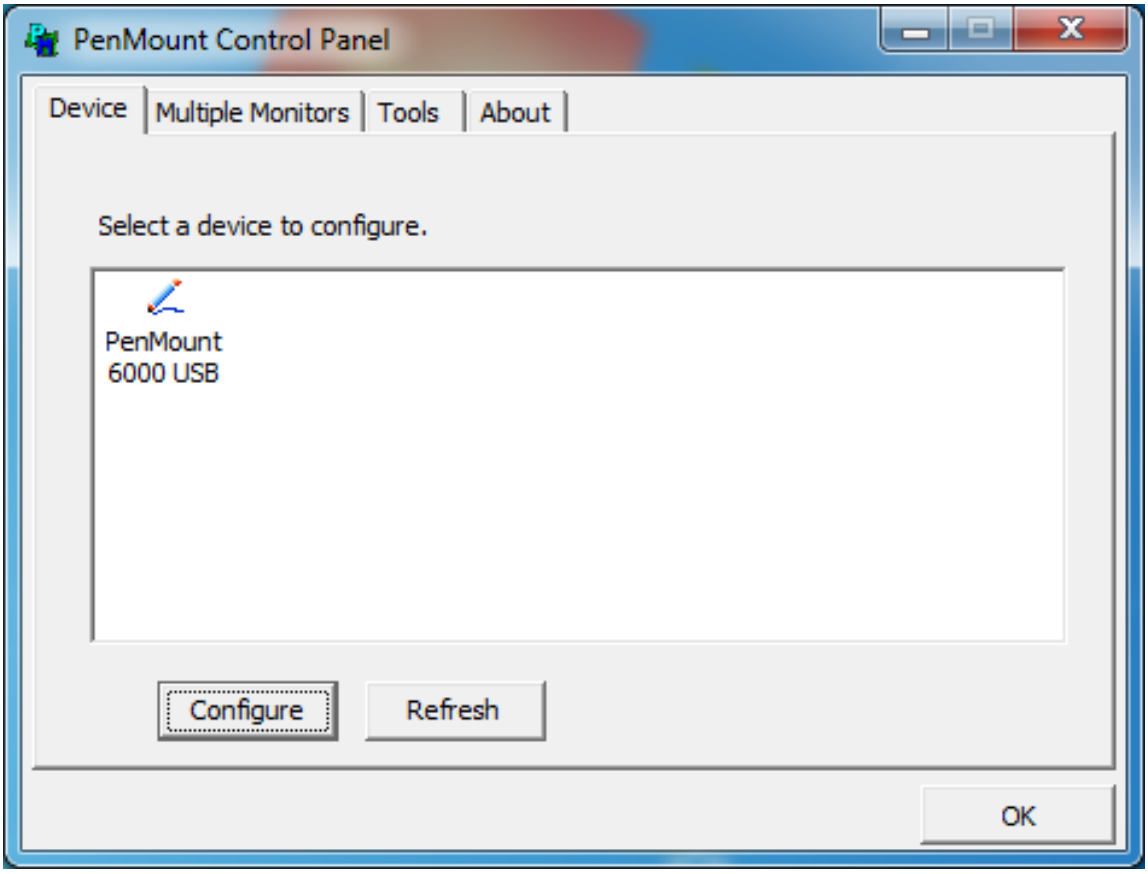
1. After installation, click the PenMount Monitor icon “PM” in the menu bar.
2. When the PenMount Control Panel appears, select a device to “Calibrate.”

PenMount Control Panel (Resistive Touch)

The functions of the PenMount Control Panel are **Device, Multiple Monitors** ,**Tools** and **About**, which are explained in the following sections.

Device

In this window, you can find out that how many devices be detected on your system.

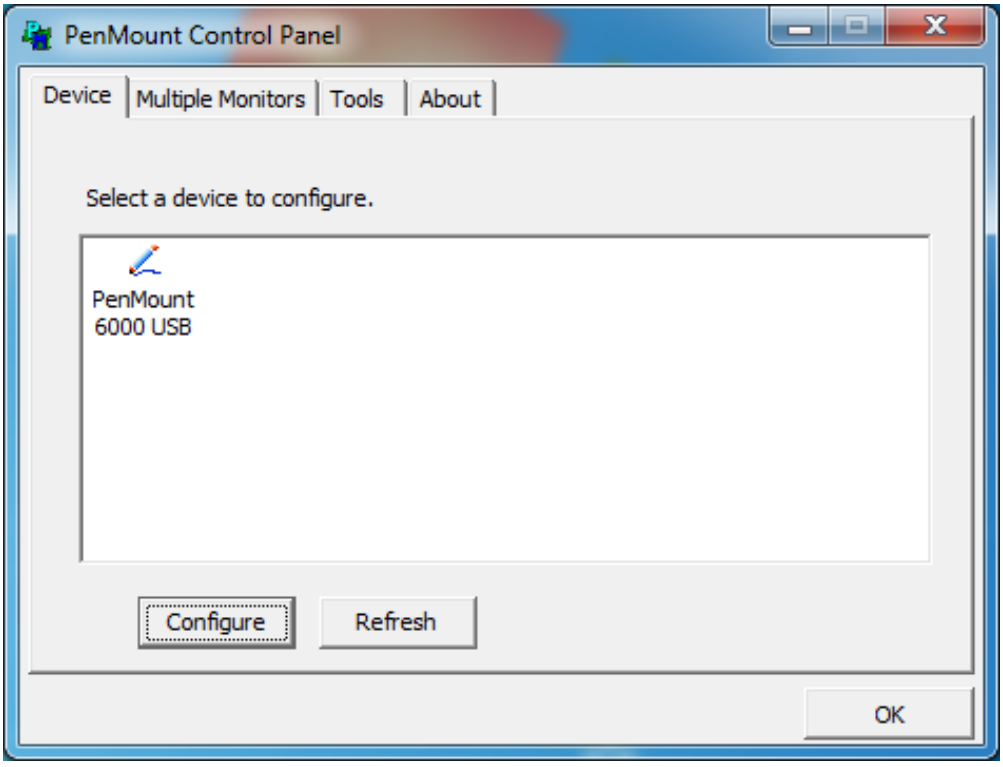


Calibrate

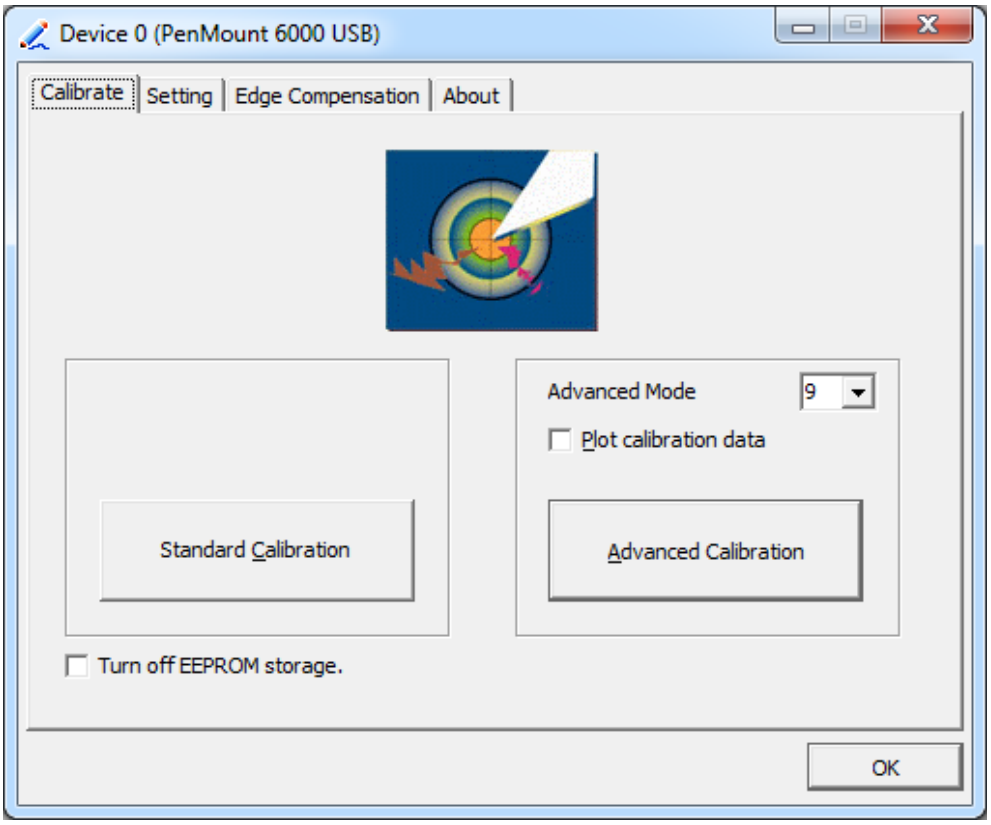
This function offers two ways to calibrate your touch screen. ‘Standard Calibration’ adjusts most touch screens. ‘Advanced Calibration’ adjusts aging touch screens.

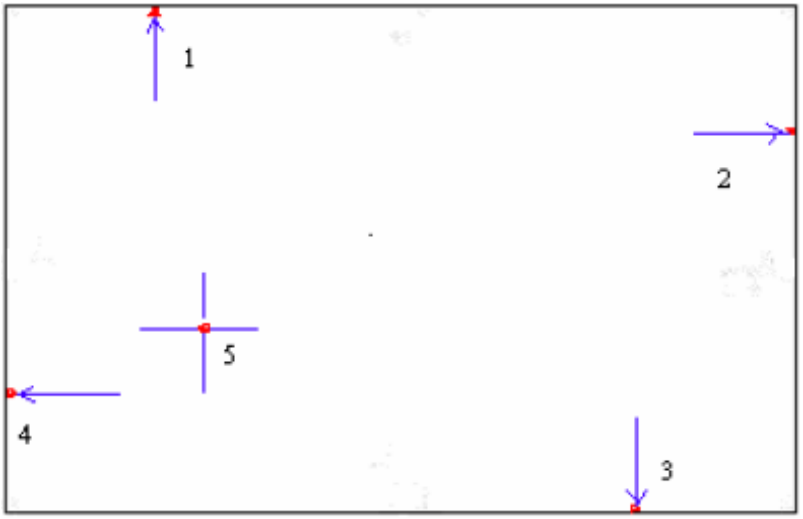
Standard Calibration	**Click this button and arrows appear pointing to red squares. Use your finger or stylus to touch the red squares in sequence. After the fifth red point calibration is complete. To skip, press ‘ESC’.**
Advanced Calibration	**Advanced Calibration uses 4, 9, 16 or 25 points to effectively calibrate touch panel linearity of aged touch screens. Click this button and touch the red squares in sequence with a stylus. To skip, press ESC’.**

Step 1. Please select a device then click “Configure”. You can also double click the device too.



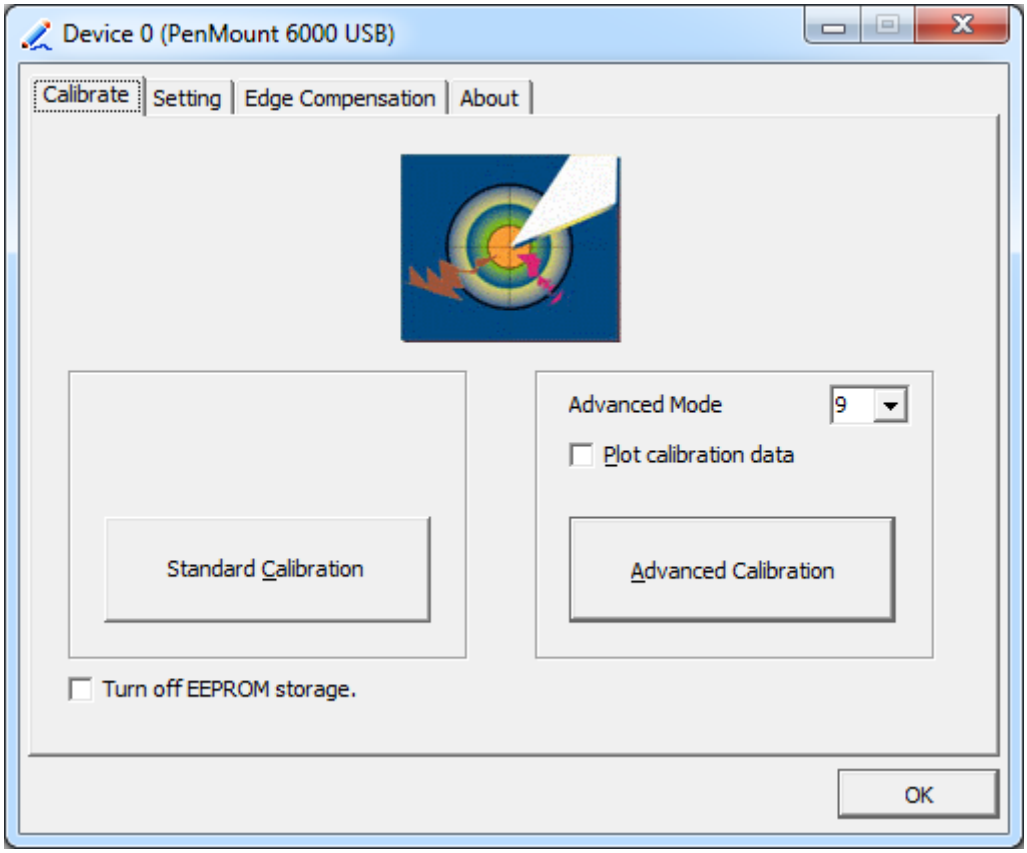
Step 2. Click "**Standard Calibration**" to start calibration procedure



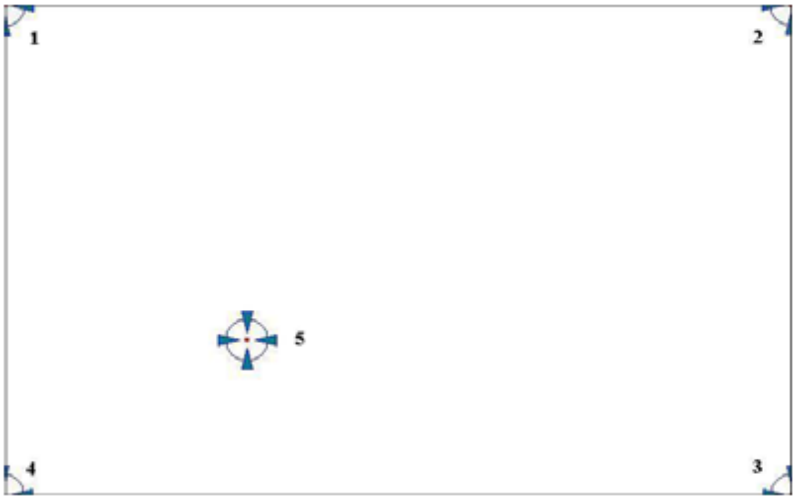


NOTE: The older the touch screen, the more Advanced Mode calibration points you need for an accurate calibration. Use a stylus during Advanced Calibration for greater accuracy. Please follow the step as below:

Step 3. Select **Device** to calibrate, then you can start to do **Advanced Calibration**.

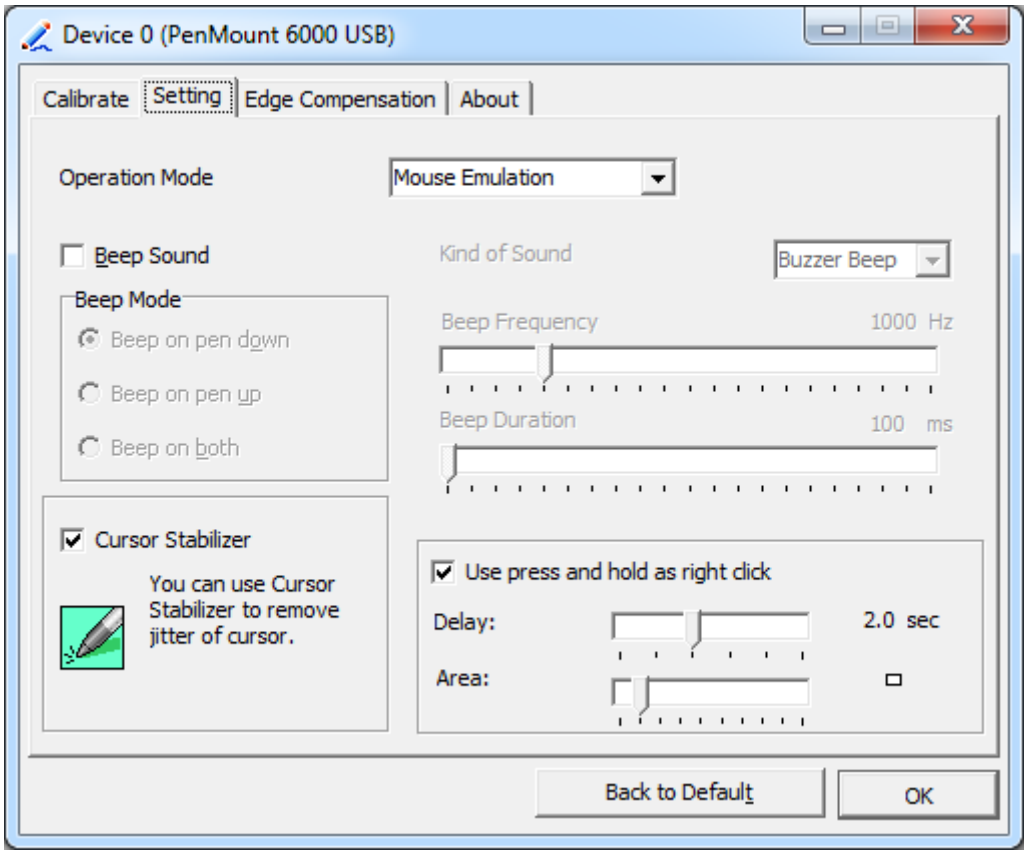


NOTE: Recommend to use a stylus during Advanced Calibration for greater accuracy.



Plot Calibration Data	**Check this function and a touch panel linearity comparison graph appears when you have finished Advanced Calibration. The blue lines show linearity before calibration and black lines show linearity after calibration.**
Turn off EEPROM storage	**The function disable for calibration data to write in Controller. The default setting is Enable.**

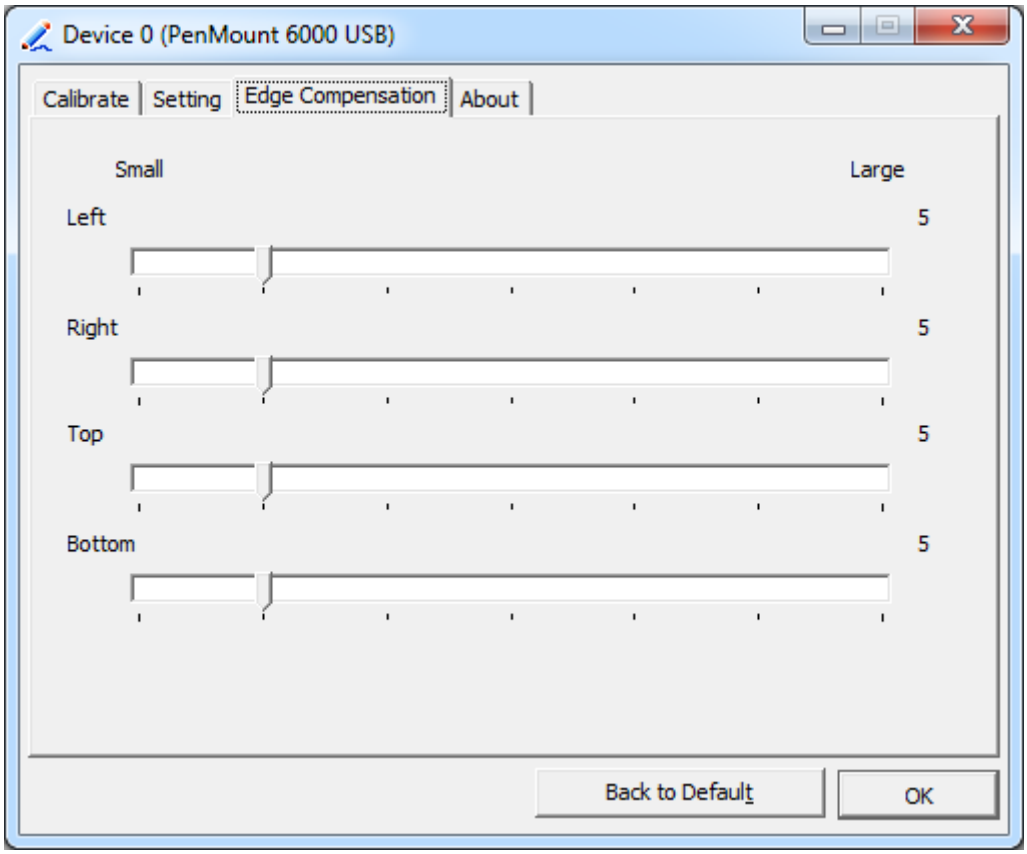
Setting



Touch Mode	**This mode enables and disables the mouse's ability to drag on-screen icons – useful for configuring POS terminals.** **Mouse Emulation – Select this mode and the mouse functions as normal and allows dragging of icons.** **Click on Touch – Select this mode and mouse only provides a click function, and dragging is disables.**
Beep Sound	**Enable Beep Sound – turns beep function on and off** **Beep on Pen Down – beep occurs when pen comes down** **Beep on Pen Up – beep occurs when pen is lifted up** **Beep on both – beep occurs when comes down and lifted up** **Beep Frequency – modifies sound frequency** **Beep Duration – modifies sound duration**
Cursor Stabilizer	**Enable the function support to prevent cursor shake.**
Use press and hold as right click	**You can set the time out and area for you need.**

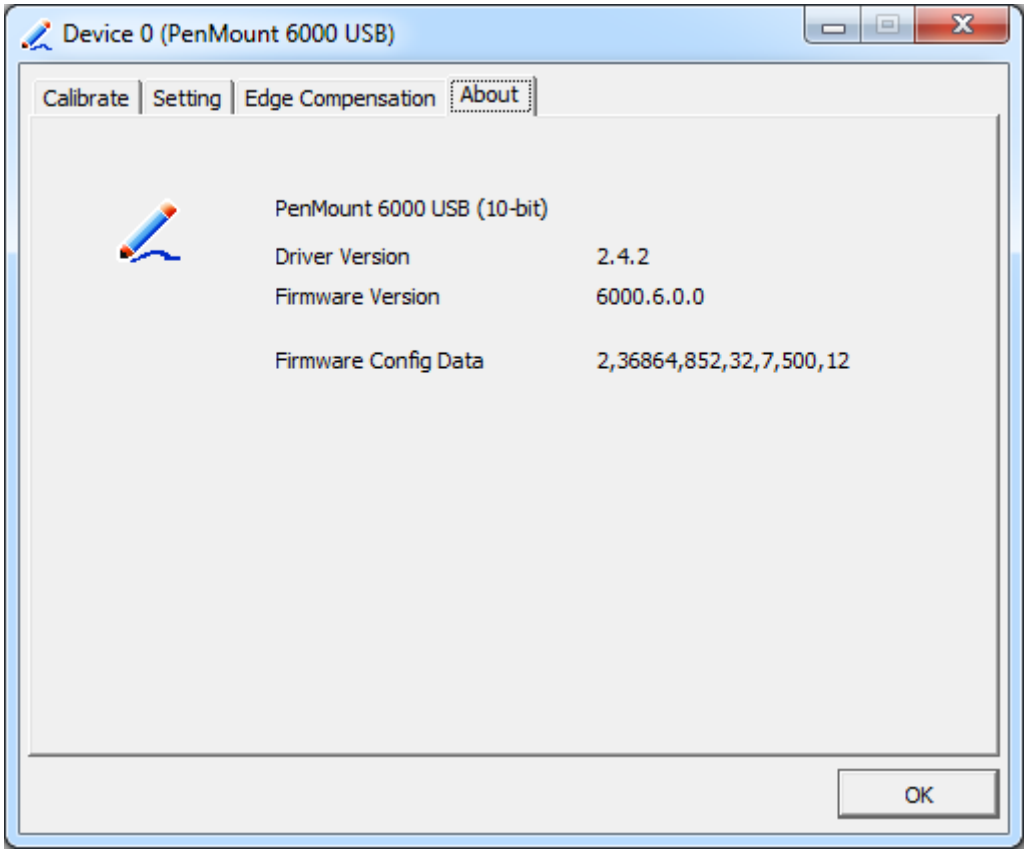
Edge Compensation

You can use Edge Compensation to calibrate more subtly.



About

This panel displays information about the PenMount controller and driver version.



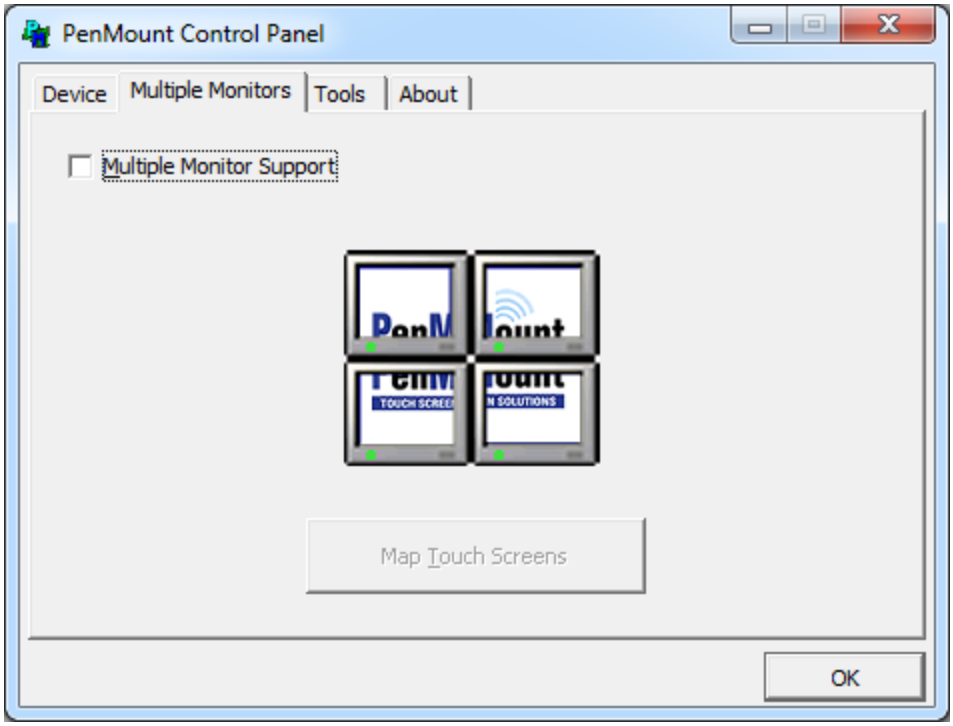
Multiple Monitors

Multiple Monitors support from two to six touch screen displays for one system. The PenMount drivers for Windows 7/8/8.1 support Multiple Monitors. This function supports from two to six touch screen displays for one system. Each monitor requires its own PenMount touch screen control board, either installed inside the display or in a central unit. The PenMount control boards must be connected to the computer COM ports via the USB interface. Driver installation procedures are the same as for a single monitor. Multiple Monitors support the following modes:
Windows Extends Monitor Function
Matrox DualHead Multi-Screen Function
nVidia nView Function

NOTE: The Multiple Monitor function is for use with multiple displays only. Do not use this function if you have only one touch screen display. Please note once you turn on this function the rotating function is disabled.

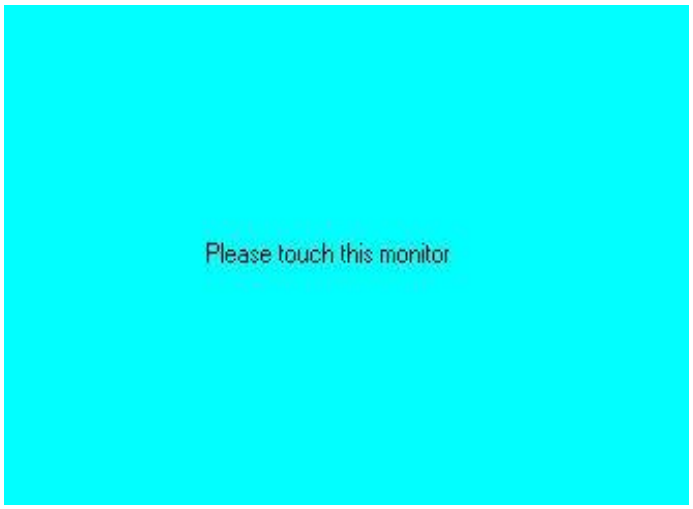
Enable the multiple display function as follows:

1. Check the **Enable Multiple Monitor Support** box; then click **Map Touch Screens** to assign touch controllers to displays.



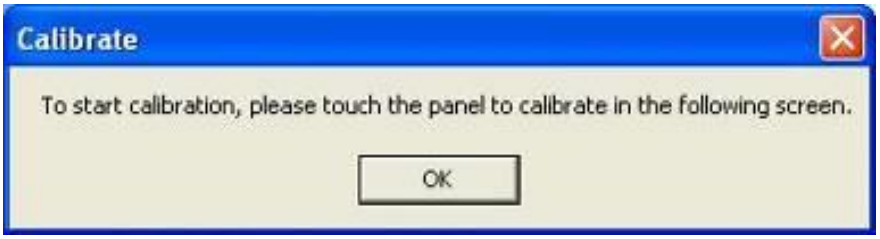
2. When the mapping screen message appears, click **OK.**

3. Touch each screen as it displays “Please touch this monitor”. Following this sequence and touching each screen is called **mapping the touch screens.**



4. Touching all screens completes the mapping and the desktop reappears on the monitors.

5. Select a display and execute the “Calibration” function. A message to start calibration appears. Click **OK.**



6. “Touch this screen to start its calibration” appears on one of the screens. Touch the screen.

7. “Touch the red square” messages appear. Touch the red squares in sequence.

8. Continue calibration for each monitor by clicking **Standard Calibration** and touching the red squares.

NOTES:

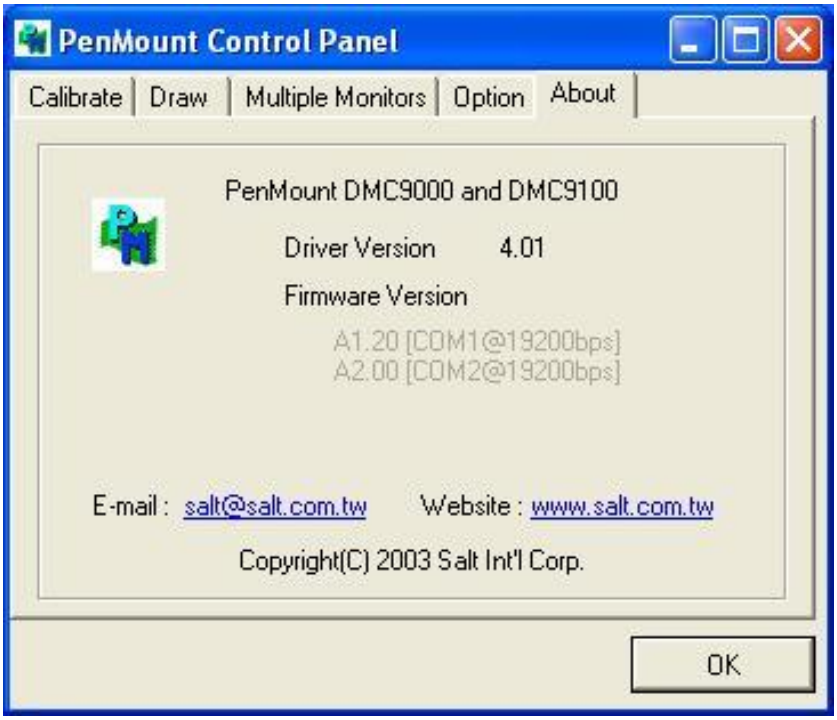
1. If you use a single VGA output for multiple monitors, please do not use the **Multiple Monitor** function. Just follow the regular procedure for calibration on each of your desktop monitors.

2. The Rotating function is disabled if you use the Multiple Monitor function.

3. If you change the resolution of display or screen address, you have to redo **Map Touch Screens,** so the system understands where the displays are.

About

This panel displays information about the PenMount controller and this driver version.



PenMount Monitor Menu Icon

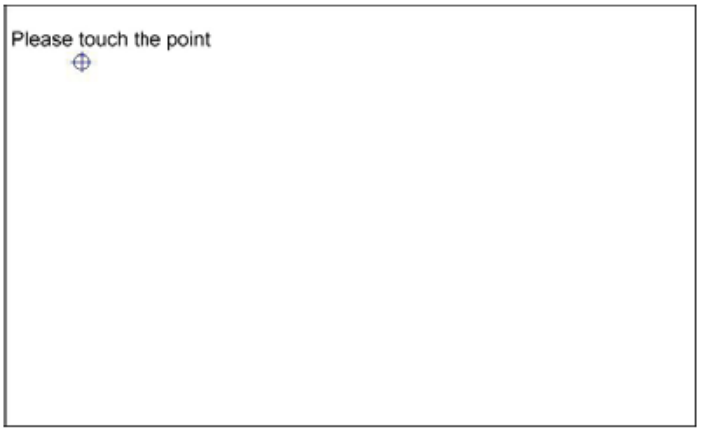
The PenMount monitor icon (PM) appears in the menu bar of Windows 7/8/8.1 system when you turn on PenMount Monitor in PenMount Utilities.

PenMount Monitor has the following function

Control Panel	**Open Control Panel Windows**
Beep	**Setting Beep function for each device**
Right Button	**When you select this function, a mouse icon appears in the right-bottom of the screen.**  **Click this icon to switch between Right and Left Button functions.**
Exit	**Exits the PenMount Monitor function.**

Configuring the Rotate Function

1. Install the rotation software package.
2. Choose the rotate function (0°, 90°, 180°, 270°) in the 3rd party software. The calibration screen appears automatically. Touch this point and rotation is mapped.



NOTE: The Rotate function is disabled if you use Monitor Mapping